Compal Confidential

QCL10 Schematics Document

AMD APU Trinity FS1r2 + FCH Hudson-M3 + GPU Seymour/Thames XT

2012-07-13

REV:1.0(A00)

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Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title: Cover Page
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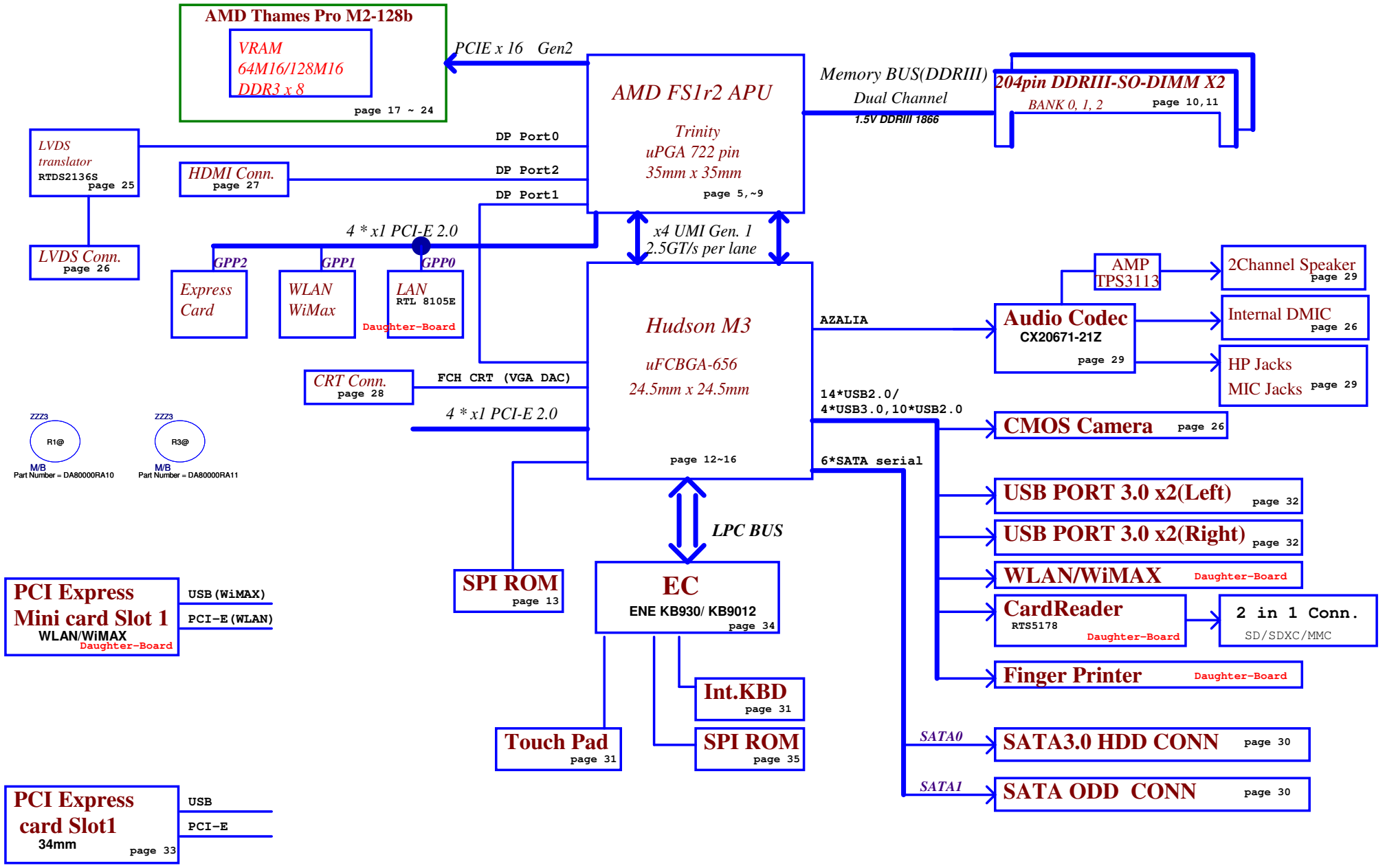
File Name : QCL10



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Issued Date	2011/08/01	Deciphered Date 2013/01/01	Title: Block Diagrams
Size: B	Document Number: LA8251P		Rev: 1.0
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Voltage Rails

Power Plane	Description	S1	S3	S5
VIN	Adapter power supply (19V)	N/A	N/A	N/A
B+	AC or battery power rail for power circuit.	N/A	N/A	N/A
+APU_CORE	Core voltage for APU	ON	OFF	OFF
+APU_CORE_NB	Voltage for On-die VGA of APU	ON	OFF	OFF
+1.5V	1.5V power rail for APU VDDIO and DDR	ON	ON	OFF
+0.75VS	0.75V switched power rail for DDR terminator	ON	OFF	OFF
+1.2VS	1.2V (VDDR, VDDP) switched power rail for APU	ON	OFF	OFF
+2.5VS	2.5V for APU VDDA	ON	OFF	OFF
+1.1VALW	1.1V switched power rail for FCH	ON	ON	ON*
+1.1VS	1.1V switched power rail for FCH	ON	OFF	OFF
+1.5VS	1.5V switched power rail	ON	OFF	OFF
+VGA_CORE	0.95-1.2V switched power rail	ON	OFF	OFF
+1.5VGS	1.5V switched power rail	ON	OFF	OFF
+1.8VGS	1.8V switched power rail	ON	OFF	OFF
+1.0VGS	1.0V switched power rail for VGA	ON	OFF	OFF
+3VALW	3.3V always on power rail	ON	ON	ON*
+3V_LAN	3.3V power rail for LAN	ON	ON	ON*
+3VS	3.3V switched power rail	ON	OFF	OFF
+5VALW	5V always on power rail	ON	ON	ON*
+5VS	5V switched power rail	ON	OFF	OFF
+VSB	VSB always on power rail	ON	ON	ON*
+RTCVCC	RTC power	ON	ON	ON

Note : ON* means that this power plane is ON only with AC power available, otherwise it is OFF.

FCH Hudson-M3 SATA Port List

SATA0	HDD
SATA1	ODD
SATA2	NC
SATA3	NC
SATA4	NC
SATA5	NC

Comal PCIE Port List

APU	PCIE0	LAN
	PCIE1	WLAN
	PCIE2	ExCARD
	PCIE3	NC
FCH	PCIE0	NC
	PCIE1	NC
	PCIE2	NC
	PCIE3	NC

FCH Hudson-M3 USB Port List

USB1.1	
Port0	NC
Port1	NC
USB2.0	
Port0	DEBUG PORT
Port1	WLAN
Port2	NC
Port3	FingerPrint
Port4	NC
Port5	NC
Port6	NC
Port7	CardReader
Port8	ExCARD
Port9	CAM
Port10	LP1
Port11	LP2
Port12	RP1
Port13	RP2

FCH Hudson-M3 USB Port List

Port0	LP1
Port1	LP2
Port2	RP1
Port3	RP2

EC SM Bus1 address

Device	Address	HEX
Smart Battery	000 1011	11h 0x16
Charger IC	000 1001	09h 0x12

EC SM Bus2 address

Device	Address	HEX
ADM1032ARMZ	100 1101	4Dh 0x9A
SB-TSI	100 1100	4Ch 0x98
RTD2136	100 1010	4Ah 0x94
GPU	100 0001	41h 0x82

SM Bus Controller 0

(FCH_SMB1 ~ FCH_SMB4, SMB_ALERT#)

Device	Address	HEX
APU SIC/SID (FCH_SMB3)		

SM Bus Controller 1

(FCH_SMB0)

Device	Address	HEX
DDR DIMM1 (FCH_SMB0)	1001-000xb	90
DDR DIMM2 (FCH_SMB0)	1001-001xb	92
WLAN (FCH_SMB0)		

BOM Structure

```
UMA@  : UMA only
DIS@  : DIS muxluss
45@   : 45 Level
9012@:  EC9012
930@:   EC930
INS@:  Inspiron
VOS@:  Vostro
M2@:  FCH M2
M3@:  FCH M3
FFS@:  FreeFallSensor
EXP@:  Express Card
FP@:  FingerPrint
EMC@: EMI&ESD part
SE@:  SEYMOUS GPU
CH@:  Chelsea GPU
X76@: VRAM
H2G@: Hynix 2G
S2G@: Samsung 2G
R1@:   R1 P/N for FCH,PCB
TMSR1@: R1 P/N for GPU,VRAM
R3@:   R3 P/N for FCH,PCB
TMSR3@: R3 P/N for GPU,VRAM
```


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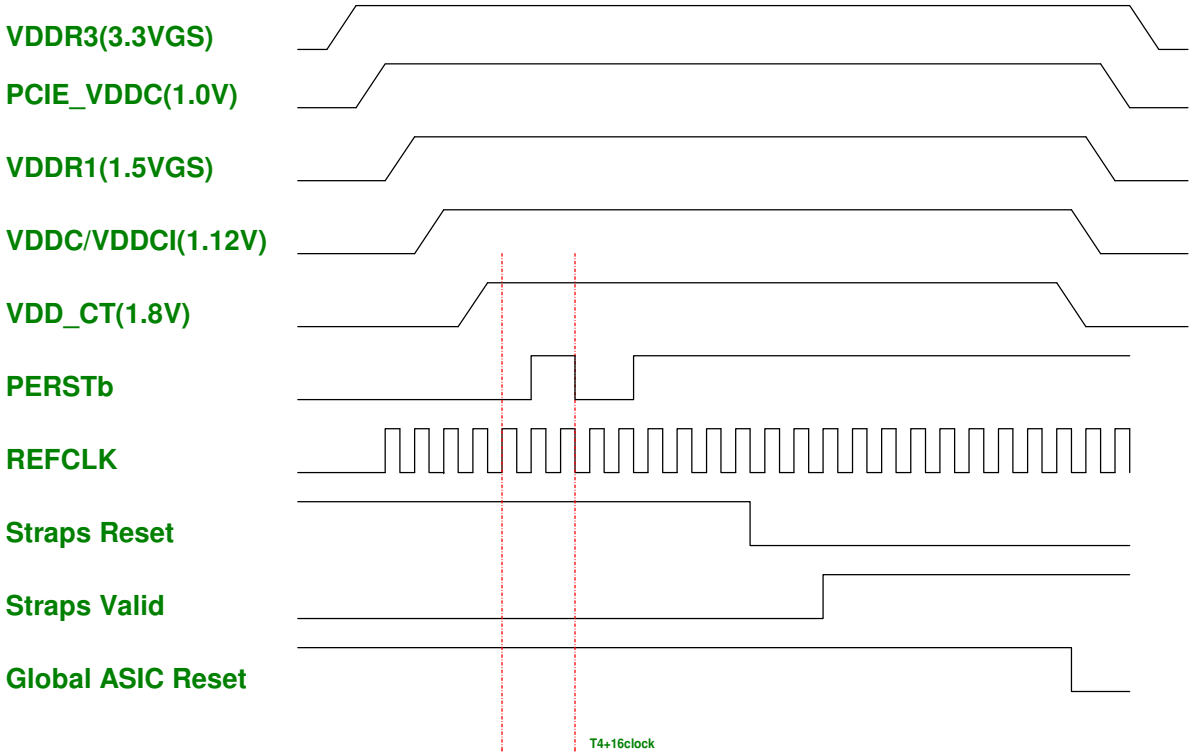
Power-Up/Down Sequence

- All the ASIC supplies, except for VDDR3, must fully reach their respective nominal voltages within 20 ms of the start of the ramp-up sequence, though a shorter ramp-up duration is preferred. There is no timing requirement on the ramp up of VDDR3 relative to other power rails.
- The external pull-up resistors on the DDC/AUX signals (if applicable) should ramp up before or after both VDDC and VDD_CT have ramped up.
- VDDC and VDD_CT should not ramp up simultaneously. For example, VDDC should reach 90% before VDD_CT starts to ramp up (or vice versa).
- For power down, reversing the ramp-up sequence is recommended.



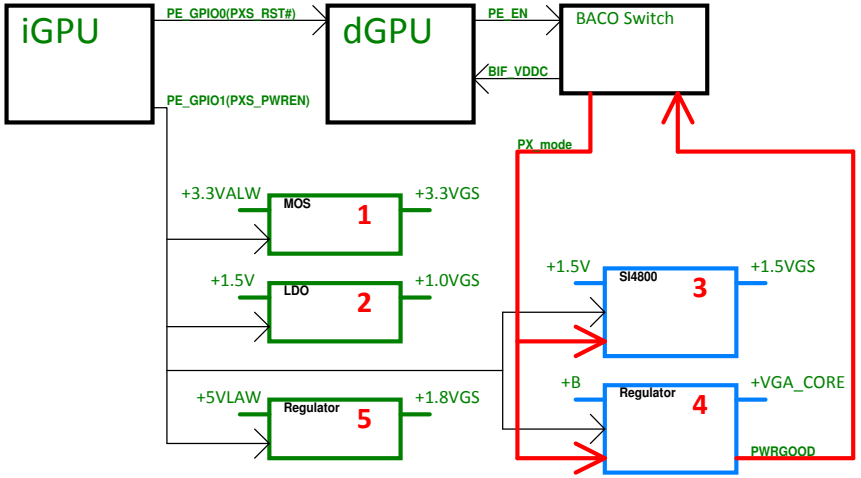
Without BACO option :

PE_GPIO0 : Low -> Reset dGPU ; High ->Normal operation
PE_GPIO1 : Low -> dGPU Power OFF ; High -> dGPU Power ON

BACO option :

PE_GPIO0 : High ->Normal operation (dGPU is not reset on BACO mode)
PE_GPIO1 : Low -> dGPU Power OFF ; High -> dGPU Power ON (always High)

dGPU Power Pins	Voltage	PX 3.0	BACO Mode	Max current
PCIE_PVDD, PCIE_VDDR, TSVDD, VDDR4, VDD_CT, DPE_PVDD, DP[F:E]_VDD18, DP[D:A]_PVDD, DP[D:A]_VDD18, AVDD, VDD1DI, A2VDDQ, VDD2DI, DPLL_PVDD, MPV18, and SPV18	1.8V	OFF	ON	1679mA
DP[F:E]_VDD10, DP[D:A]_VDD10, DPLL_VDDC, and SPV10	1.0V	OFF	ON	775mA
PCIE_VDDC	1.0V	OFF	ON	1.1A
VDDR3	3.3V	OFF	ON	60mA
BIF_VDDC (current consumption = 55mA@1.0V, in BACO mode)	Same as VDDC	OFF	ON Same as PCIE_VDDC	70mA
VDDR1	1.5V	OFF	OFF	1.2A
VDDC/VDDCI	TBD	OFF	OFF	28



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Compal Electronics, Inc.

Title: dGPU Block Diagram

Size	Document Number	Rev
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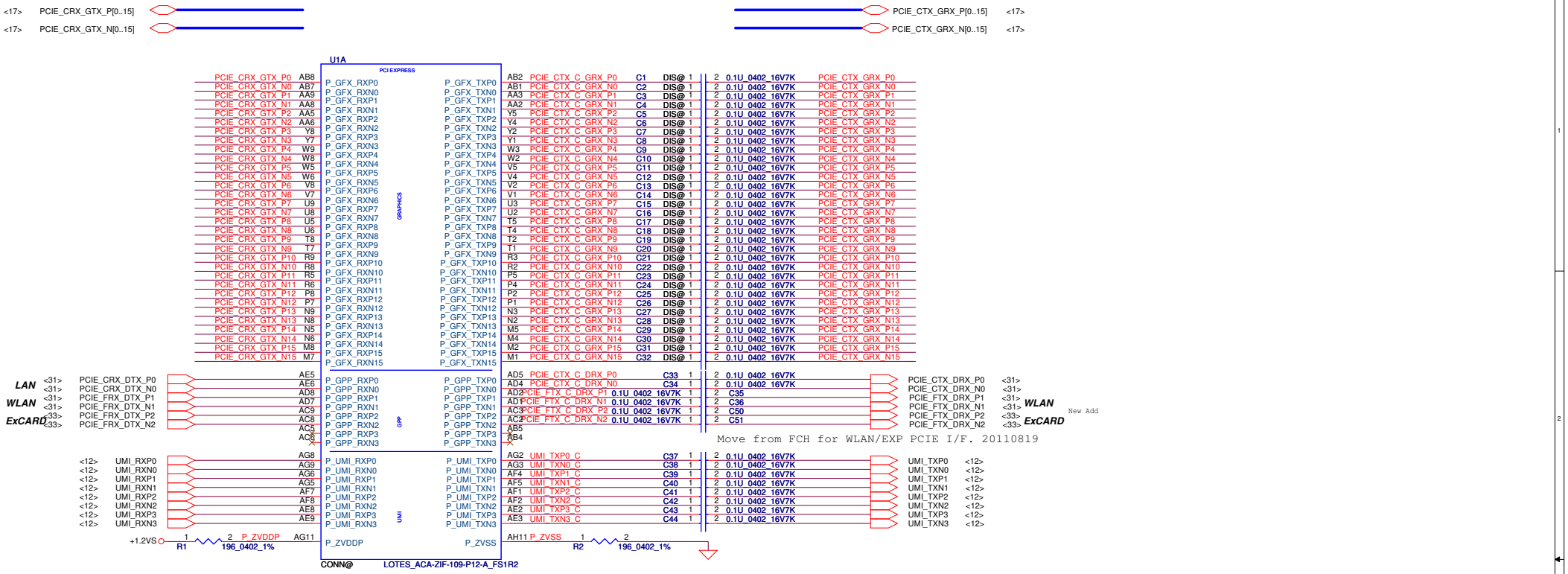

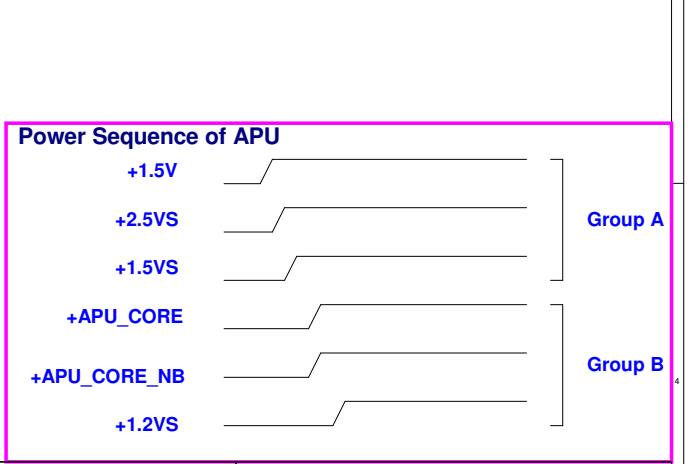

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Issued Date	2011/08/01	Deciphered Date 2013/01/01	Title: FS1r2 PCIE/UMI

Size: Custom	Document Number: LA8251P		Rev: 1.0
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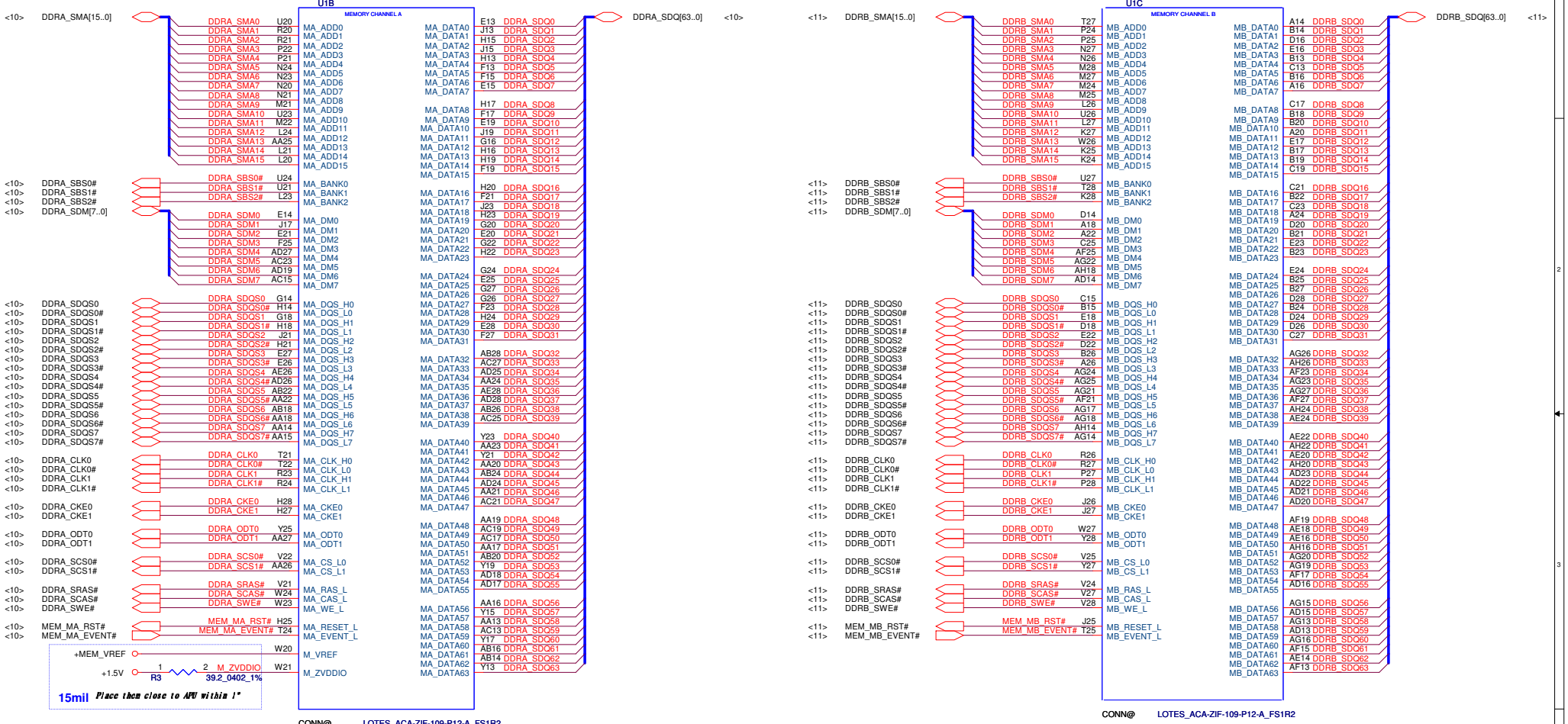

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Compal Electronics, Inc.

Title: FS1r2 DDRIII Memory I/F

Size: B2S Custom	Document Number: LA8251P	Rev: 1.0
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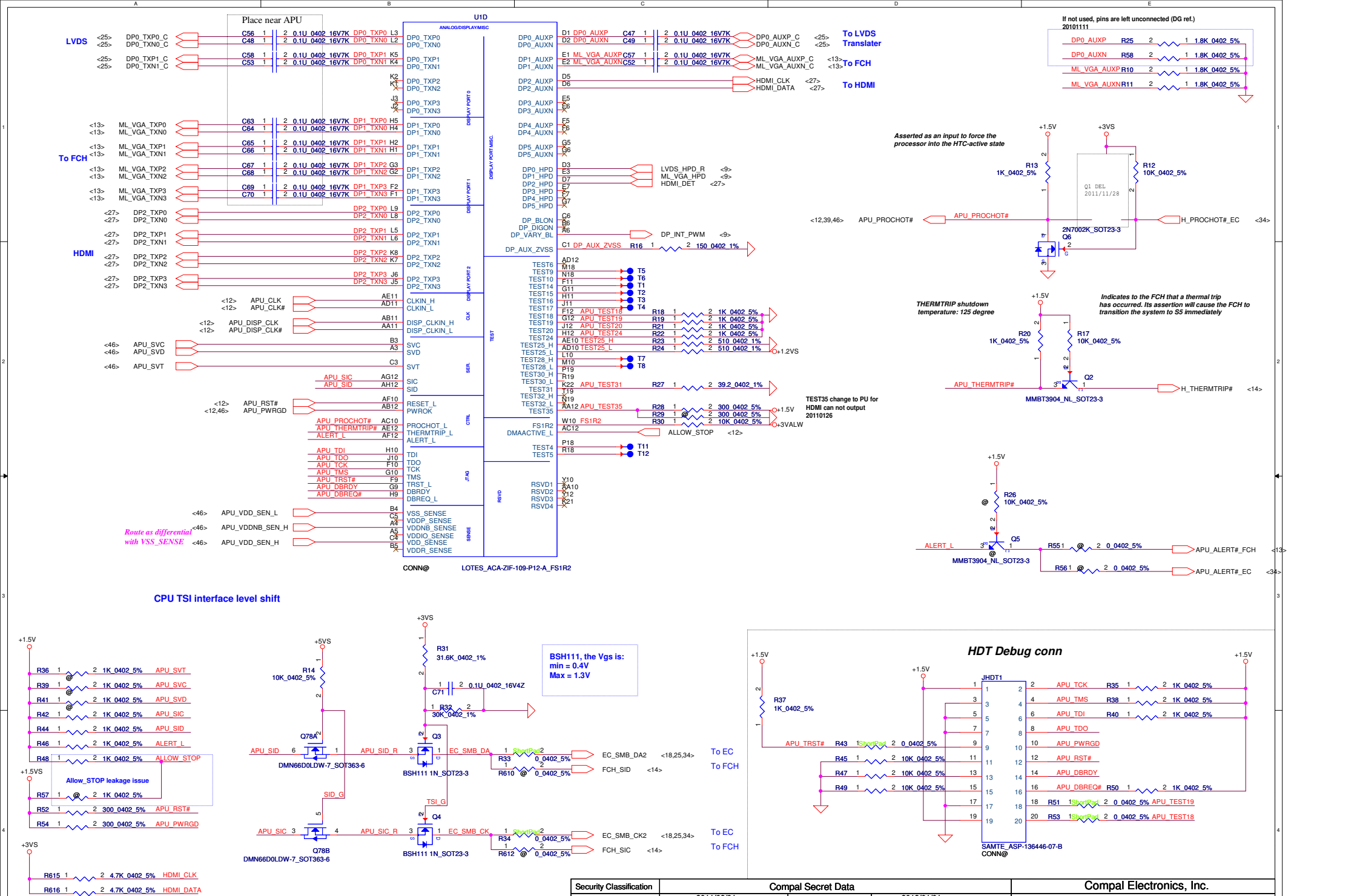

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Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.			
Title: FS1r2 Display/MISC/HDT			
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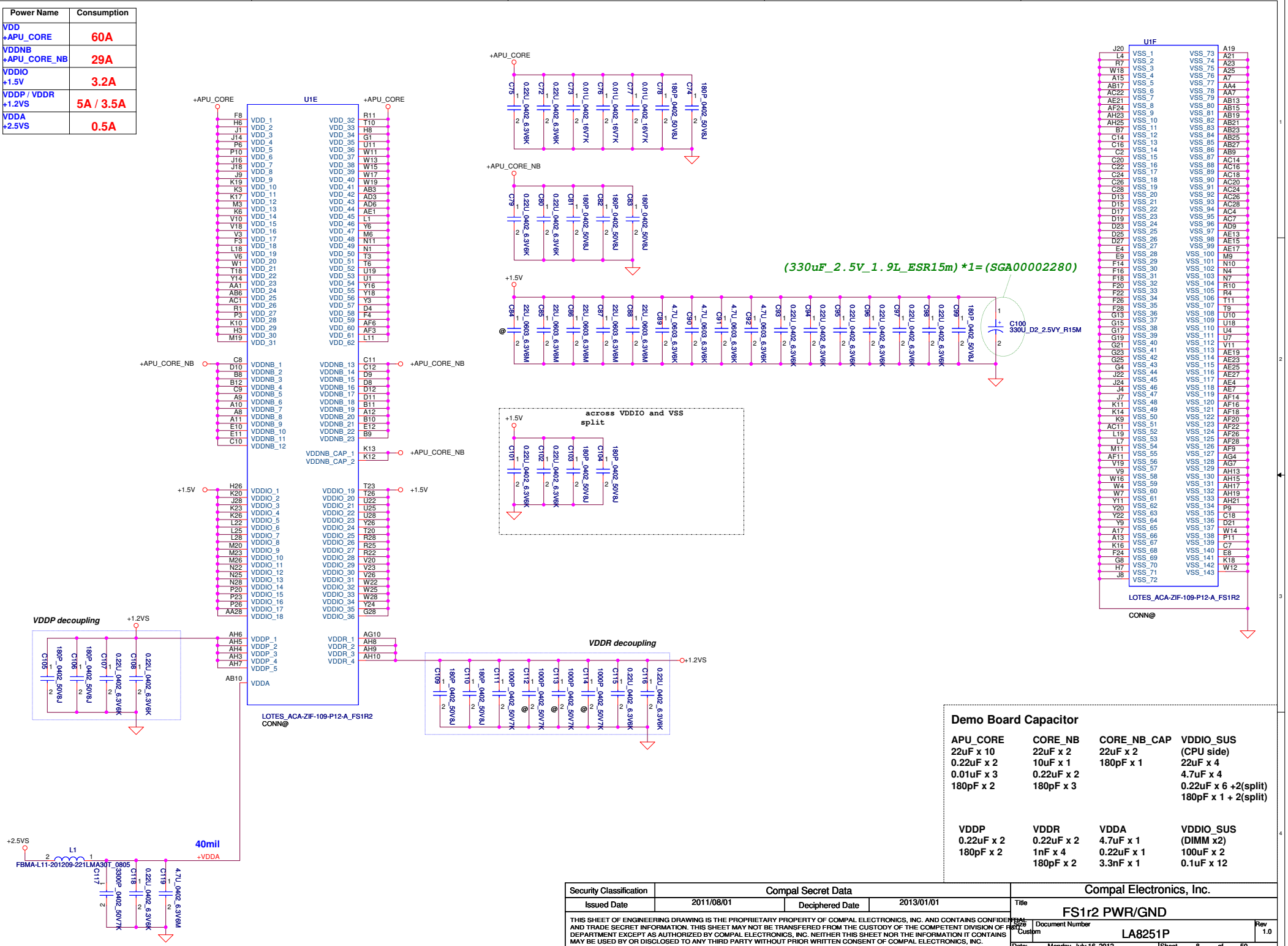
Power Name	Consumption
VDD +APU_CORE	60A
VDDNB +APU_CORE_NB	29A
VDDIO +1.5V	3.2A
VDDP / VDDR +1.2VS	5A / 3.5A
VDDA +2.5VS	0.5A



Demo Board Capacitor

APU_CORE	CORE_NB	CORE_NB_CAP	VDDIO_SUS
22uF x 10	22uF x 2	22uF x 2	(CPU side)
0.22uF x 2	10uF x 1	180pF x 1	22uF x 4
0.01uF x 3	0.22uF x 2		4.7uF x 4
180pF x 2	180pF x 3		0.22uF x 6 +2(split)
			180pF x 1 + 2(split)

VDDP	VDDR	VDDA	VDDIO_SUS
0.22uF x 2	0.22uF x 2	4.7uF x 1	(DIMM x2)
180pF x 2	1nF x 4	0.22uF x 1	100uF x 2
	180pF x 2	3.3nF x 1	0.1uF x 12

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Issued Date	2011/08/01	Deciphered Date 2013/01/01	Title: FS1r2 PWR/GND

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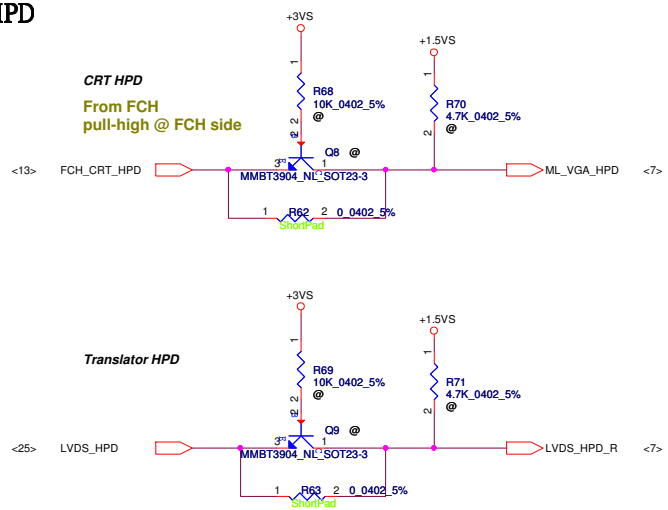
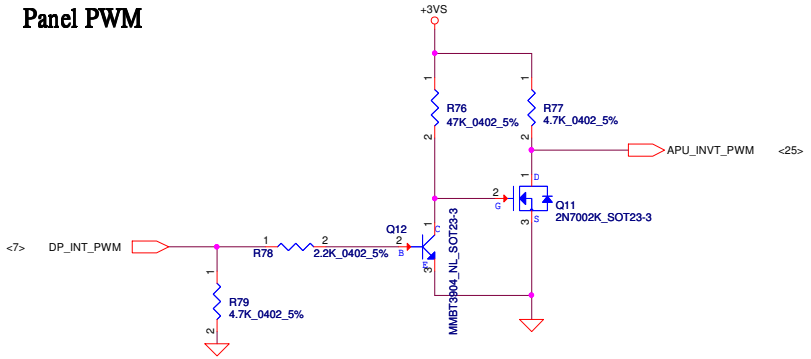
HPD



Panel PWM



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Title: FS1r2 Signal Level Shifter

Size	Document Number	Rev
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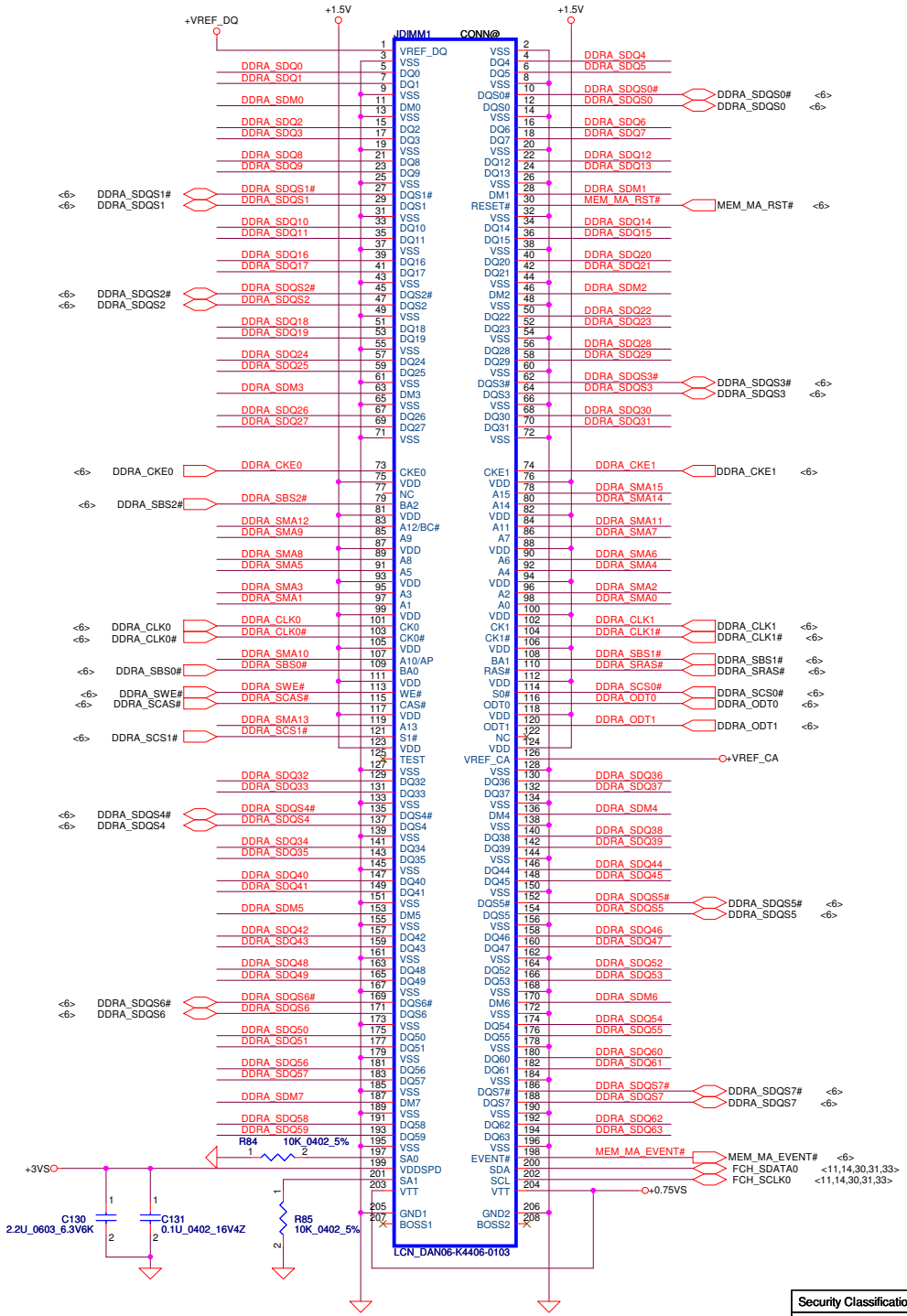

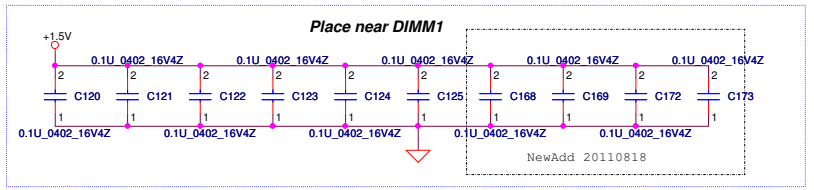

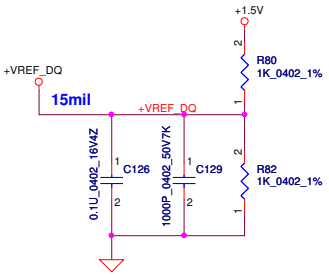

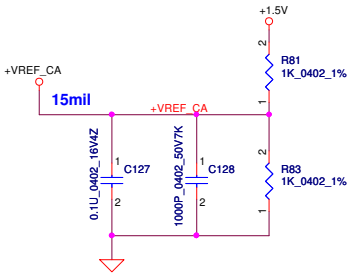

Reverse H:4mm

<Address: 00>

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Compal Electronics, Inc.			
Title	DDRIII SO-DIMM 1		
Size Custom	Document Number LA8251P		Rev 1.0
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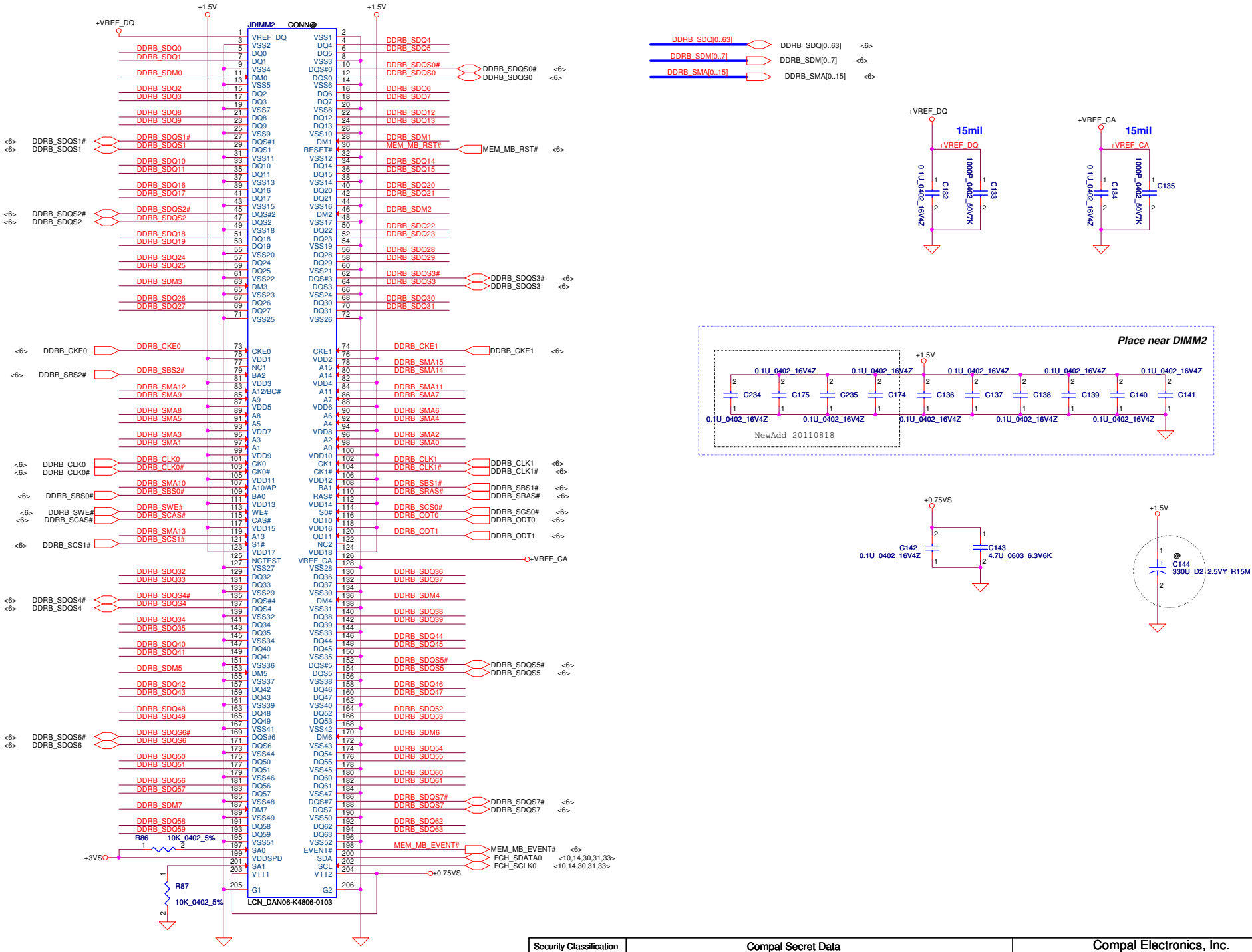

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Title: DDRIII SO-DIMM 2

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R90/ C146 close to FCH

U2
R3@
FCH-M3
Part Number = SA000043I3L

R90 2 1 100K_0402_5%
C146 1 2 150P_0402_50V8J
PLT_RST# 1 R89 2 33_0402_5% APU_PCIE_RST#_C A_RST# AE2 AD5

U2A

HUDSON-2

PCI_CLKS
PCICLK0 AF3
PCICLK1/GPO36 AF1
PCICLK2/GPO37 AF5
PCICLK3/GPO38 AG2
PCICLK4/14M_OSC/GPO39 AF6
PCIRST# AB5

PCI_CLK1 <16>
PCI_CLK3 <16>
PCI_CLK4 <16>

PCI EXPRESS INTERFACES

<5> UMI_RXP0 C147 1 2 0.1U_0402_16V7K UMI_RXP0_C AE30 UMI_TX0P
<5> UMI_RXN0 C148 1 2 0.1U_0402_16V7K UMI_RXN0_C AE32 UMI_TX0N
<5> UMI_RXP1 C149 1 2 0.1U_0402_16V7K UMI_RXP1_C AD33 UMI_TX1P
<5> UMI_RXN1 C150 1 2 0.1U_0402_16V7K UMI_RXN1_C AD31 UMI_TX1N
<5> UMI_RXP2 C151 1 2 0.1U_0402_16V7K UMI_RXP2_C AD28 UMI_TX2P
<5> UMI_RXN2 C152 1 2 0.1U_0402_16V7K UMI_RXN2_C AD29 UMI_TX2N
<5> UMI_RXP3 C153 1 2 0.1U_0402_16V7K UMI_RXP3_C AC30 UMI_TX3P
<5> UMI_RXN3 C154 1 2 0.1U_0402_16V7K UMI_RXN3_C AC32 UMI_TX3N

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<5> UMI_TXN0 AB31 UMI_RX0N
<5> UMI_TXP1 AB28 UMI_RX1P
<5> UMI_TXN1 AB29 UMI_RX1N
<5> UMI_TXP2 Y33 UMI_RX2P
<5> UMI_TXN2 Y31 UMI_RX2N
<5> UMI_TXP3 Y28 UMI_RX3P
<5> UMI_TXN3 Y29 UMI_RX3N

+VDDAN_11_PCIE
R94 1 2 590_0402_1% PCIE_CALRP AF29 PCIE_CALRP
R88 1 2 2K_0402_1% PCIE_CALRN AF31 PCIE_CALRN

V33 GPP_TX0P
V31 GPP_TX0N
W30 GPP_TX1P
W32 GPP_TX1N
AB26 GPP_TX2P
AB27 GPP_TX2N
AA24 GPP_TX3P
AA23 GPP_TX3N

AA27 GPP_RX0P
AA26 GPP_RX0N
W27 GPP_RX1P
V27 GPP_RX1N
V26 GPP_RX2P
W26 GPP_RX2N
W24 GPP_RX3P
W23 GPP_RX3N

Move PCIE device to APU. 20110819

PCI INTERFACE

PCI_AD23 <16>
PCI_AD24 <16>
PCI_AD25 <16>
PCI_AD26 <16>
PCI_AD27 <16>

AD0/GPIO0 AJ3
AD1/GPIO1 AL5
AD2/GPIO2 AG4
AD3/GPIO3 AL6
AD4/GPIO4 AH3
AD5/GPIO5 AJ5
AD6/GPIO6 AL1
AD7/GPIO7 AN5
AD8/GPIO8 AN6
AD9/GPIO9 AJ1
AD10/GPIO10 AL8
AD11/GPIO11 AL3
AD12/GPIO12 AM7
AD13/GPIO13 AJ6
AD14/GPIO14 AK7
AD15/GPIO15 AN8
AD16/GPIO16 AG9
AD17/GPIO17 AM11
AD18/GPIO18 AJ10
AD19/GPIO19 AL12
AD20/GPIO20 AK11
AD21/GPIO21 AN12
AD22/GPIO22 AG12
AD23/GPIO23 AE12
AD24/GPIO24 AC12
AD25/GPIO25 AE13
AD26/GPIO26 AF13
AD27/GPIO27 AH13
AD28/GPIO28 AH14
AD29/GPIO29 AD15
AD30/GPIO30 AC15
AD31/GPIO31 AE16
CBE0# AN3
CBE1# AJ8
CBE2# AN10
CBE3# AD12
FRAME# AG10
DEVSEL# AK9
IRDY# AL10
TRDY# AF10
PAR AE10
STOP# AH1
PERR# AM9
SERR# AH8
REQ0# AG15
REQ1#/GPIO40 AG13
REQ2#/CLK_REQ8#/GPIO41 AF13
REQ3#/CLK_REQ5#/GPIO42 AM17
GNT0# AD16
GNT1#/GPIO44 AD13
GNT2#/SD_LED/GPO45 AD21
GNT3#/CLK_REQ7#/GPIO46 AK17
CLKRUN# AD19
LOCK# AH9
INTE#/GPIO32 AF18
INTF#/GPIO33 AE18
INTG#/GPIO34 AC16
INTH#/GPIO35 AD18

HDD_FALL_INT
HDD_FALL_INT <30>

T14
XCRD_CLKREQ#
R223 1 @ 2 0_0402_5%
R224 1 @ 2 0_0402_5%
PXS_RST# <14,17>
PXS_PWREN <14,19,42,44>
XCRD_CLKREQ# <33>

+3VS
EXP@ 8.2K_0402_5% RX6

CLOCK GENERATOR

R95 1 2 2K_0402_1% CLK_CALRN F27
+1.1VS_CKVDD

CLK_CALRN
G30 PCIE_RCLKP
G28 PCIE_RCLKN
R26 DISP_CLKP
T26 DISP_CLKN
H33 DISP2_CLKP
H31 DISP2_CLKN
T24 APU_CLKP
T23 APU_CLKN
J30 SLT_GFX_CLKP
K29 SLT_GFX_CLKN
H27 GPP_CLK0P
H28 GPP_CLK0N
J27 GPP_CLK1P
K26 GPP_CLK1N
F33 GPP_CLK2P
F31 GPP_CLK2N
E33 GPP_CLK3P
E31 GPP_CLK3N
M23 GPP_CLK4P
M24 GPP_CLK4N
M27 GPP_CLK5P
M26 GPP_CLK5N
N25 GPP_CLK6P
N26 GPP_CLK6N
R23 GPP_CLK7P
R24 GPP_CLK7N
N27 GPP_CLK8P
R27 GPP_CLK8N

SS
For "EXT" CLK mode, input to PCIE,
APU DISP <7> APU_DISP_CLK <7> APU_DISP_CLK#
NSS
APU <7> APU_CLK <7> APU_CLK#
VGA <17> CLK_PCIE_VGA <17> CLK_PCIE_VGA#
0_0402_5% 1 ShortPad 2 R98 CLK_PCIE_VGA_R
0_0402_5% 1 ShortPad 2 R99 CLK_PCIE_VGA#_R
SS
WLAN <31> CLK_PCIE_WLAN <31> CLK_PCIE_WLAN#
GLAN <31> CLK_PCIE_LAN <31> CLK_PCIE_LAN#
0_0402_5% 1 ShortPad 2 R102 CLK_PCIE_WLAN_R
0_0402_5% 1 ShortPad 2 R103 CLK_PCIE_WLAN#_R
0_0402_5% 1 ShortPad 2 R100 CLK_PCIE_LAN_R
0_0402_5% 1 ShortPad 2 R101 CLK_PCIE_LAN#_R
ExCARD <33> CLK_PCIE_XCRD <33> CLK_PCIE_XCRD#
RX7 1 EXP@ 2 0_0402_5% CLK_PCIE_XCRD_R
RX8 1 EXP@ 2 0_0402_5% CLK_PCIE_XCRD#_R
New Add

CLOSE TO R680
<37> LAN_X1 R801 1 2 CLK_LAN_25M 0_0402_5% @

CLOSE TO X1
<37> PCH_X1 R800 1 2 25M_X1 0_0402_5% @

<31> CLK_LAN_25M R680 1 @ 2 22_0402_5% CLK_LAN_25M_R J26 14M_25M_48M_OSC

CH27 1 2 10P_0402_50V8J~D
YH2 25MHZ_10PF_7V25000014 GND OSC
CH28 1 2 10P_0402_50V8J~D
25M_X1 C31 25M_X1
R106 1M_0402_5%
25M_X2 C33 25M_X2

+3VALW
C789 @ 1 2 0.1U_0402_16V4Z
MC74VHC1G08DFT2G SC70 5P U43
APU_PCIE_RST# C 1 R692 @ 2 33_0402_5%
C790 @ 150P_0402_50V8J
R693 @ 8.2K_0402_5%
@R695 0_0402_5%
R694 0_0402_5% ShortPad
APU_PCIE_RST# <17>
PLT_RST# <31,33,34>

For PCIE device reset on FS1
(GFX,GLAN,WLAN,LVDS Travis)
APU_PCIE_RST #: Reset PCIE device on APU

R692/ C790 close to FCH

QCL10 LAN-APU,WLAN&ExCARD-FCH 20110803

APU

DMA_ACTIVE# G25
PROCHOT# E28 APU_PROCHOT#_R R15 1 @ 2 0_0402_5%
APU_PG E26 APU_PWRGD <46,7>
LDT_STP# G26 APU_RST# <7>
APU_RST# F26

ALLOW_STOP <7>
APU_PROCHOT# <39,46,7>

APU_PG/APU_RST#/LDT_STP# : OD pin
DMA_ACTIVE# : IN/OD, 0.8V threshold
PROCHOT# : IN, 0.8V threshold
LDT_STP : No use, NC
DMA active. The FCH drives the DMA_ACTIVE# to APU to notify DMA activity. This will cause the APU to reestablish the UMI link quicker.

LPC

LPCCLK0 B25 CLK_EC33M 1 R222 2 22_0402_5%
CLK_PCI_EC <16,34>

LPCCLK1 D25 LPC_CLK1 <16>
LAD0 C28 LPC_AD0 <34>
LAD1 A26 LPC_AD1 <34>
LAD2 A29 LPC_AD2 <34>
LAD3 A31 LPC_AD3 <34>
LFRAME# B27 LPC_FRAME# <34>
LDRQ0# AE27
LDRQ1#/CLK_REQ6#/GPIO49 AE19
SERIRQ/GPIO48 SERIRQ <34>

S5_PLUS

S5_CORE_EN H7
RTCCLK F1 RTC_CLK <16,34>
INTRUDER_ALERT# F3
VDDBT_RTC_G E6 +VDDBT_RTC
32K_X1 G2 32K_X1
32K_X2 G4 32K_X2

+RTCBATT
R135 1 2 +VCOIN 510_0402_5%
+3VLP
D8 RB751V40_SC76-2
D5 RB751V40_SC76-2
+VCOIN_RTC
R105 1 2 510_0402_5%
W=20mils
W=20mils
1U_0402_6.3V6K C156
CLRP1 @ SHORT PADS
R109 10M_0402_5% @
for Clear CMOS

C158 2 1 18P_0402_50V8J
R107 20M_0402_5%~D
32.768KHZ_12.5PF_9H03200019 Y1
C159 2 1 18P_0402_50V8J
32K_X1
32K_X2
Close to HUDSON-M2/3

CLOSE TO Y1
<37> FCH_RTCX1 R803 1 2 32K_X1 0_0402_5% @

218-0755097 A14 HUDSON-M3_FCBGA656

Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

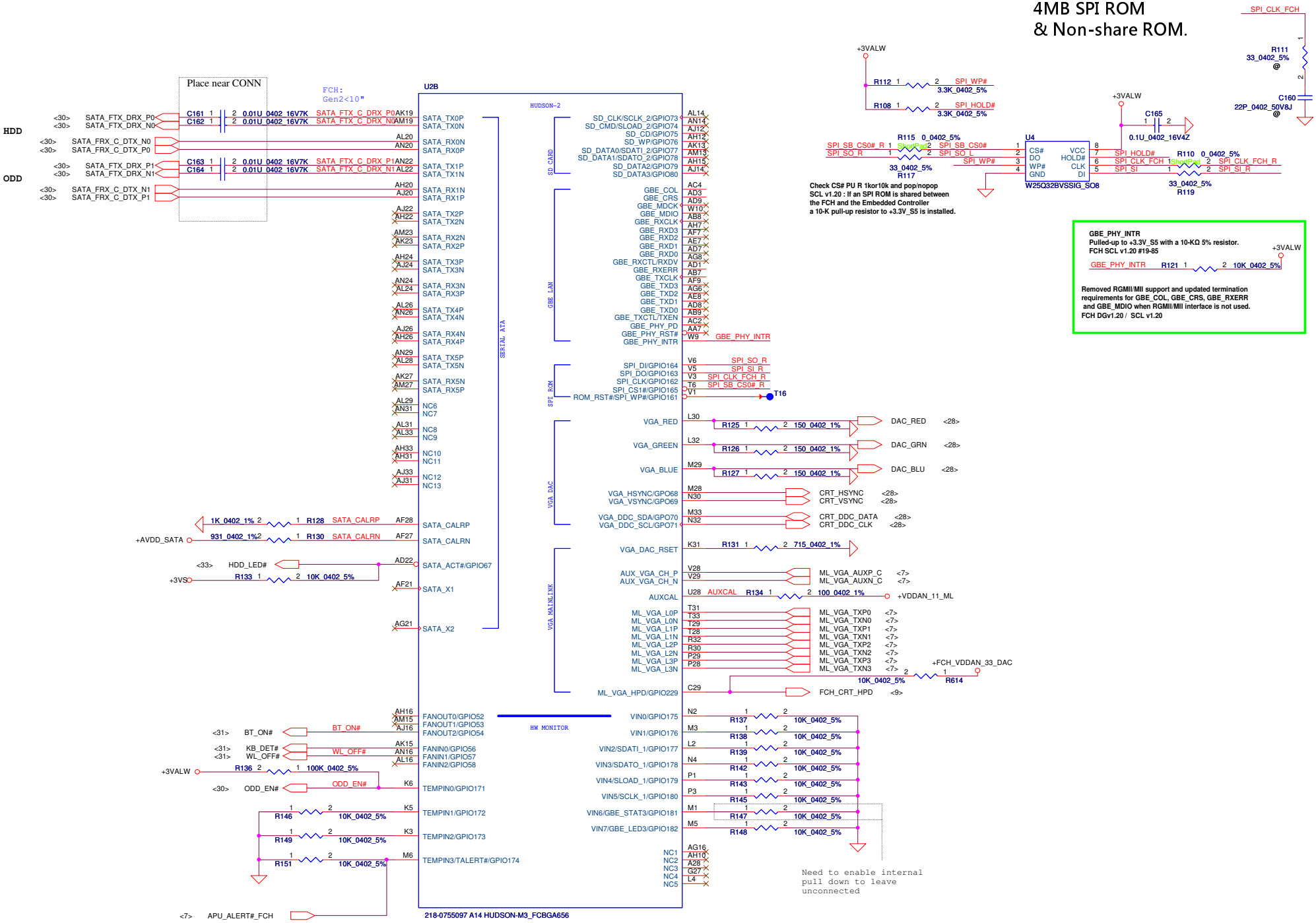
Compal Electronics, Inc.

Title: FCH PCIE/CLK/PCI/LPC/RTC

Size	Document Number	Rev
Custom	LA8251P	1.0

Date: Monday, July 16, 2012 Sheet 12 of 50

4MB SPI ROM & Non-share ROM.



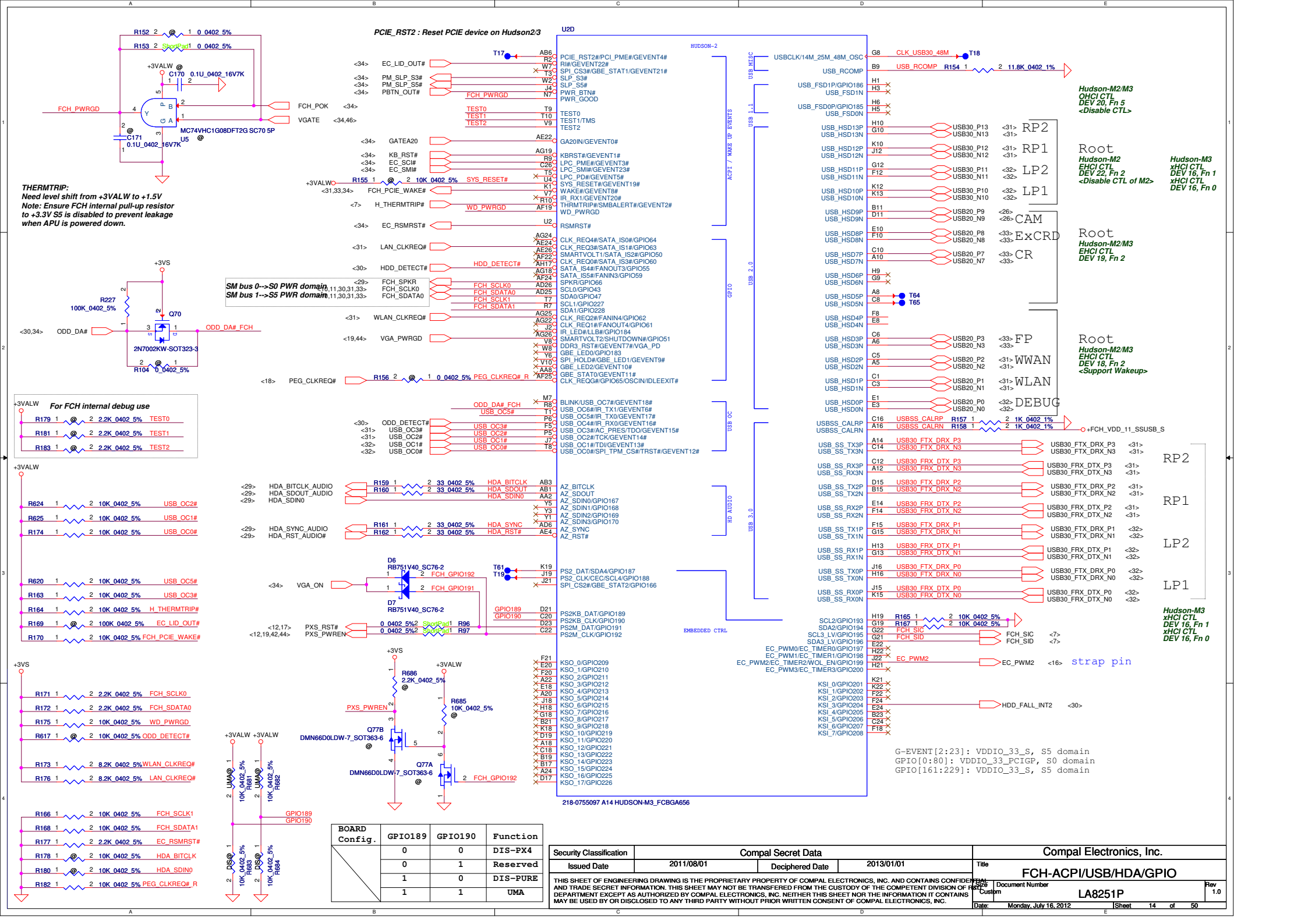
Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.

Title: FCH SATA/SPI/VGA/HWM/SD

Size: Custom | Document Number: LA8251P | Rev: 1.0

Date: Monday, July 16, 2012 | Sheet 13 of 50



BOARD Config.	GPIO189	GPIO190	Function
	0	0	DIS-PX4
	0	1	Reserved
	1	0	DIS-PURE
	1	1	UMA

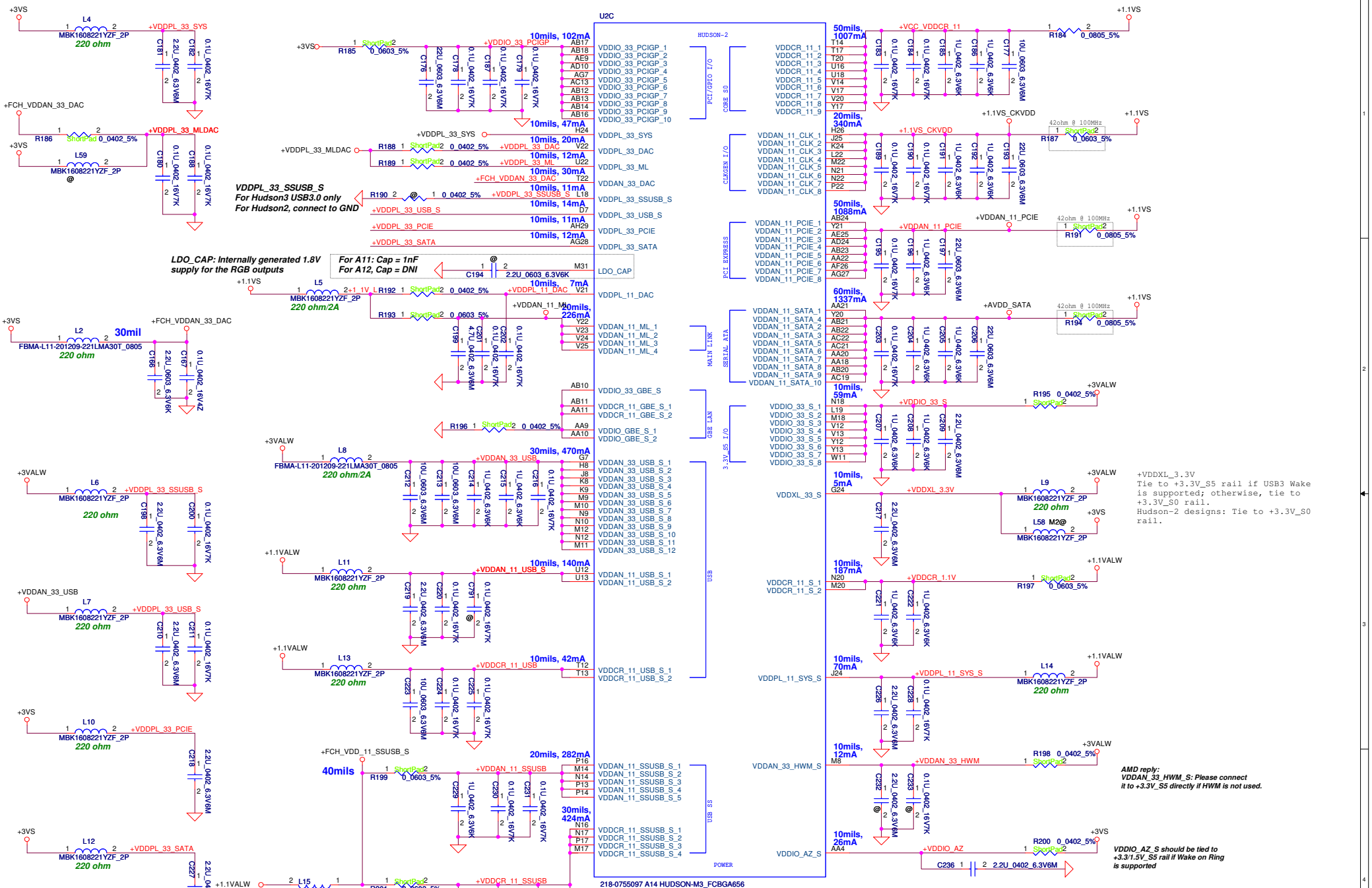
Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.

Title: FCH-ACPI/USB/HDA/GPIO

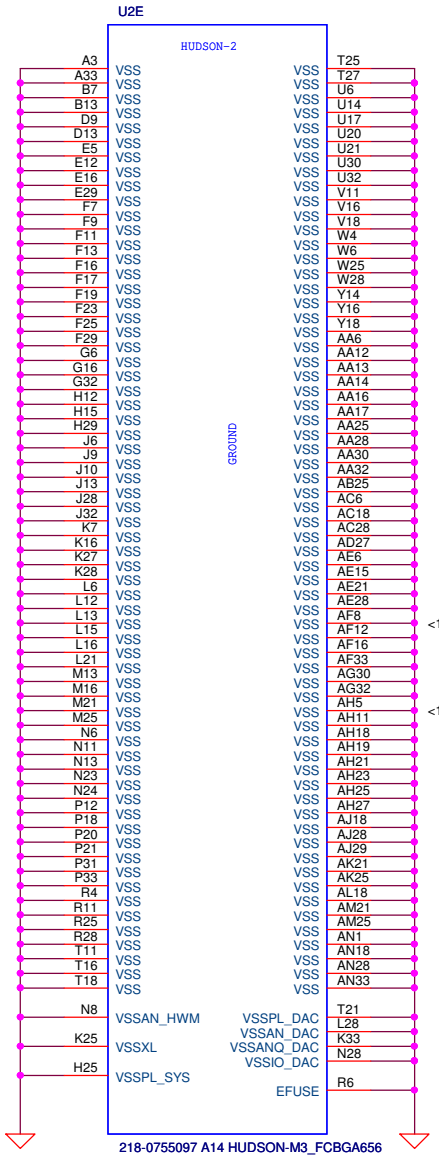
Size: Custom | Document Number: LA8251P | Rev: 1.0

Date: Monday, July 16, 2012 | Sheet 14 of 50



Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.			
Title: FCH-PWR			
Size: Custom	Document Number: LA8251P		Rev: 1.0
Date: Monday, July 16, 2012	Sheet 15 of 50		



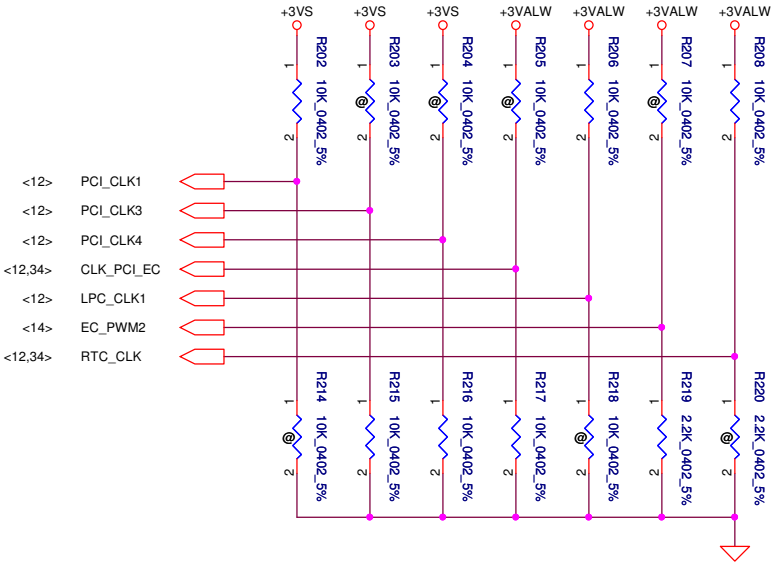
STRAP PINS

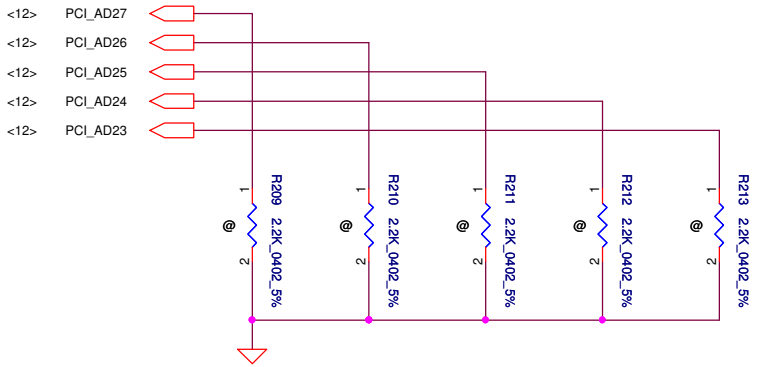
	PCI_CLK1	PCI_CLK3	PCI_CLK4	LPC_CLK0_EC	LPC_CLK1	EC_PWM2	RTC_CLK
PULL HIGH	ALLOW PCIE GEN2 DEFAULT	USE DEBUG STRAPS	NON_FUSION CLOCK MODE	EC ENABLED	CLKGEN ENABLED DEFAULT	LPC ROM	S5 PLUS MODE DISABLED DEFAULT
PULL LOW	FORCE PCIE GEN1	IGNORE DEBUG STRAP DEFAULT	FUSION CLOCK MODE DEFAULT	EC DISABLED DEFAULT	CLKGEN DISABLE	SPI ROM DEFAULT	S5 PLUS MODE ENABLED

DEBUG STRAPS

FCH HAS 15K INTERNAL PU FOR PCI_AD[27:23]

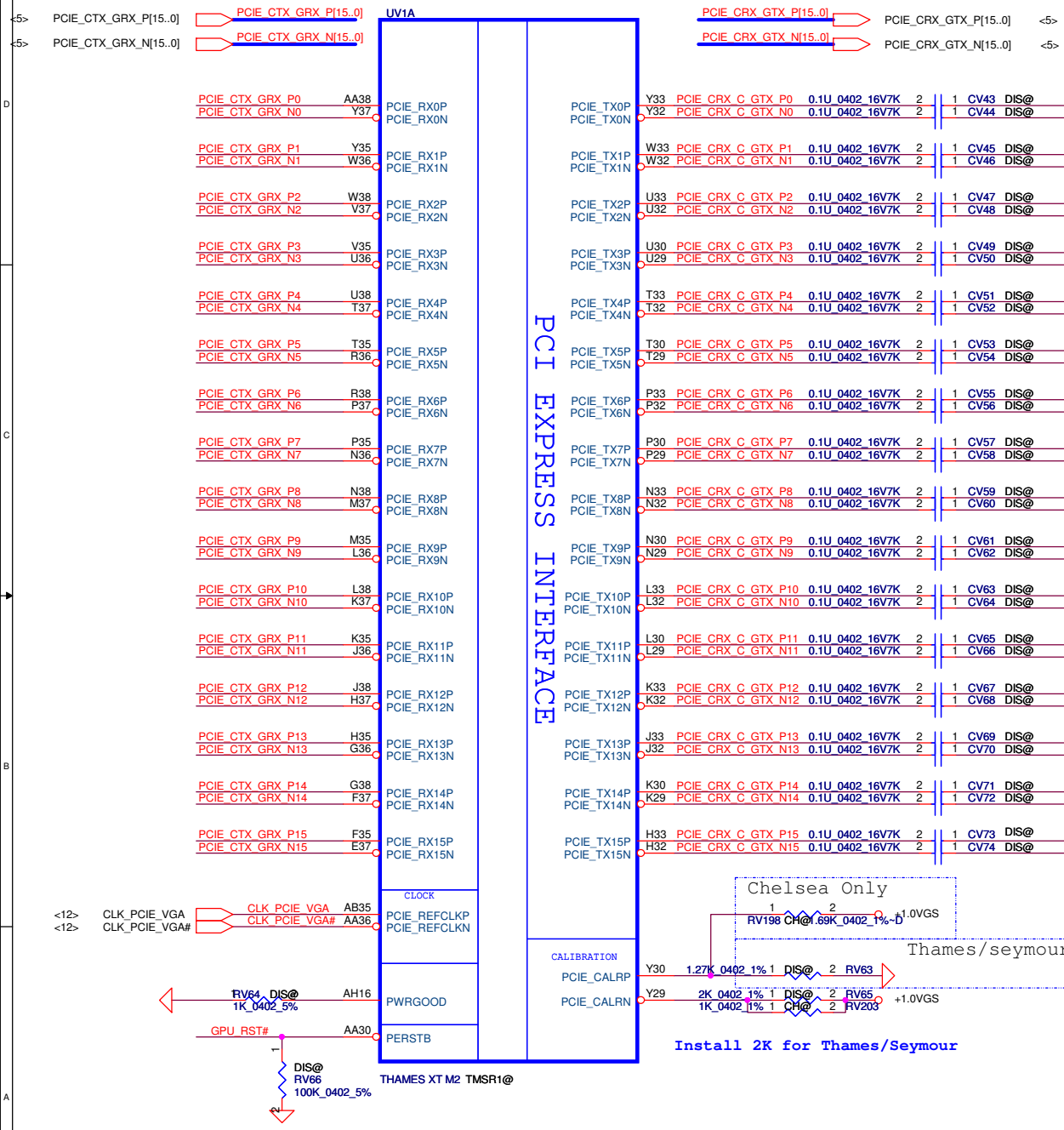
	PCI_AD27	PCI_AD26	PCI_AD25	PCI_AD24	PCI_AD23
PULL HIGH	USE PCI PLL DEFAULT	DISABLE ILA AUTORUN DEFAULT	USE FC PLL DEFAULT	USE DEFAULT PCIE STRAPS DEFAULT	DISABLE PCI MEM BOOT DEFAULT
PULL LOW	BYPASS PCI PLL	ENABLE ILA AUTORUN	BYPASS FC PLL	USE EEPROM PCIE STRAPS	ENABLE PCI MEM BOOT



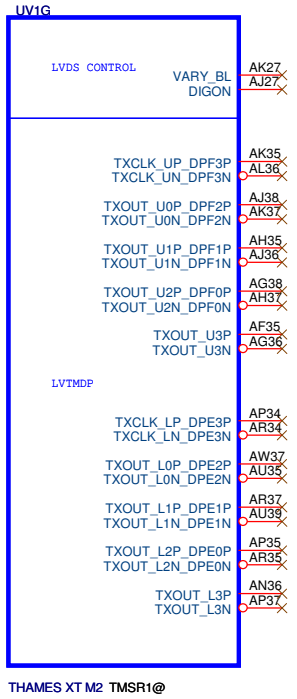


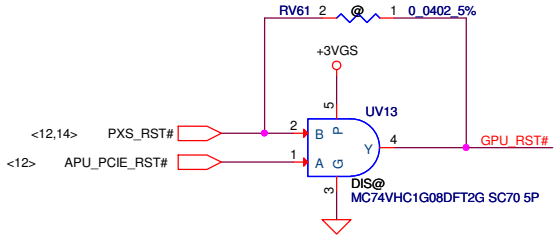
Security Classification	Compal Secret Data		Compal Electronics, Inc.
Issued Date	2011/08/01	Deciphered Date 2013/01/01	Title: FCH-VSS/Strap
			Size: B; Document Number: LA8251P; Rev: 1.0
			Date: Monday, July 16, 2012; Sheet 16 of 50

GFX PCIE LANE REVERSAL



LVDS Interface





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Issued Date	2011/08/01	Deciphered Date	2013/01/01

Title	ATI_SeymourXT_M2_PCIE/LVDS		
Size	Document Number		Rev
Custom	LA8251P		1.0
Date:	Monday, July 16, 2012	Sheet	17 of 50

CONFIGURATION STRAPS

ALLOW FOR PULLUP PADS FOR THESE STRAPS AND IF THESE GPIOS ARE USED, THEY MUST NOT CONFLICT DURING RESET

RECOMMENDED SETTINGS
0= DO NOT INSTALL RESISTOR
1 = INSTALL 10K RESISTOR
X = DESIGN DEPENDANT
NA = NOT APPLICABLE

STRAPS	PIN	DESCRIPTION OF DEFAULT SETTINGS	RECOMMENDED SETTINGS
TX_PWRS_ENB	GPIO0	PCIE FULL TX OUTPUT SWING 0: 50% swing 1: Full swing	X
TX_DEEMPH_EN	GPIO1	PCIE TRANSMITTER DE-EMPHASIS 0: disable 1: enable	X
RSVD	GPIO2	Advertises PCIE speed when compliance test 0: 2.5GT/s 1: 5GT/s	0
RSVD	GPIO8	RESERVED	0
BIF_VGA DIS	GPIO9	VGA ENABLED	0
RSVD	GPIO21	RESERVED	0
BIOS_ROM_EN	GPIO_22_ROMCSB	ENABLE EXTERNAL BIOS ROM 0: disable 1: enable	X
ROMIDCFG(2:0)	GPIO[13:11]	SERIAL ROM TYPE OR MEMORY APERTURE SIZE SELECT	XXX
VIP_DEVICE_STRAP_ENA	V2SYNC	IGNORE VIP DEVICE STRAPS	0
RSVD	H2SYNC		0
RSVD	GENERICC		0
AUD[1] AUD[0]	HSYNC VSYNC	AUD[1] AUD[0]: 0 0 No audio function; 0 1 Audio for DisplayPort and HDMI if dongle is detected; 1 0 Audio for DisplayPort only; 1 1 Audio for both DisplayPort and HDMI	11

AMD RESERVED CONFIGURATION STRAPS

ALLOW FOR PULLUP PADS FOR THESE STRAPS BUT DO NOT INSTALL RESISTOR. IF THESE GPIOS ARE USED, THEY MUST KEEP "LOW" AND NOT CONFLICT DURING RESET

GPIO21	H2SYNC	GENERICC	GPIO2	GPIO8

Vendor	VRAM_ID0	VRAM_ID1	VRAM_ID2	
64MX16 (1G) Hynix 1GB PN:SA00004LS20	RV67 1	RV70 0	RV72 0	PT
64MX16 (1G) Samsung 1GB PN:SA00004GS0L	RV68 0	RV69 1	RV72 0	PT
128MX16 (2G) Hynix 2GB PN:SA00003VQ00	RV67 1	RV70 0	RV71 1	
128MX16 (2G) Samsung 2GB PN:SA00004TQ00	RV68 0	RV69 1	RV71 1	

Not Share via for other GND

Reserved test pad of CRT Signals for debug

Add 12/8

Add 12/6 for MLPS

NC_TSVSSQ should be tied to GND on Thames/Seymour

CLOSE TO YV1

TX_PWRS_ENB	GPIO0	Transmitter Power Saving Enable 0: 50% Tx output swing for mobile mode 1: full Tx output swing (Default setting for Desktop)
TX_DEEMPH_EN	GPIO1	PCI Express Transmitter De-emphasis Enable 0: Tx de-emphasis diabled for mobile mode 1: Tx de-emphasis enabled (Default setting for desktop)

Internal VGA Thermal Sensor

VGA Thermal Sensor ADM1032ARMZ

Closed to GPU

Address:100_1101

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Compal Electronics, Inc.

Title: ATI_SeymourXT_M2_Main_MSIC

Size: Custom | Document Number: LA8251P | Rev: 1.0

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Circuits to support BACO

Switch circuits in BACO desingns for Thanes/Seymour only

55mA@1.0V, in BACO mode

for PX4.0

for PX4.0 and PX5.0

for PX5.0

PX_MODE=1 for Normal Operation

PX_MODE=0 for BACO mode to shut down power rails expcept VDDR3,PCIE_VDDC and 1.8V rail

+3.3VS TO +3.3VGS

+1.5V TO +1.5VGS

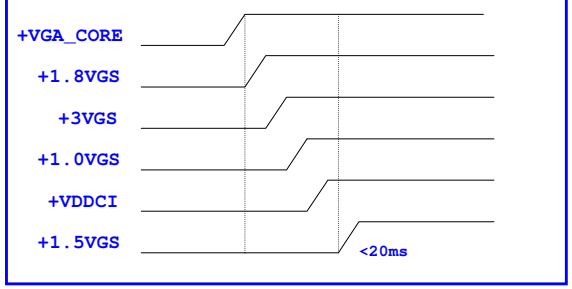
Note:

PX4.0 +VGA_CORE,VDDCI,+1.5VGS OFF

PX4.0 +3VGS, +1.0VGS,+1.8VGS ON

PX5.0 +3VGS,+VGA_CORE,VDDCI,+1.5VGV,+1.0VGS,+1.8VGS OFF

Power Seguence of Thames and Chelsea



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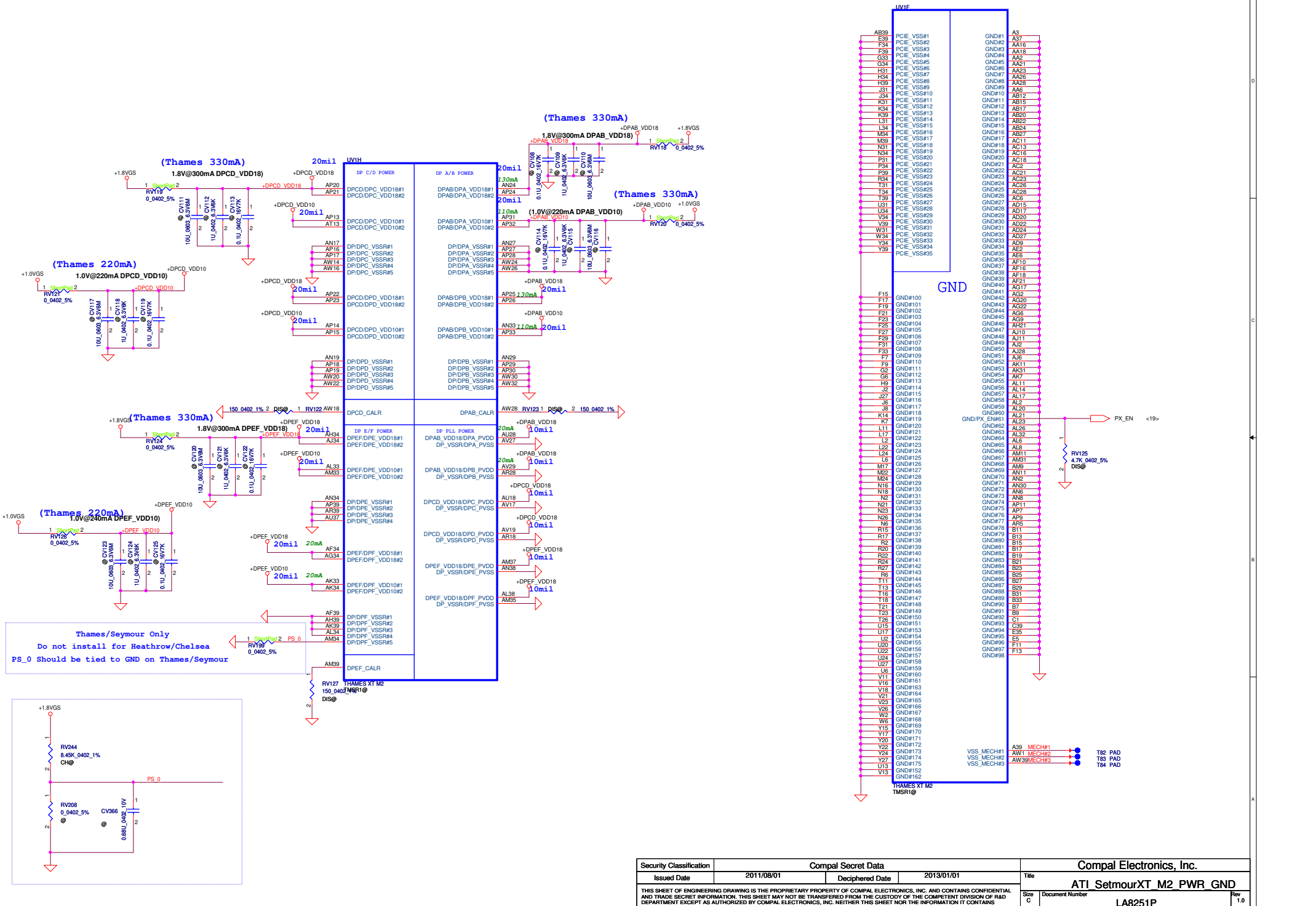
Issued Date	2011/08/01	Deciphered Date	2013/01/01
Title	ATI_SeymourXT_M2_BACO POWER		
Size C	Document Number LA8251P		Rev 1.0
Date: Monday, July 16, 2012	Sheet 19 of 50		



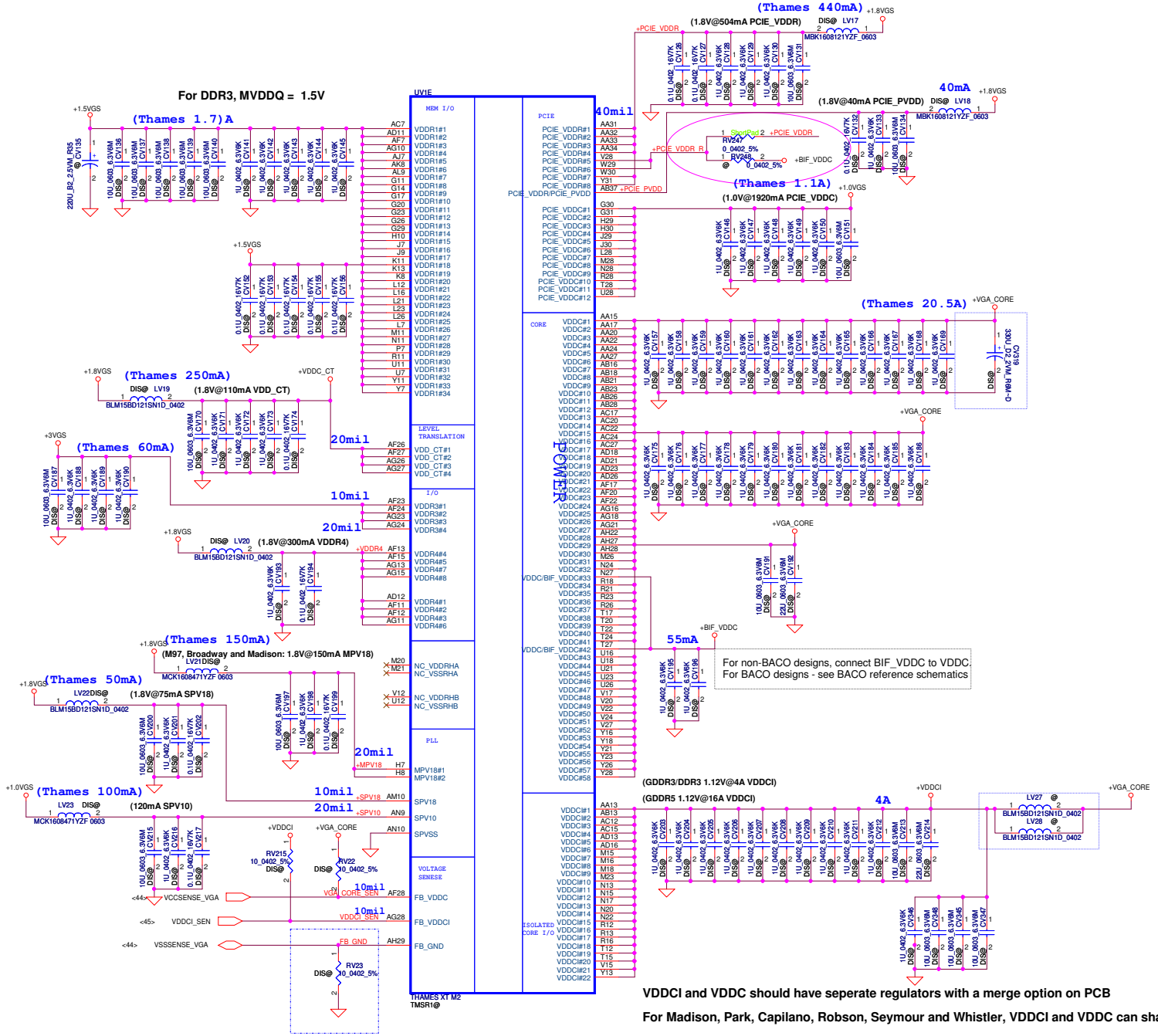
Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.

Title: ATI_SetmourXT_M2_PWR_GND

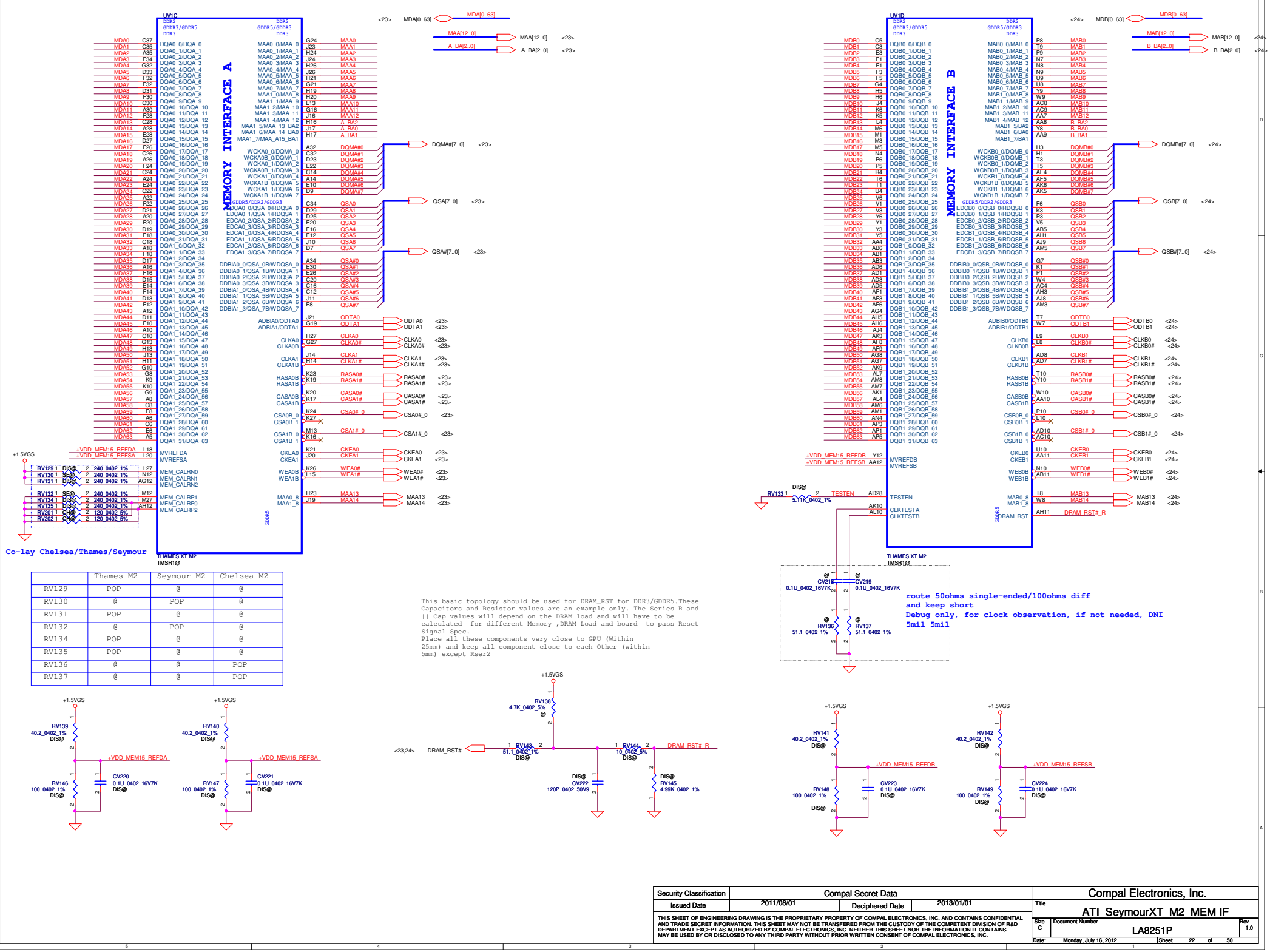
Size	Document Number	Rev
C	LA8251P	1.0

Date: Monday, July 16, 2012 Sheet 20 of 50



Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.			
Title	ATI_SeymourXT_M2_Power		
Size C	Document Number LA8251P		Rev 1.0
Date: Monday, July 16, 2012	Sheet 21 of 50		



	Thames M2	Seymour M2	Chelsea M2
RV129	POP	@	@
RV130	@	POP	@
RV131	POP	@	@
RV132	@	POP	@
RV134	POP	@	@
RV135	POP	@	@
RV136	@	@	POP
RV137	@	@	POP

Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.

Title: ATI_SeymourXT_M2_MEM IF

Size	Document Number	Rev
C	LA8251P	1.0

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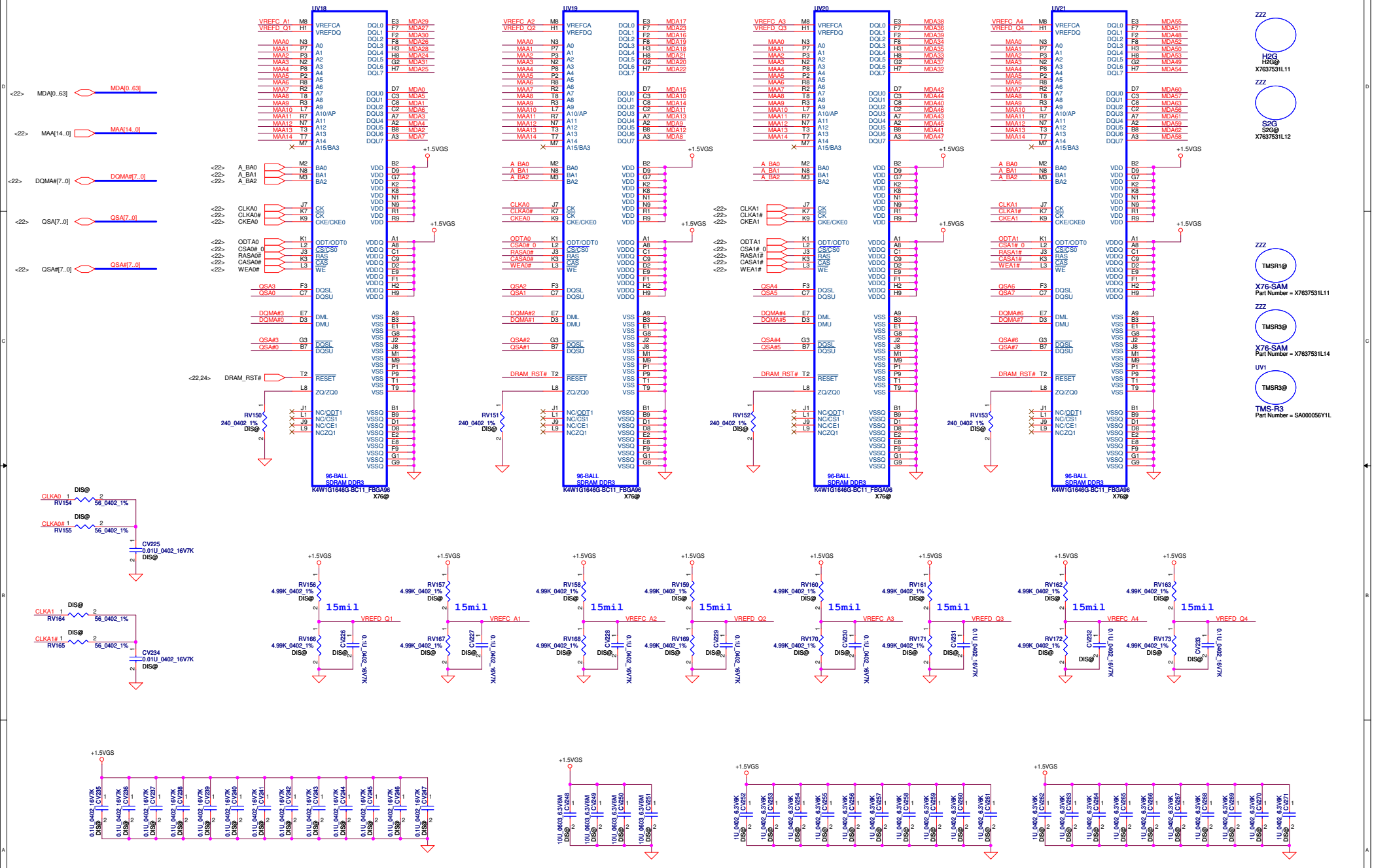
CHANNEL A: 256MB/512MB DDR3



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Compal Electronics, Inc.			
Title	ATI_SeymourXT_M2_VRAM_A		
Size C	Document Number LA8251P		Rev 1.0
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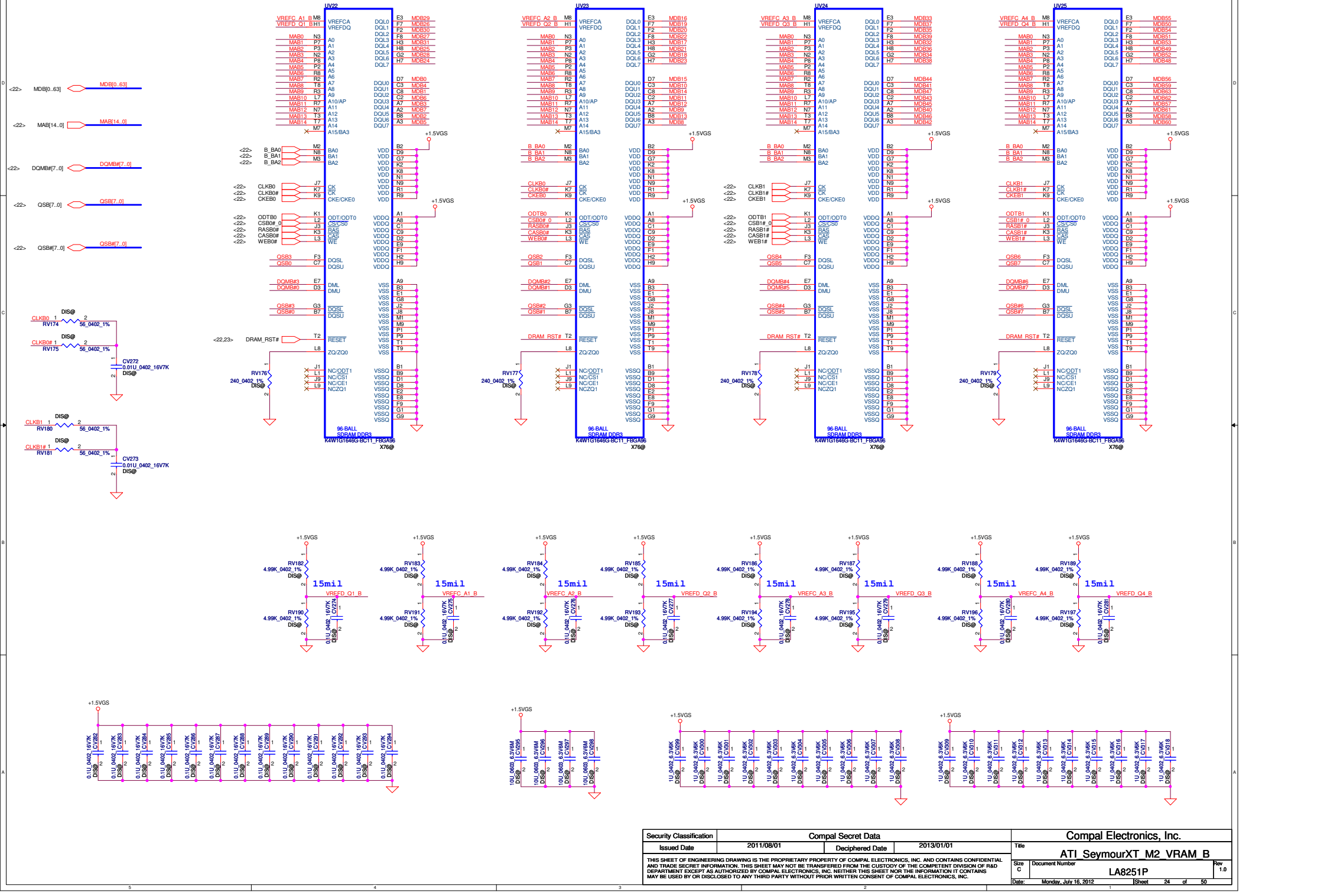
CHANNEL B: 256MB/512MB DDR3



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Title: ATI_SeymourXT_M2_VRAM_B

Size	Document Number	Rev
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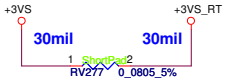
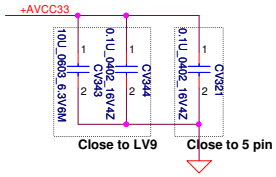
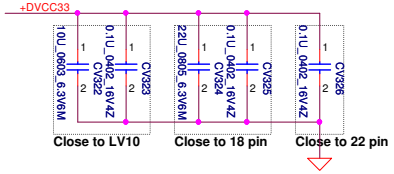
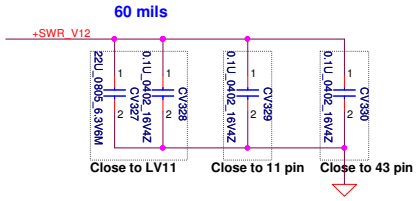
Power Consumption:

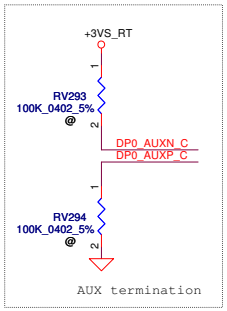
Pin5 (DPV33) < 20mA
Pin 11 (DPV12) < 100mA
Pin 15 (SWR_VCCK) < 100mA (layout trace > 60 mil)
Pin 17 (SWR_LX) < 600mA (layout trace > 60 mil)
Pin 18 (SWR_VDD) < 200mA (layout trace > 40 mil)
Pin 22 (PVCC) < 50 mA
Pin 43 (VCCK) < 50mA

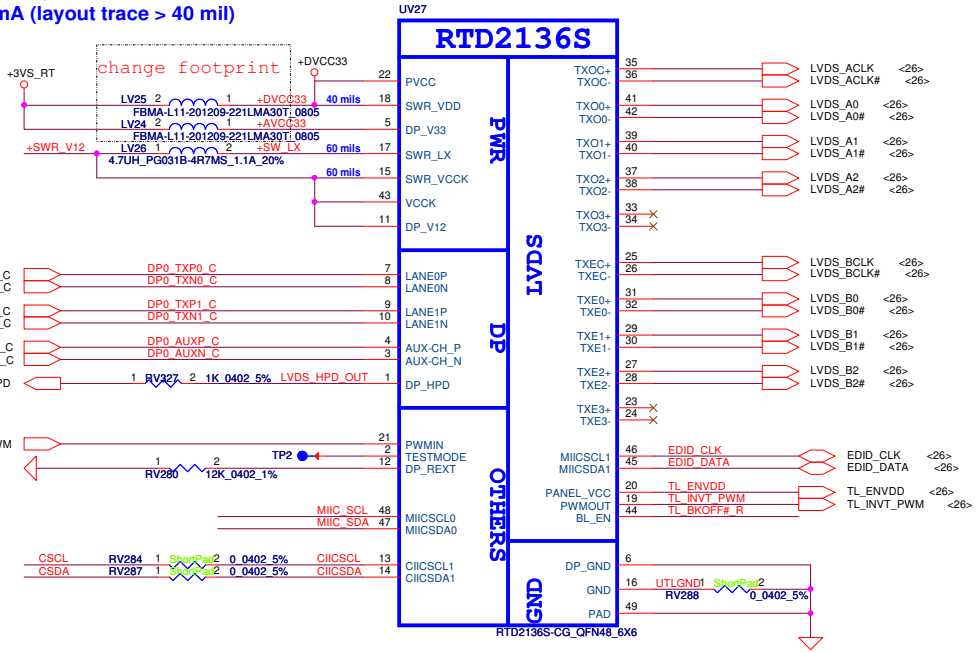


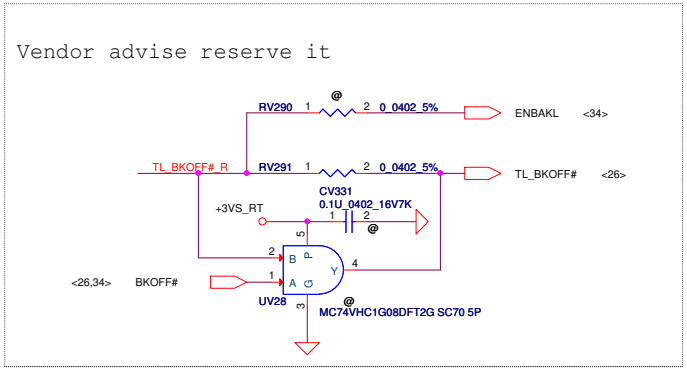


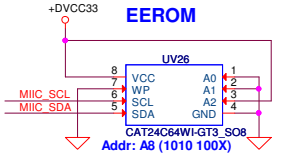


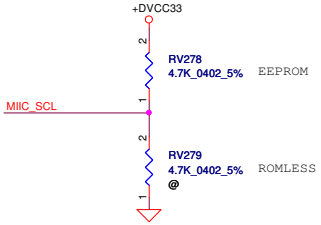


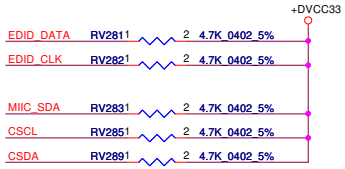


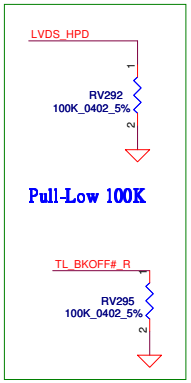












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Issued Date	2011/08/01	Deciphered Date 2013/01/01	Title: LVDS Translator - RTD2132S
Size: Custom	Document Number: LA8251P		Rev: 1.0
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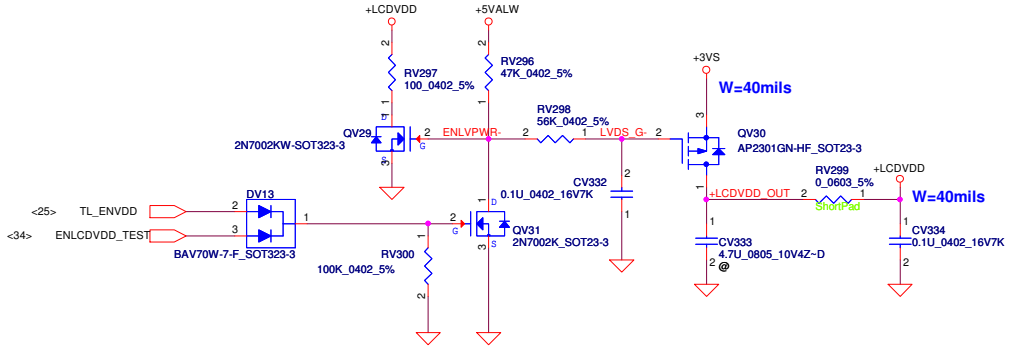
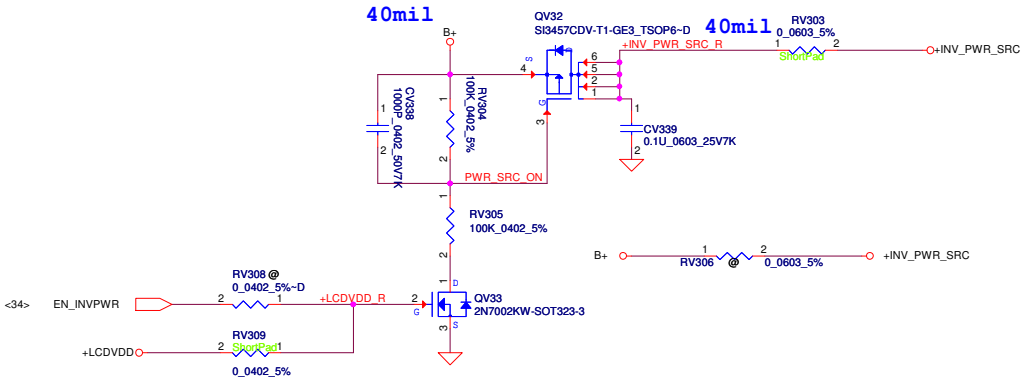
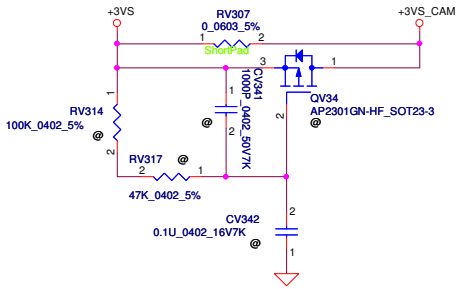
LCD PWR CTRL



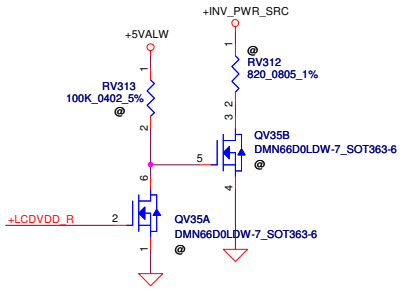
LCD backlight PWR CTRL



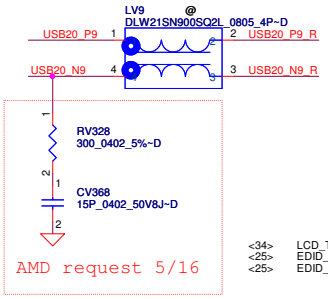
Wedcam PWR CTRL

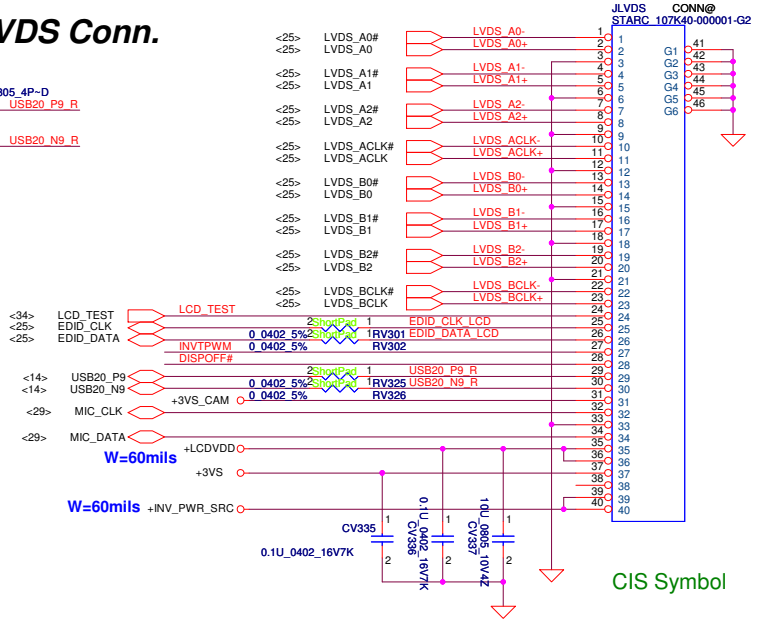


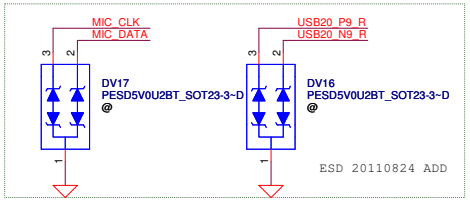
* Reserved for LCD sequence tuning

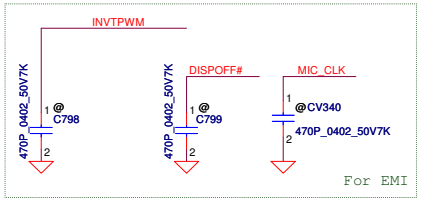


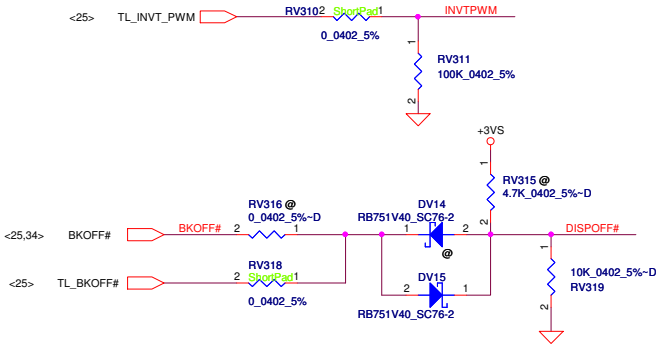
LVDS Conn.











Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.			
Title	LVDS/CAMERA		
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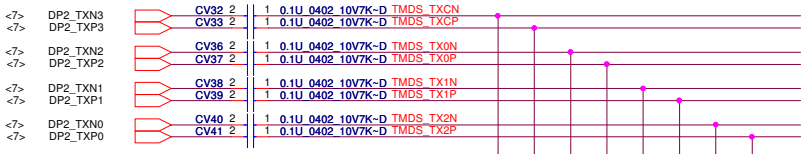
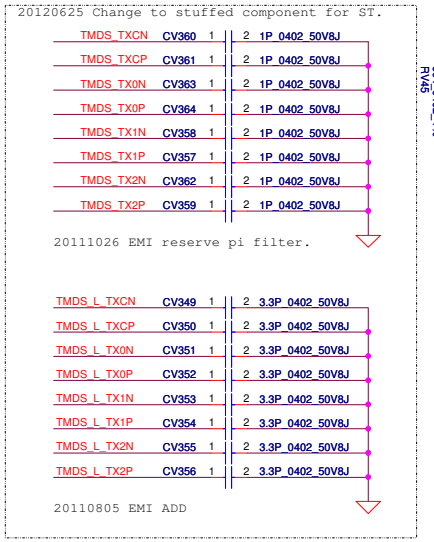
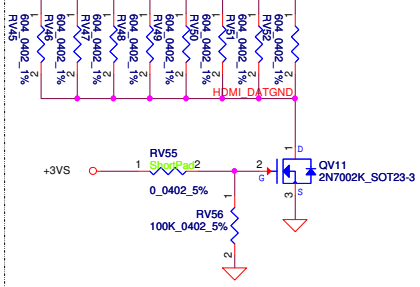
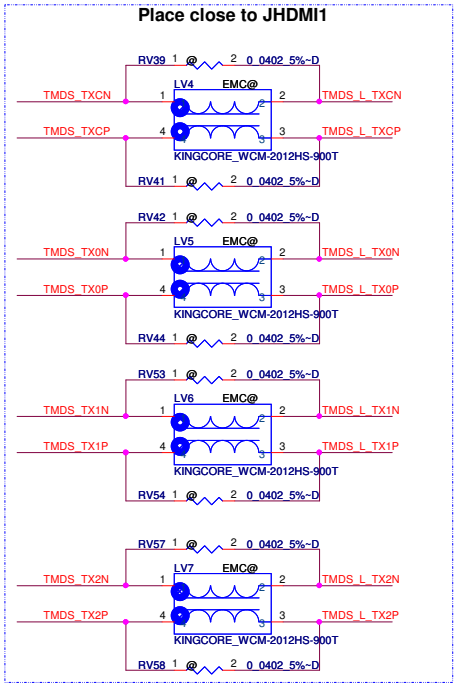
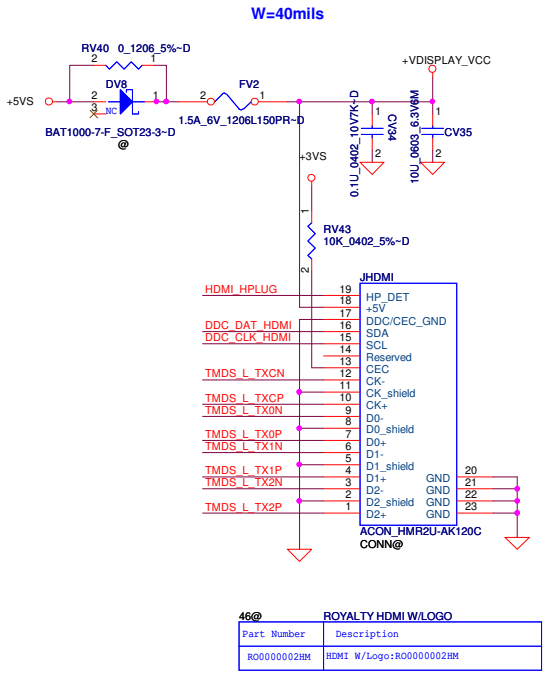




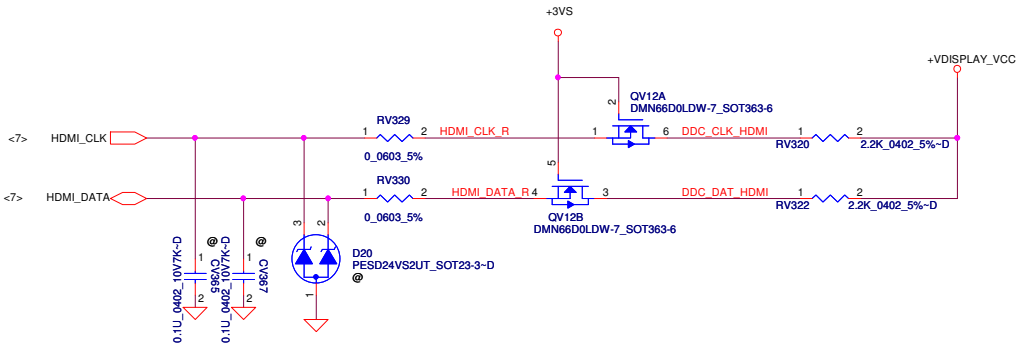


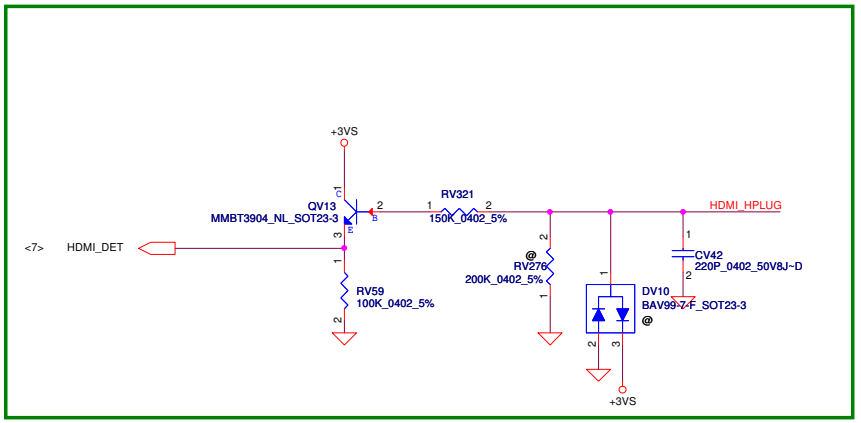




46@ ROYALTY HDMI W/LOGO

Part Number	Description
RO0000002HM	HDMI W/Logo:RO0000002HM





Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.

Title: HDMI

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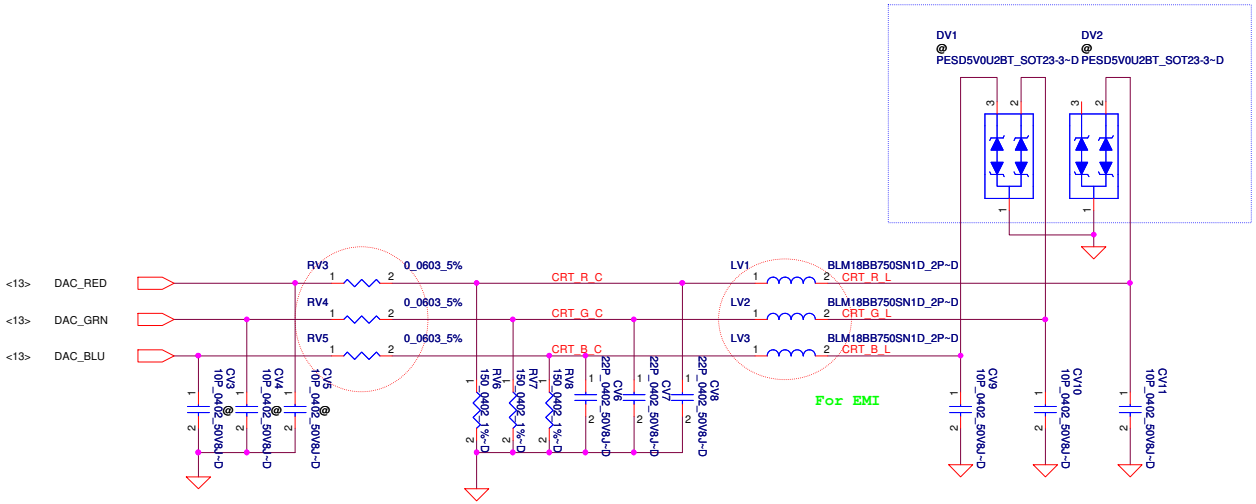
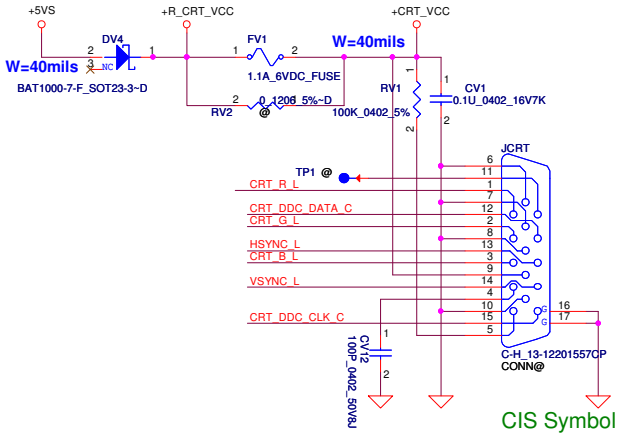
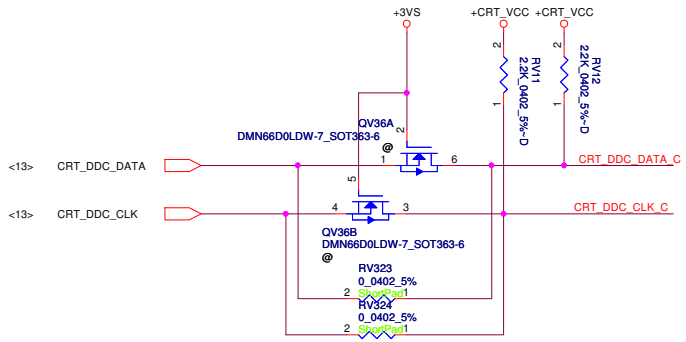
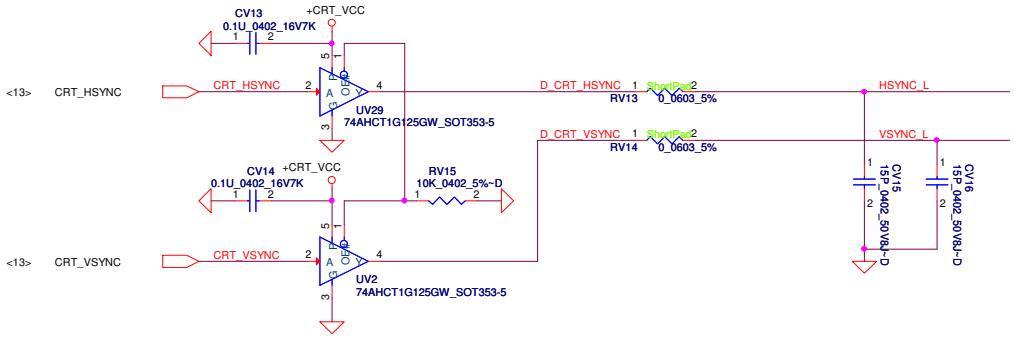
C R T



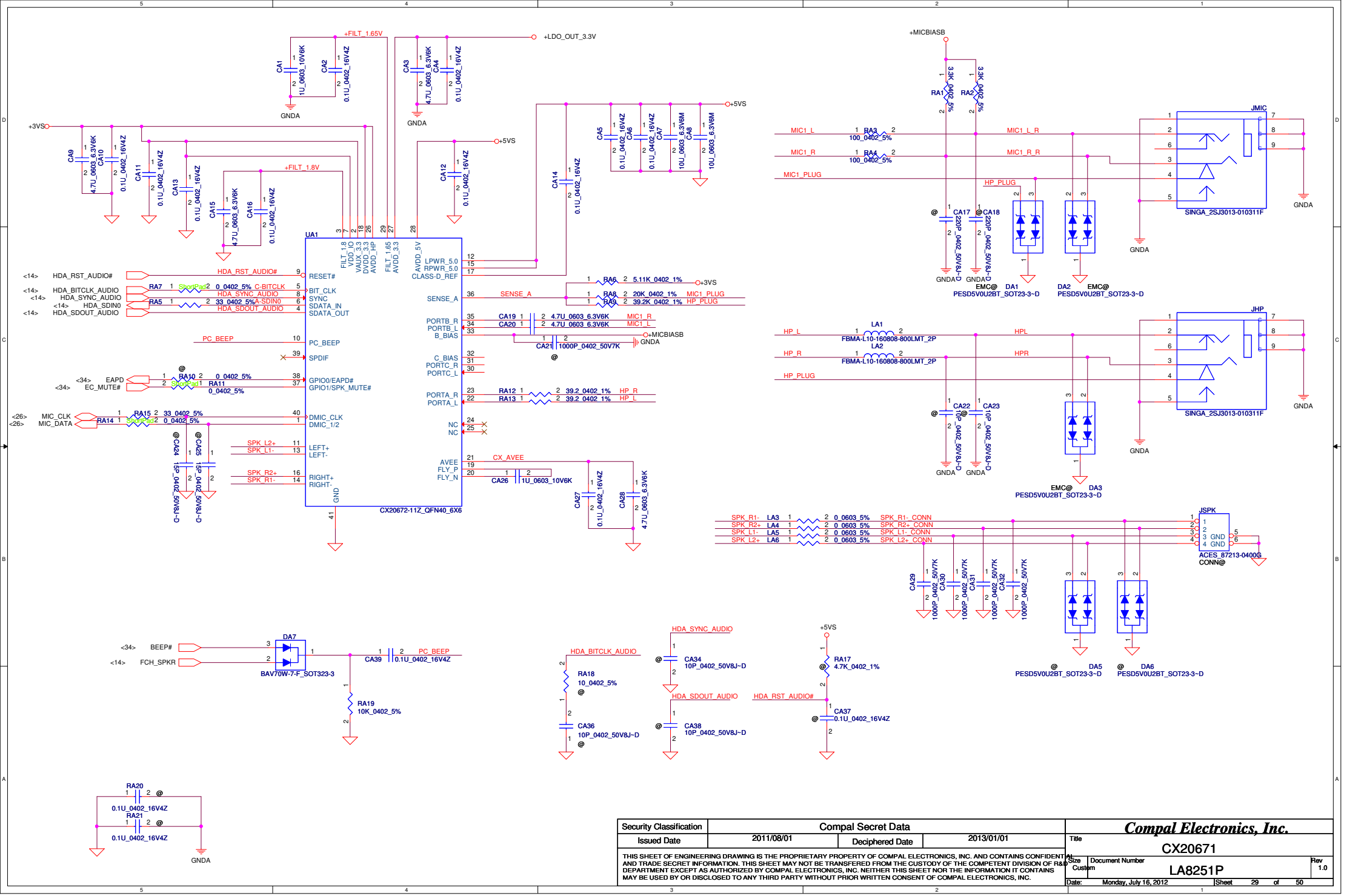






Security Classification	Compal Secret Data		Compal Electronics, Inc.
Issued Date	2011/08/01	Deciphered Date 2013/01/01	Title CRT Conn.

Size	Document Number LA8251P		Rev 1.0
Date: Monday, July 16, 2012	Sheet 28 of 50		



Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.

Title: CX20671

Size: Custom | Document Number: LA8251P | Rev: 1.0

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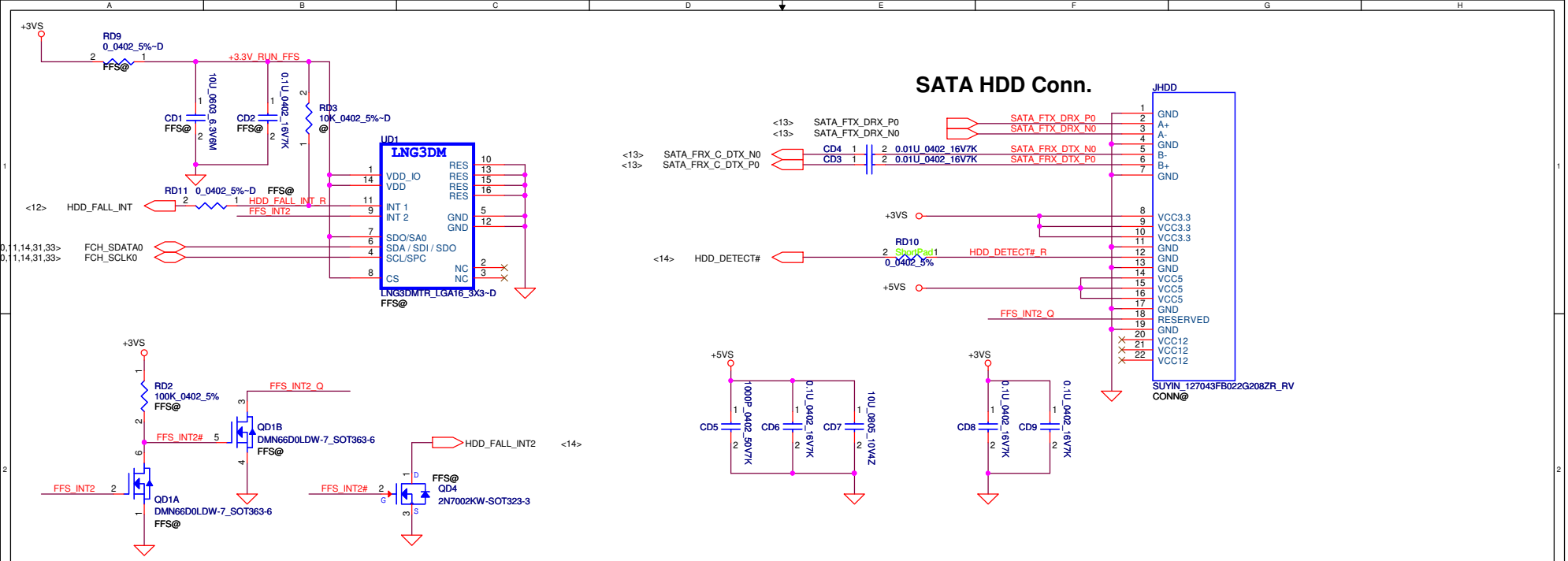

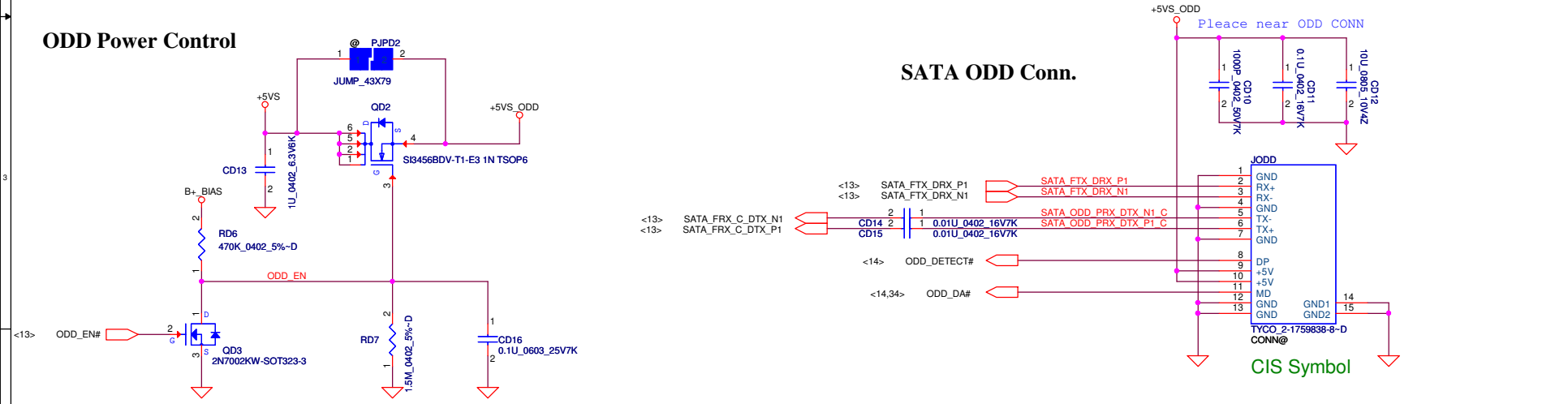

Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.

Title: HDD/ODD/FAN

Size	Document Number	Rev
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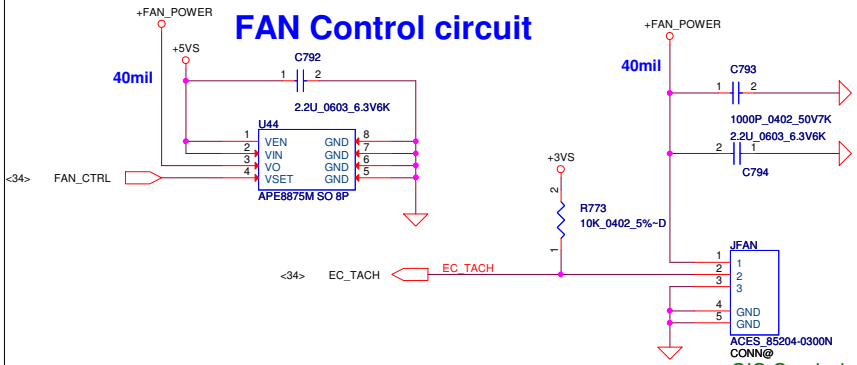
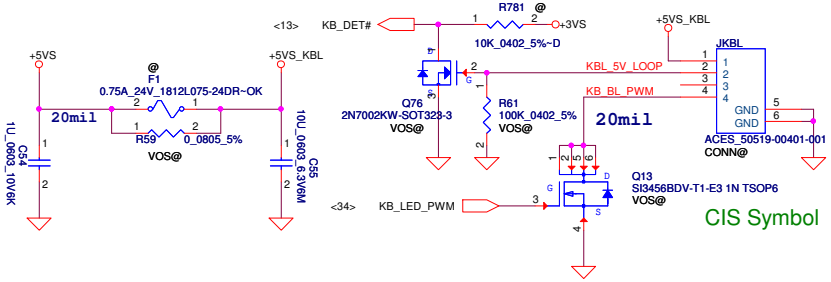
FAN Control circuit



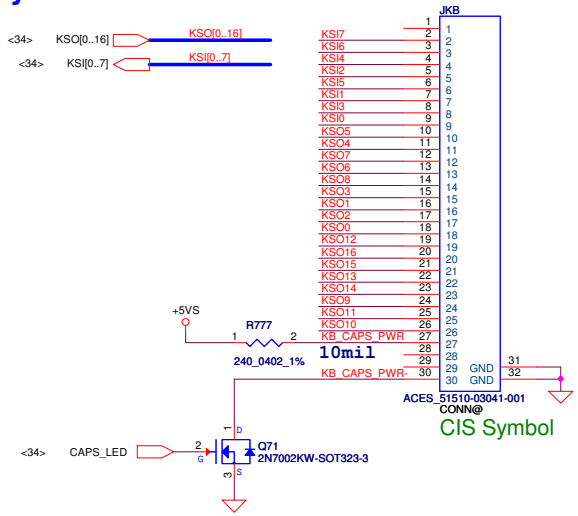
CIS Symbol

Keyboard back light



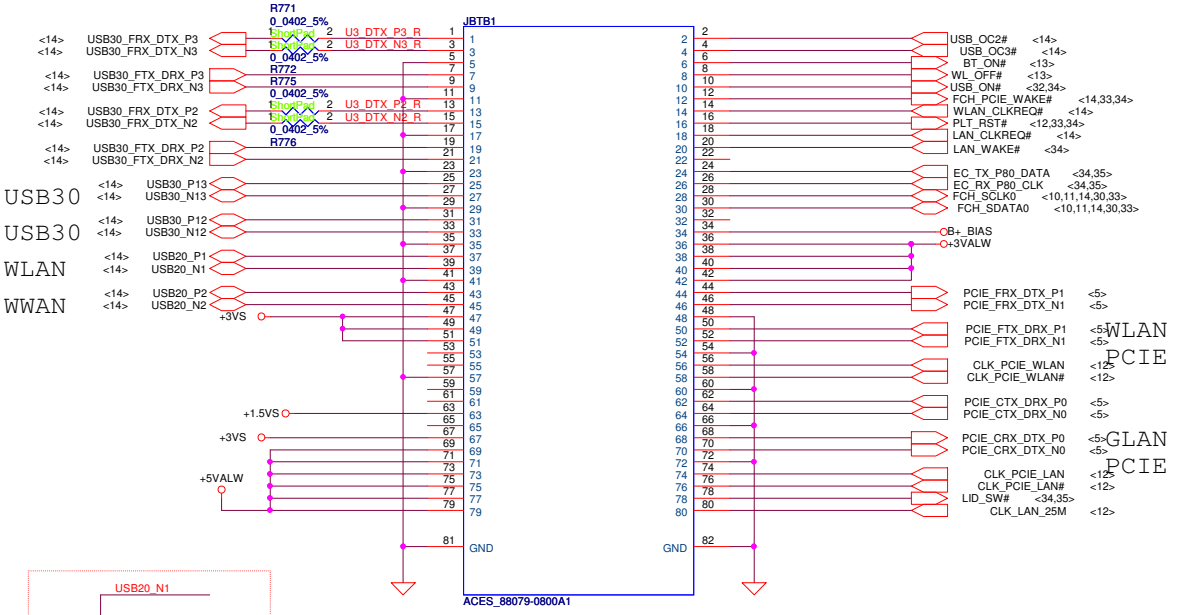
CIS Symbol

Keyboard Connector

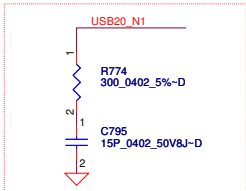


CIS Symbol

M/B to D/B BTB connector, LAN, FMC, HMC, USB3.0*2

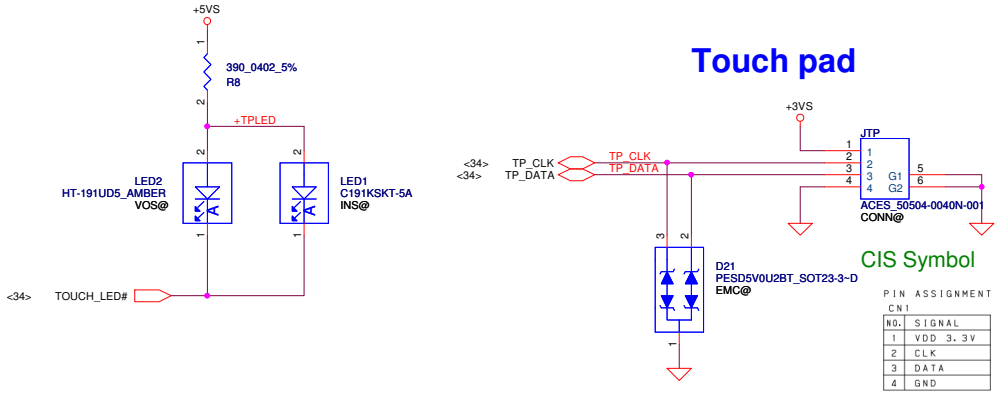


CIS Symbol, Receptacle.



AMD request 5/16

Touch pad



CIS Symbol

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Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.

Title: IO brd Conn & FAN/KB/TP

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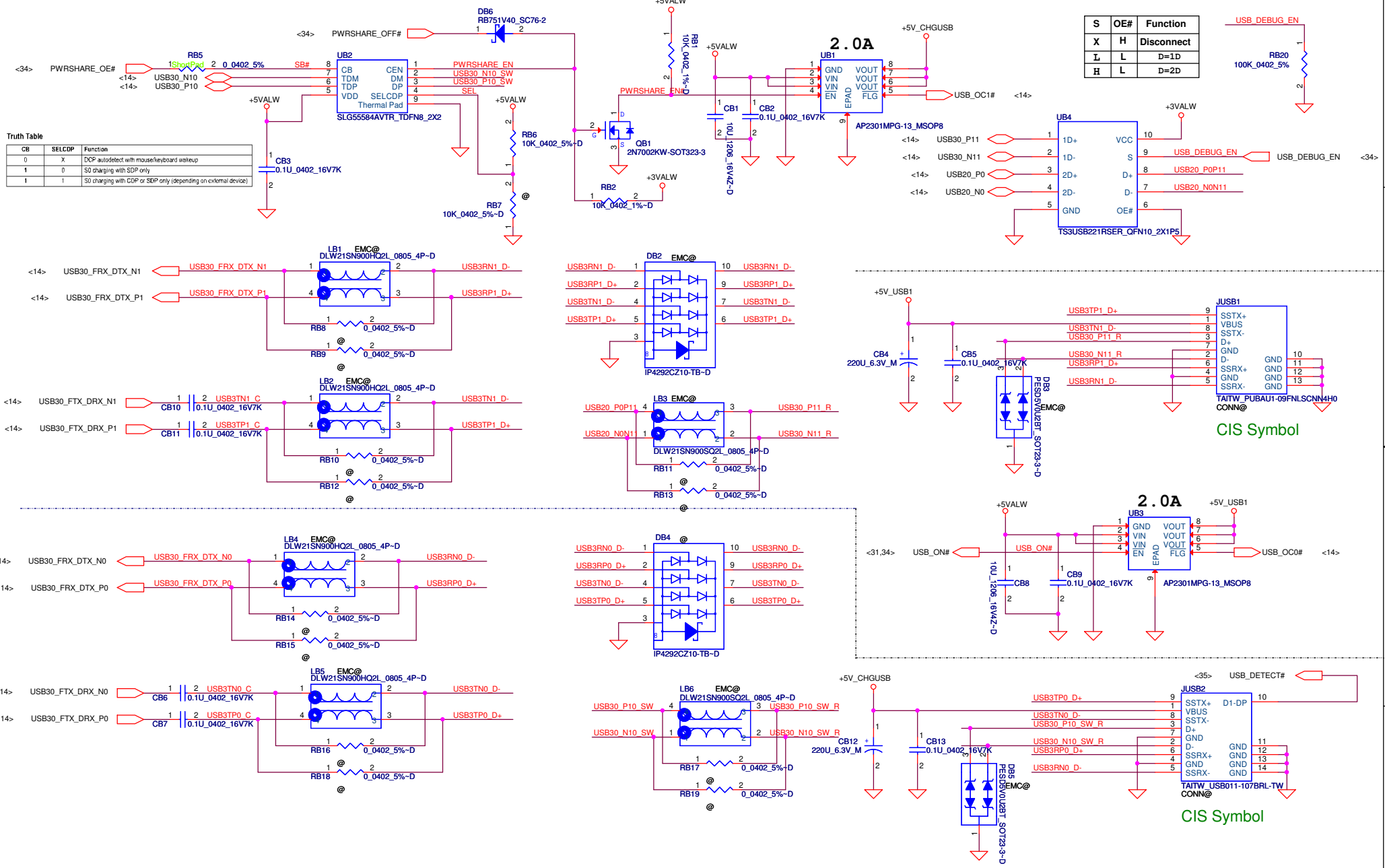
Power share

CB	Function
L	auto detection charger identification active
H	DP/DM=TDP/TDM

S	OE#	Function
X	H	Disconnect
L	L	D=1D
H	L	D=2D

Truth Table

CB	SELCDP	Function
0	X	DCP autodetect with mouse/keyboard wakeup
1	0	S0 charging with SDP only
1	1	S0 charging with CDP or SDP only (depending on external device)



Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.
Title: USB LP1/2
Size: Custom | Document Number: LA8251P | Rev: 1.0
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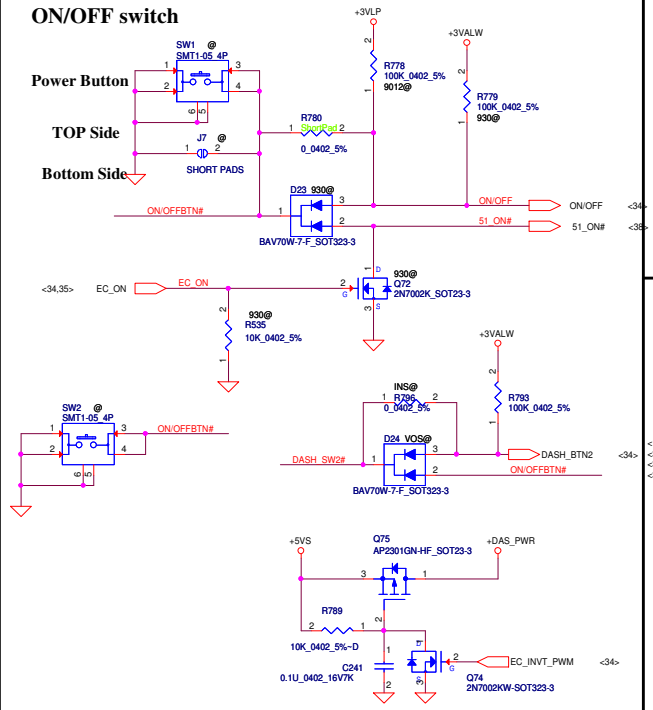
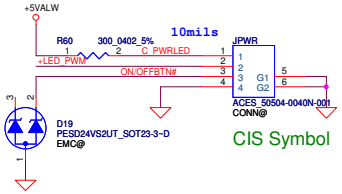
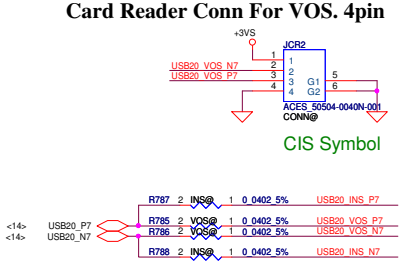
ON/OFF switch

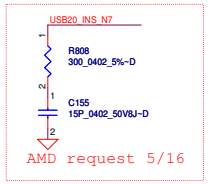


Power Button Board Conn. 4pin

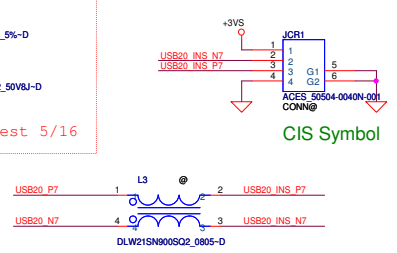


Card Reader Conn For VOS. 4pin

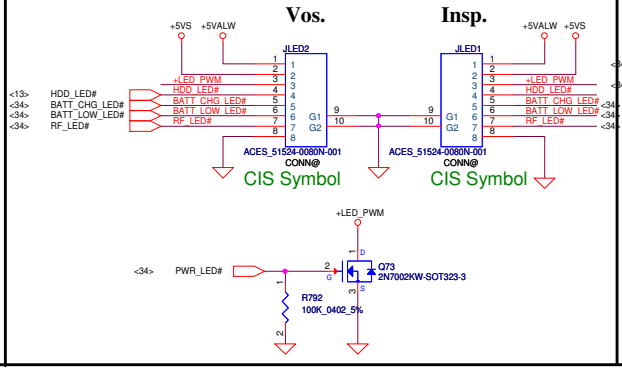




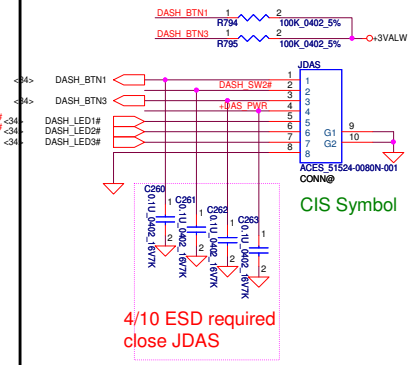
Card Reader Conn For INS.



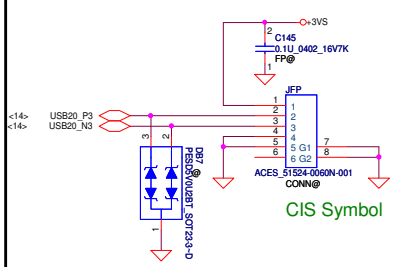
LED Board Conn, include LID SW. 10pin



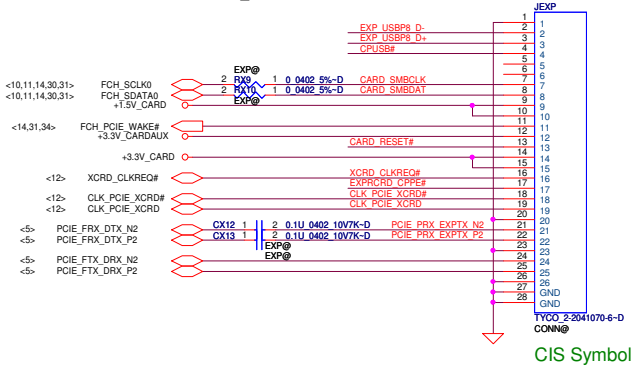
Dashboard Function Conn. 8pin

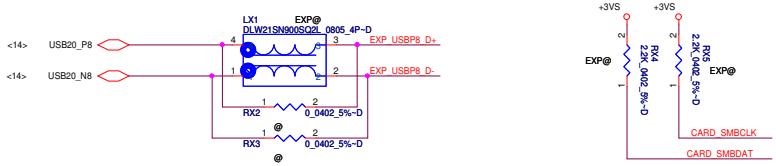


Finger Printer Conn. 6pin

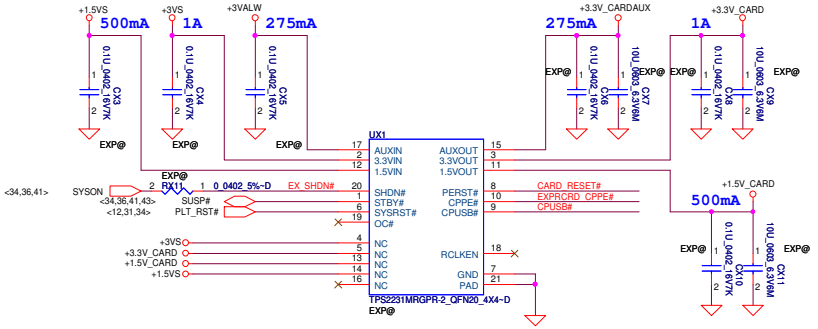


Express Card





Express Card PWR S/W



Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.

Title: Other IO Conn. ExCARD

Size	Document Number	Rev
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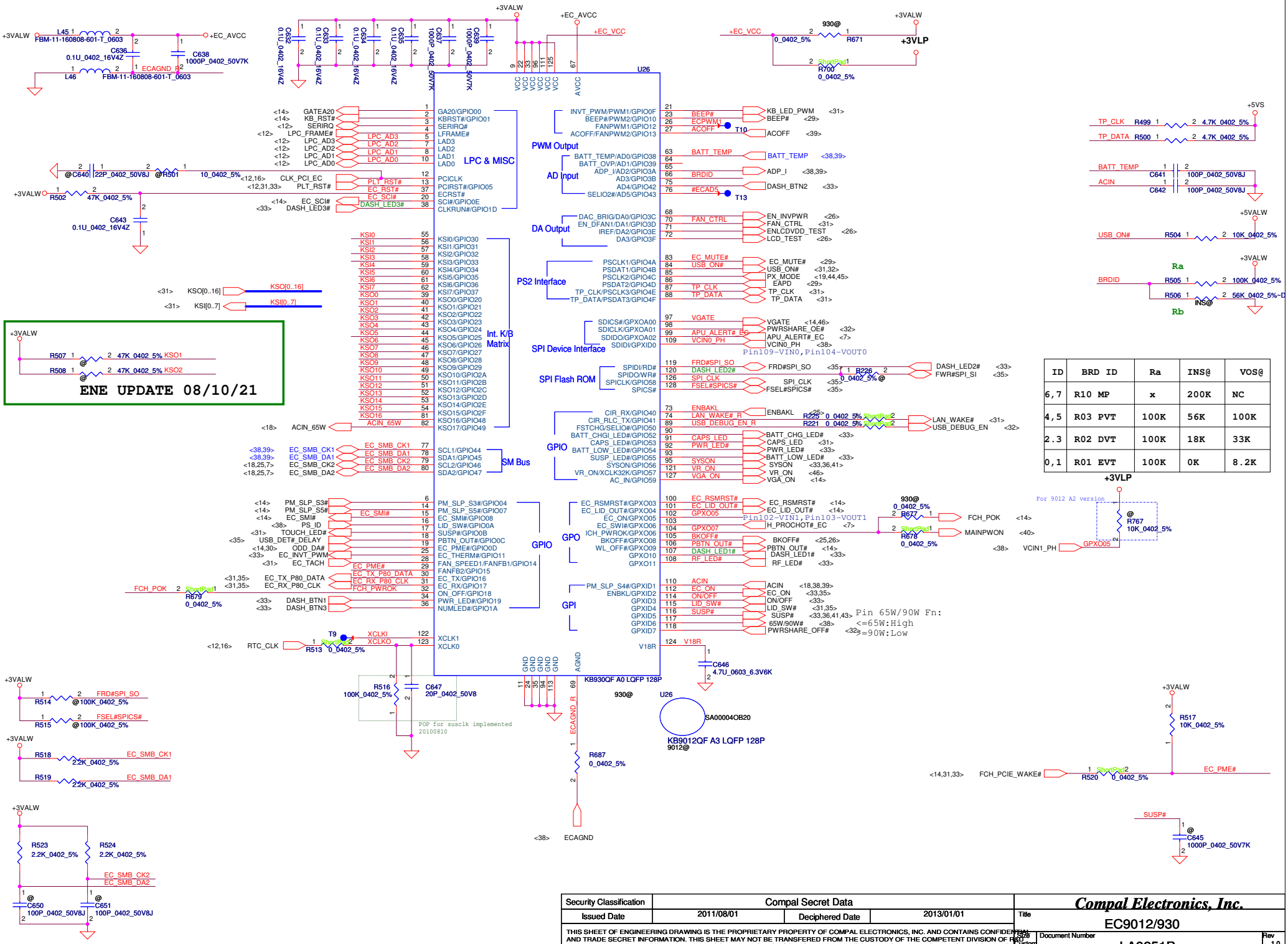

ID	BRD ID	Ra	INS@	VOS@
6,7	R10 MP	x	200K	NC
4,5	R03 PVT	100K	56K	100K
2.3	R02 DVT	100K	18K	33K
0,1	R01 EVT	100K	0K	8.2K

Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

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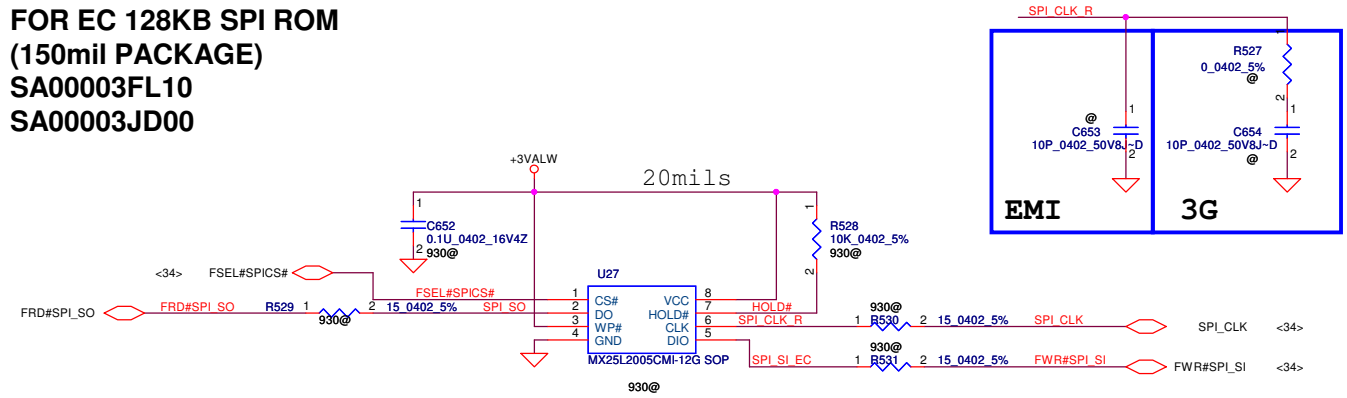
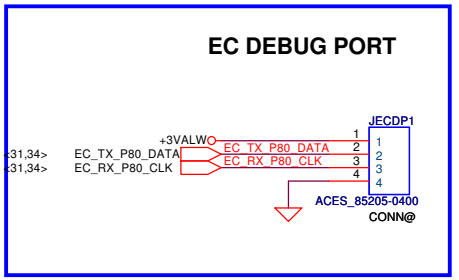
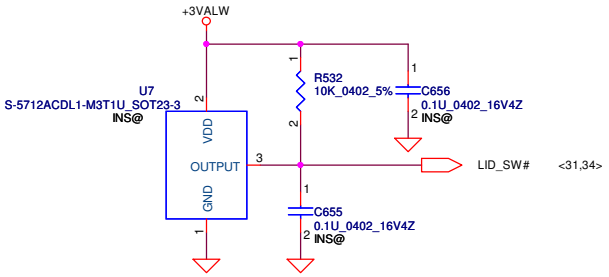
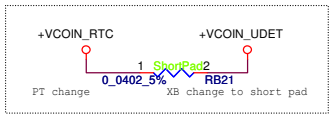
FOR EC 128KB SPI ROM
(150mil PACKAGE)
SA00003FL10
SA00003JD00



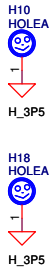


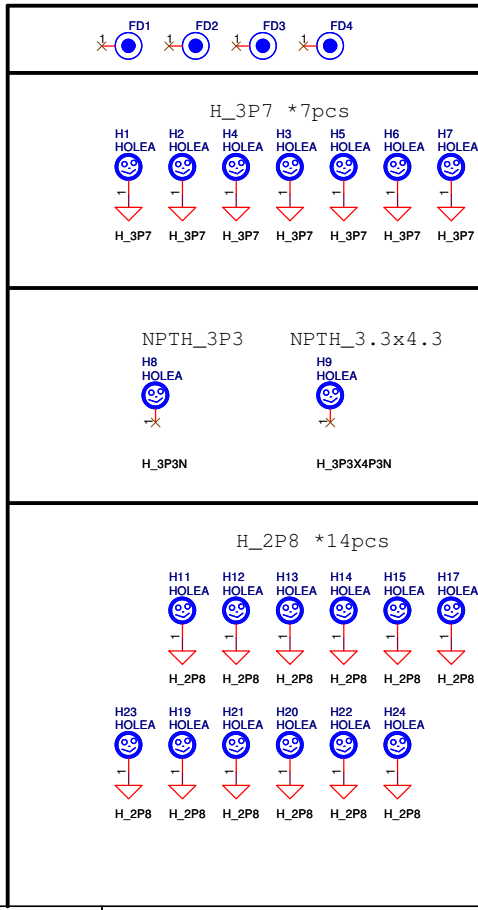
LID SWITCH FOR INS. ONLY





H_3P5 *2pcs





Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.

Title: EC ROM/Debug

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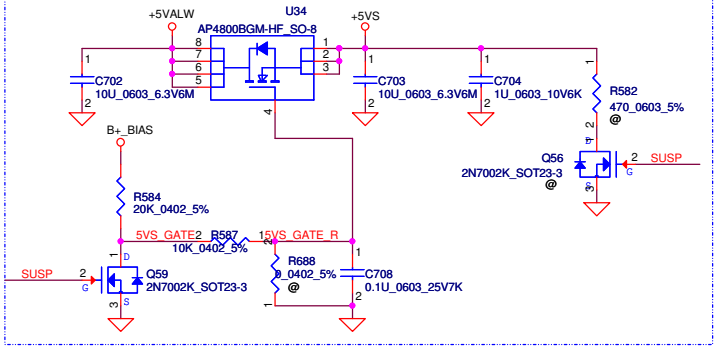
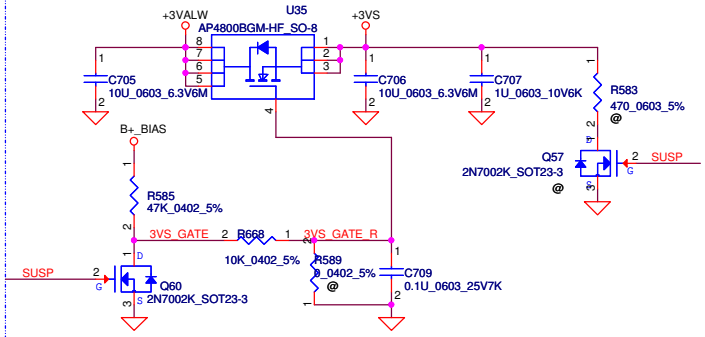
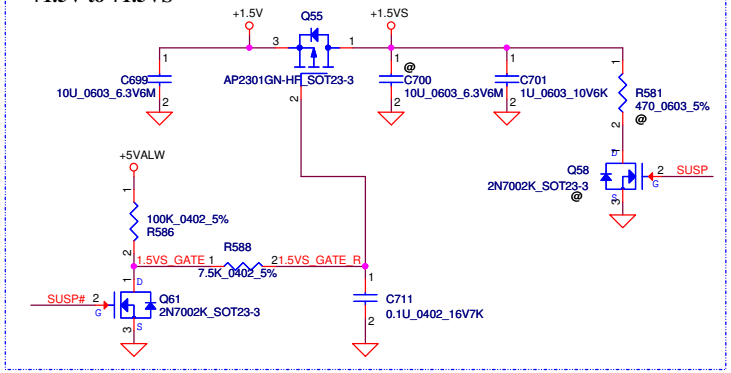
+5VALW TO +5VS



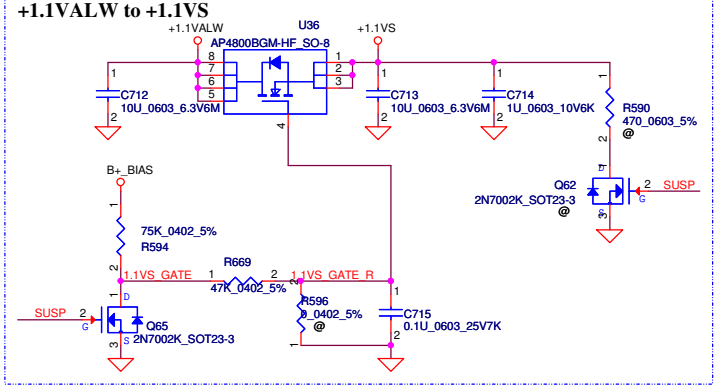
+3VALW TO +3VS

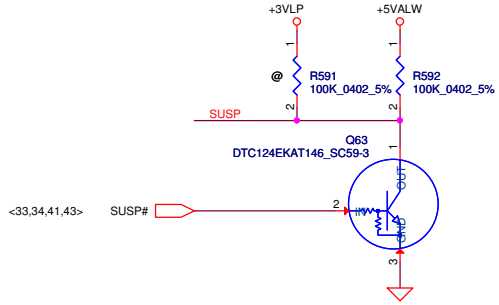


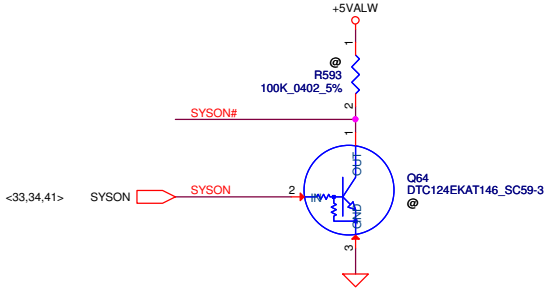
+1.5V to +1.5VS

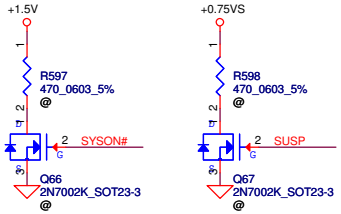


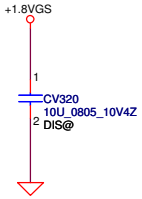
+1.1VALW to +1.1VS

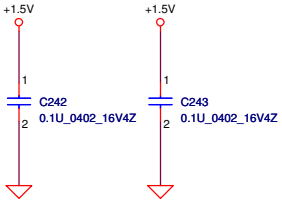




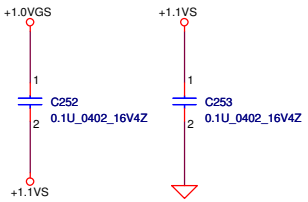




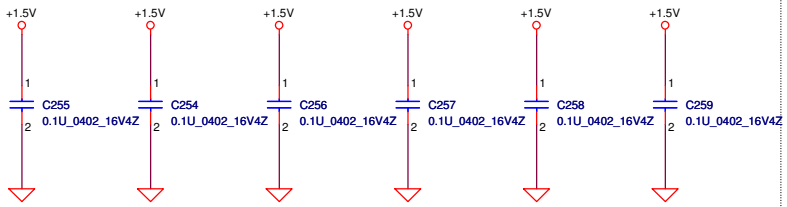




For USB3.0 Cross Moat On Bottom



ESD demand in PT



EMI Adding for PT, 2011/11/28

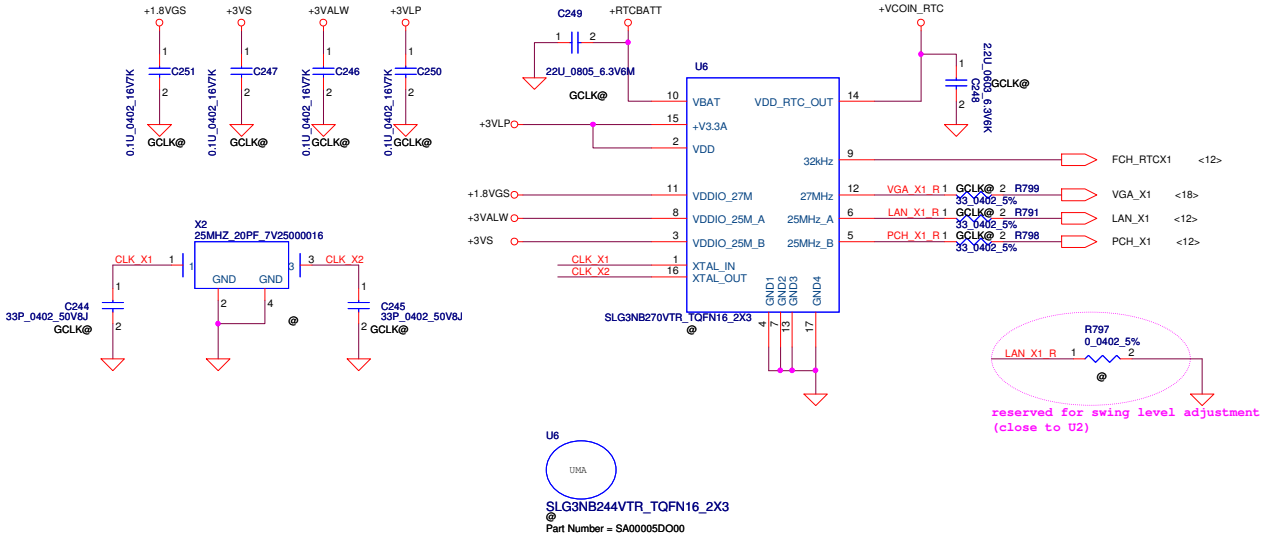
Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.

Title: DC Interface

Size: Custom | Document Number: LA8251P | Rev: 1.0

Date: Monday, July 16, 2012 | Sheet 36 of 50



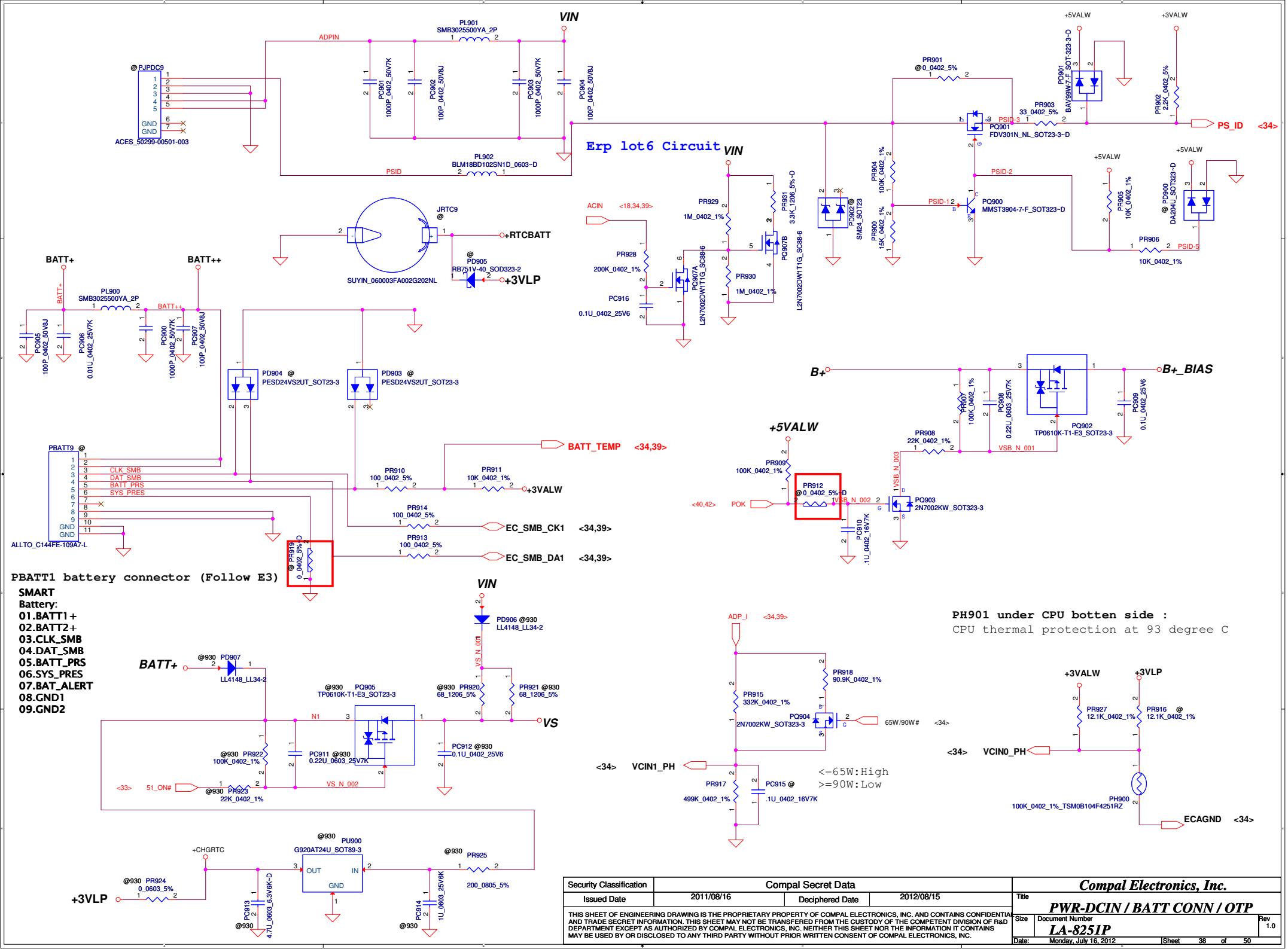
Security Classification	Compal Secret Data		
Issued Date	2011/08/01	Deciphered Date	2013/01/01

Compal Electronics, Inc.

Title: **AMP & GCLK**

Size	Document Number	Rev
Custom	LA8251P	1.0

Date: Monday, July 16, 2012 | Sheet 48 of 50



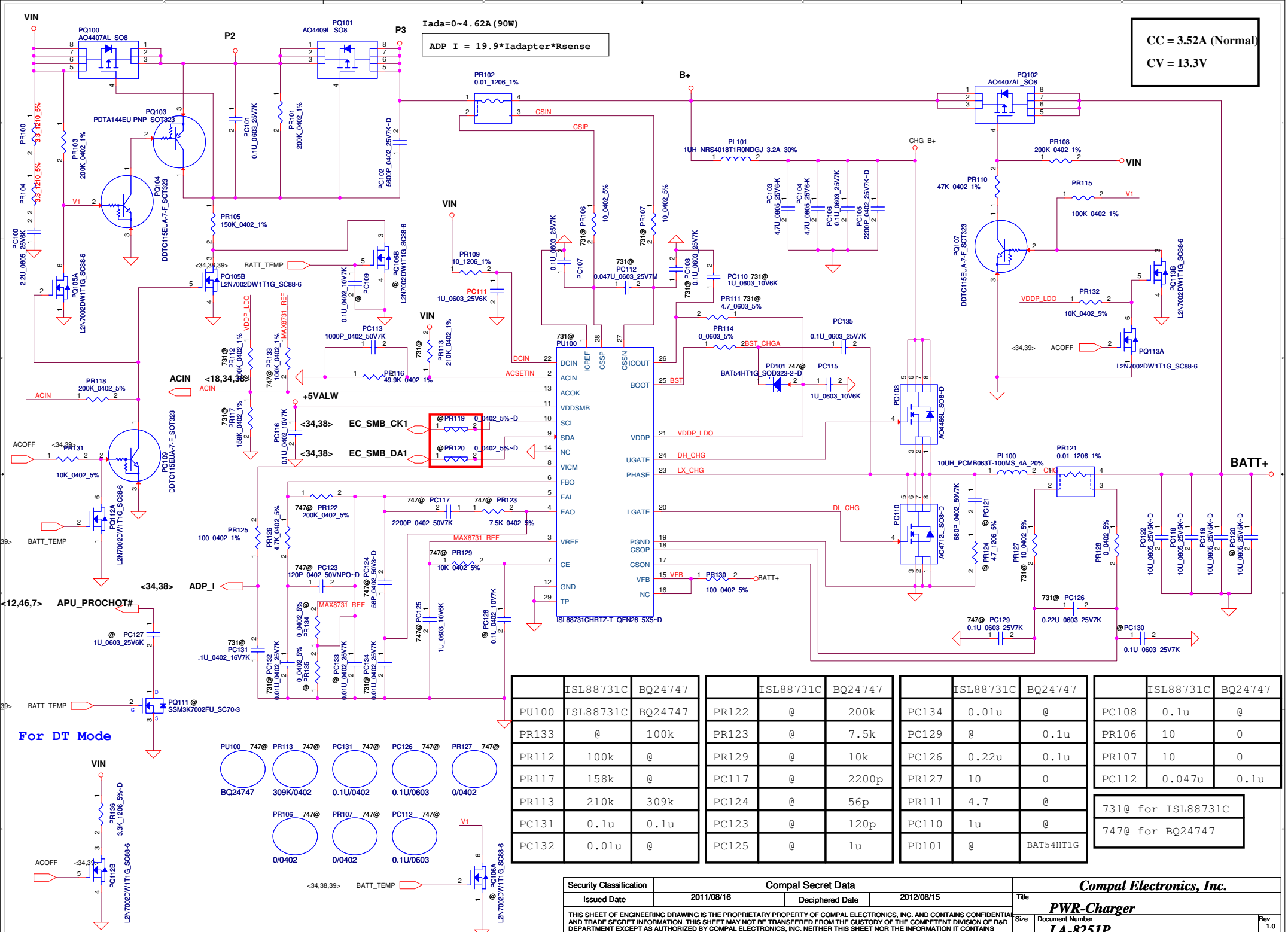
Security Classification	Compal Secret Data		
Issued Date	2011/08/16	Deciphered Date	2012/08/15

Compal Electronics, Inc.

Title: PWR-DCIN / BATT CONN / OTP

Size: | Document Number: LA-8251P | Rev: 1.0

Date: Monday, July 16, 2012 | Sheet 38 of 50



	ISL88731C	BQ24747
PU100	ISL88731C	BQ24747
PR133	@	100k
PR112	100k	@
PR117	158k	@
PR113	210k	309k
PC131	0.1u	0.1u
PC132	0.01u	@

	ISL88731C	BQ24747
PR122	@	200k
PR123	@	7.5k
PR129	@	10k
PC117	@	2200p
PC124	@	56p
PC123	@	120p
PC125	@	1u

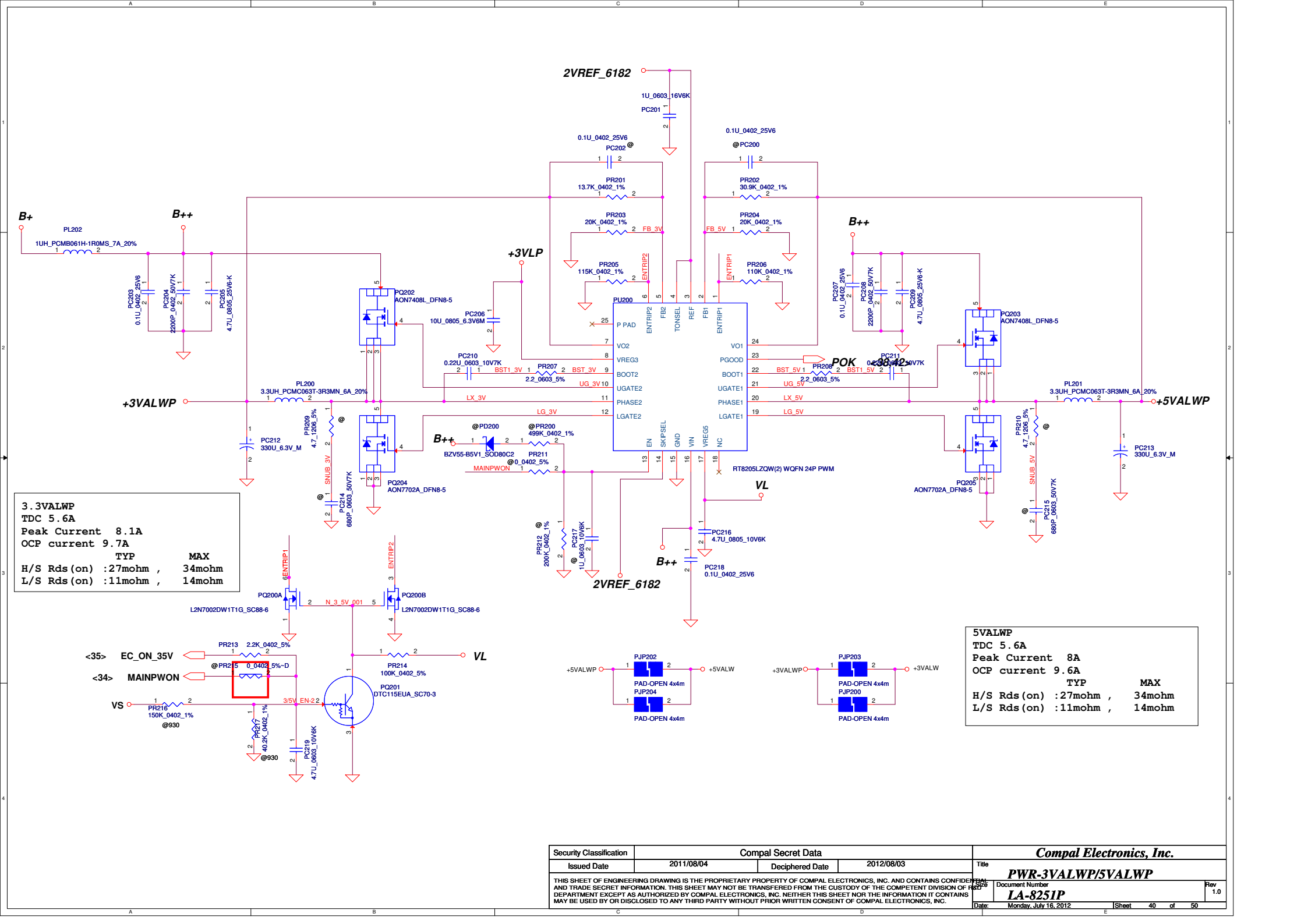
	ISL88731C	BQ24747
PC134	0.01u	@
PC129	@	0.1u
PC126	0.22u	0.1u
PR127	10	0
PR111	4.7	@
PC110	1u	@
PD101	@	BAT54HT1G

	ISL88731C	BQ24747
PC108	0.1u	@
PR106	10	0
PR107	10	0
PC112	0.047u	0.1u

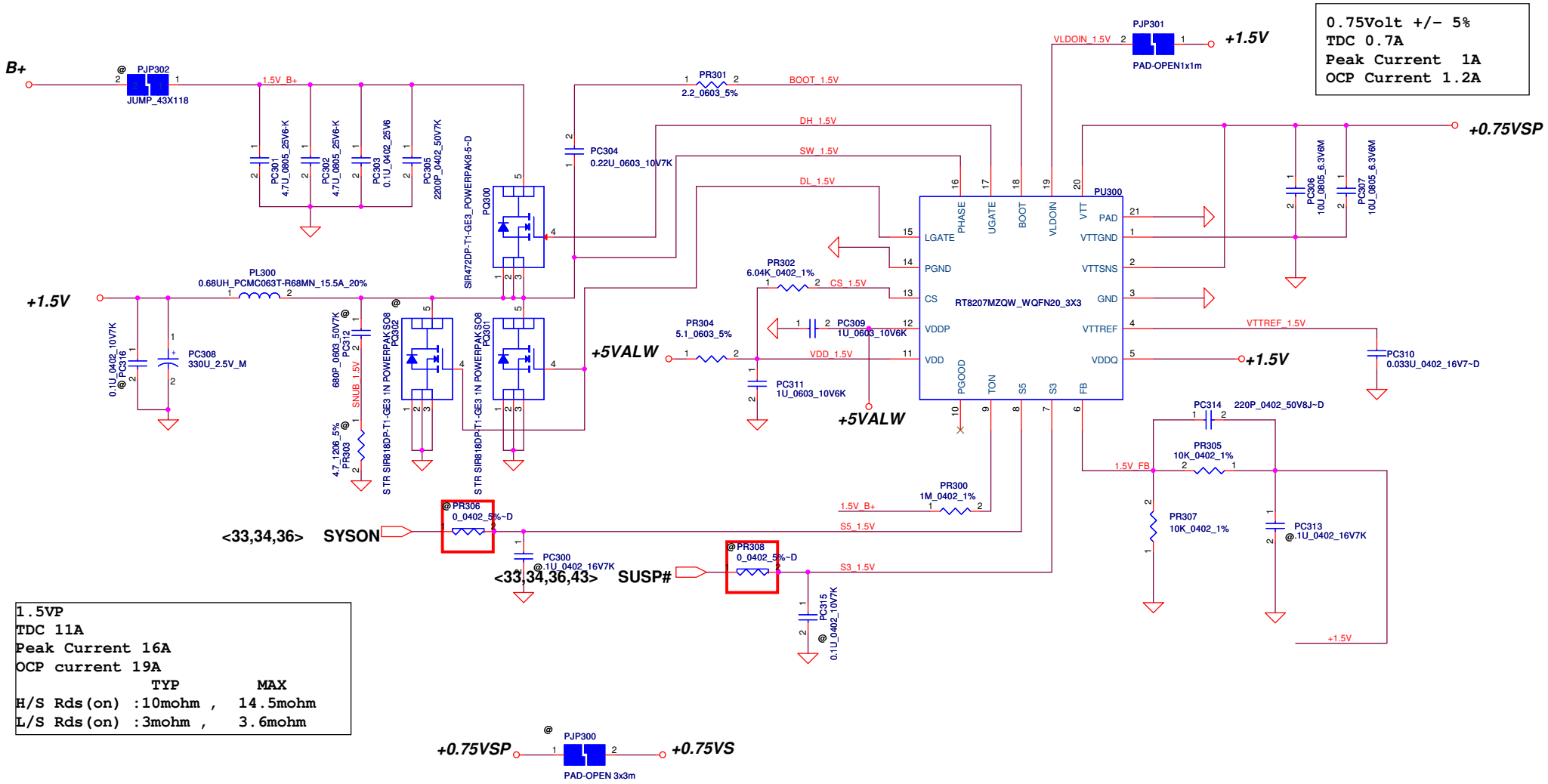
731@ for ISL88731C
747@ for BQ24747

Security Classification	Compal Secret Data		
Issued Date	2011/08/16	Deciphered Date	2012/08/15

Compal Electronics, Inc.	
Title	PWR-Charger
Size	Document Number: LA-8251P
Rev	1.0
Date:	Monday, July 16, 2012
Sheet	39 of 50



Security Classification	Compal Secret Data		Compal Electronics, Inc.
Issued Date	2011/08/04	Deciphered Date	2012/08/03
Title	PWR-3VALWP/5VALWP		
Size	Document Number		Rev
	LA-8251P		1.0
Date:	Monday, July 16, 2012	Sheet	40 of 50



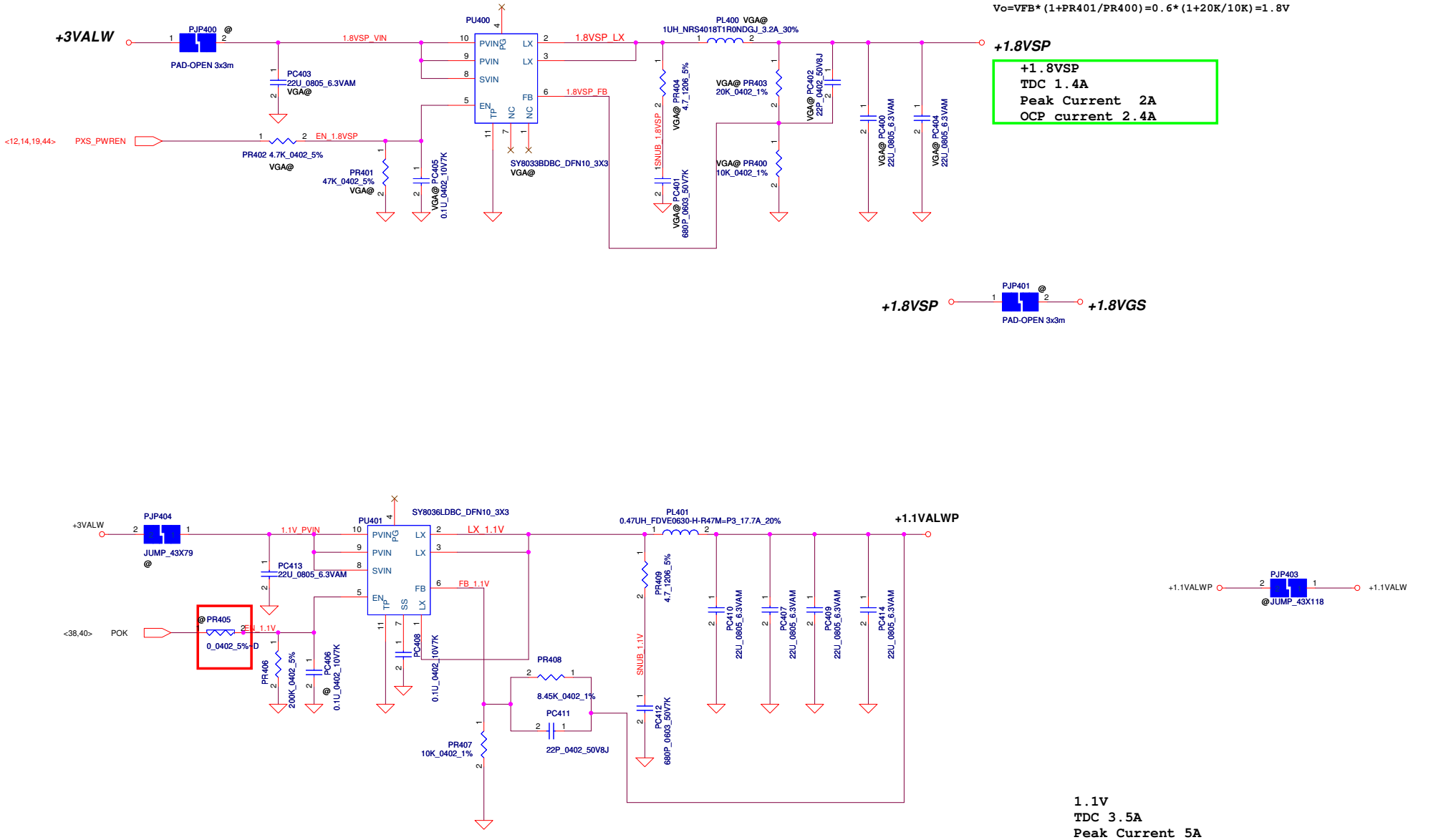
Security Classification	Compal Secret Data		
Issued Date	2011/08/04	Deciphered Date	2012/08/03

Compal Electronics, Inc.

Title: PWR-1.5V/0.75VSP

Size | Document Number: LA-8251P | Rev: 1.0

Date: Monday, July 16, 2012 | Sheet 41 of 50



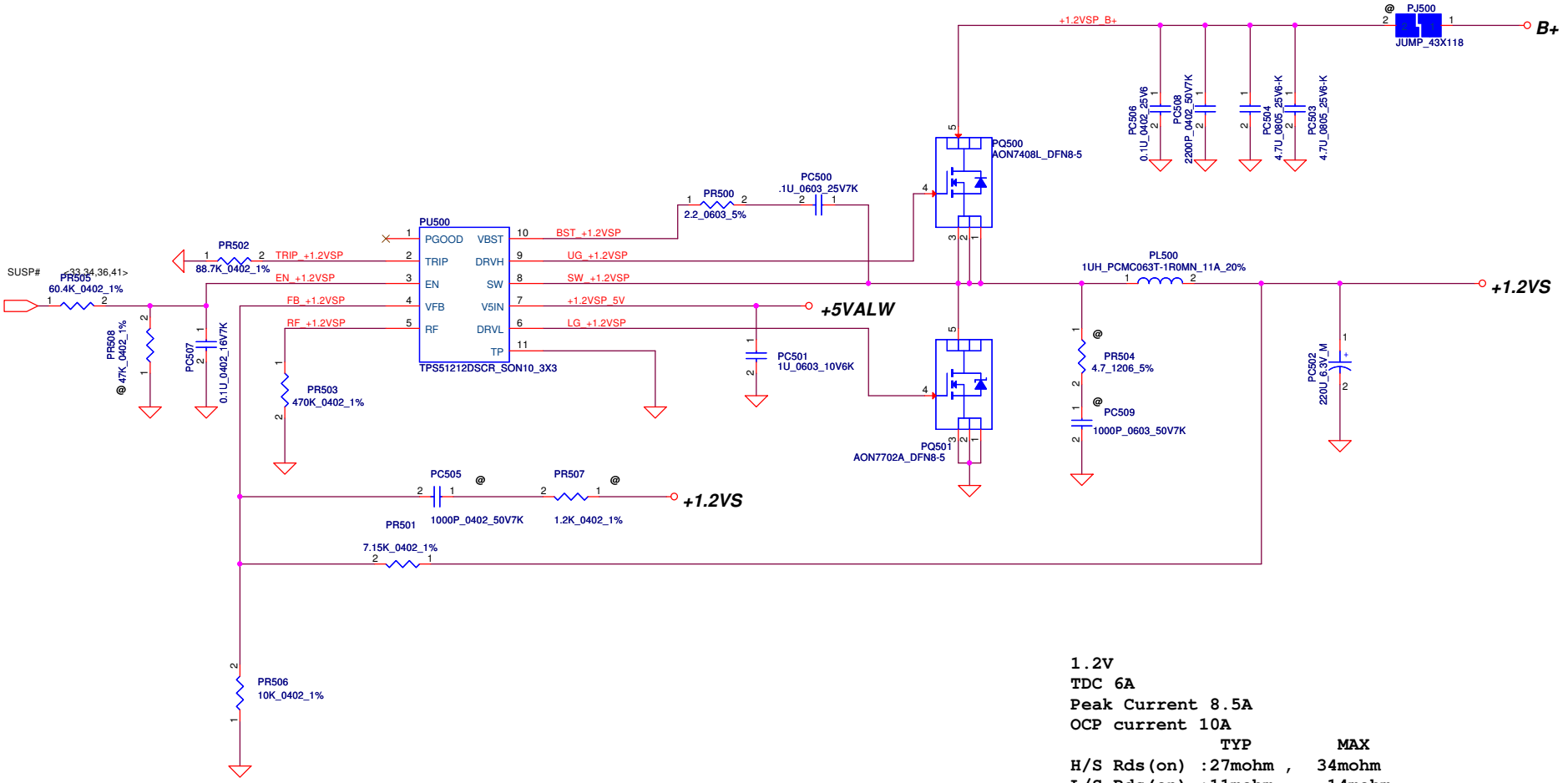
Security Classification	Compal Secret Data		
Issued Date	2011/08/04	Deciphered Date	2012/08/03

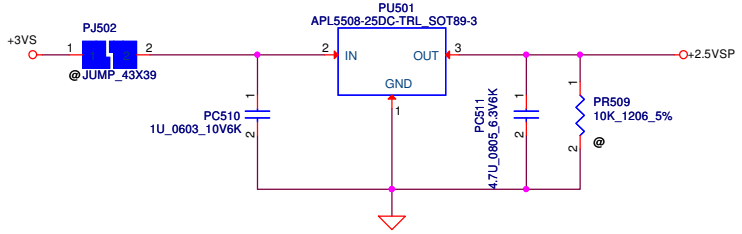
Compal Electronics, Inc.

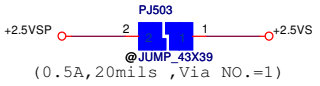
Title: PWR-1.8VSP/1.1VALWP

Size | Document Number: LA-8251P | Rev: 1.0

Date: Monday, July 16, 2012 | Sheet 42 of 50







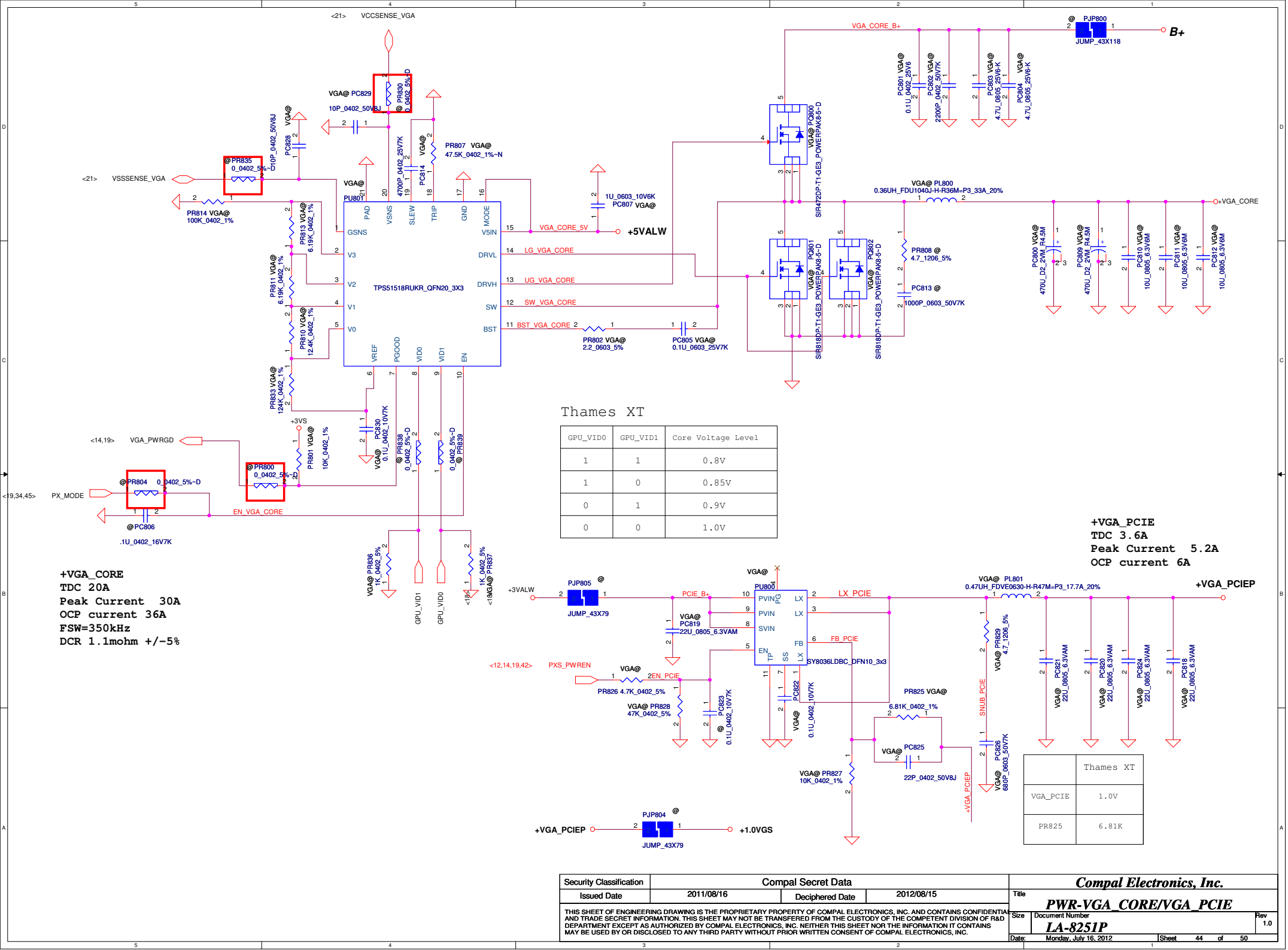
Security Classification	Compal Secret Data		
Issued Date	2011/08/04	Deciphered Date	2012/08/03

Compal Electronics, Inc.

Title: PWR-1.2VSP/2.5VSP

Size | Document Number: LA-8251P | Rev: 1.0

Date: Monday, July 16, 2012 | Sheet 43 of 50



Thames XT

GPU_VID0	GPU_VID1	Core Voltage Level
1	1	0.8V
1	0	0.85V
0	1	0.9V
0	0	1.0V

	Thames XT
VGA_PCIE	1.0V
PR825	6.81K

Security Classification	Compal Secret Data		
Issued Date	2011/08/16	Deciphered Date	2012/08/15

Compal Electronics, Inc.	
Title	PWR-VGA_CORE/VGA_PCIE
Size	Document Number: LA-8251P
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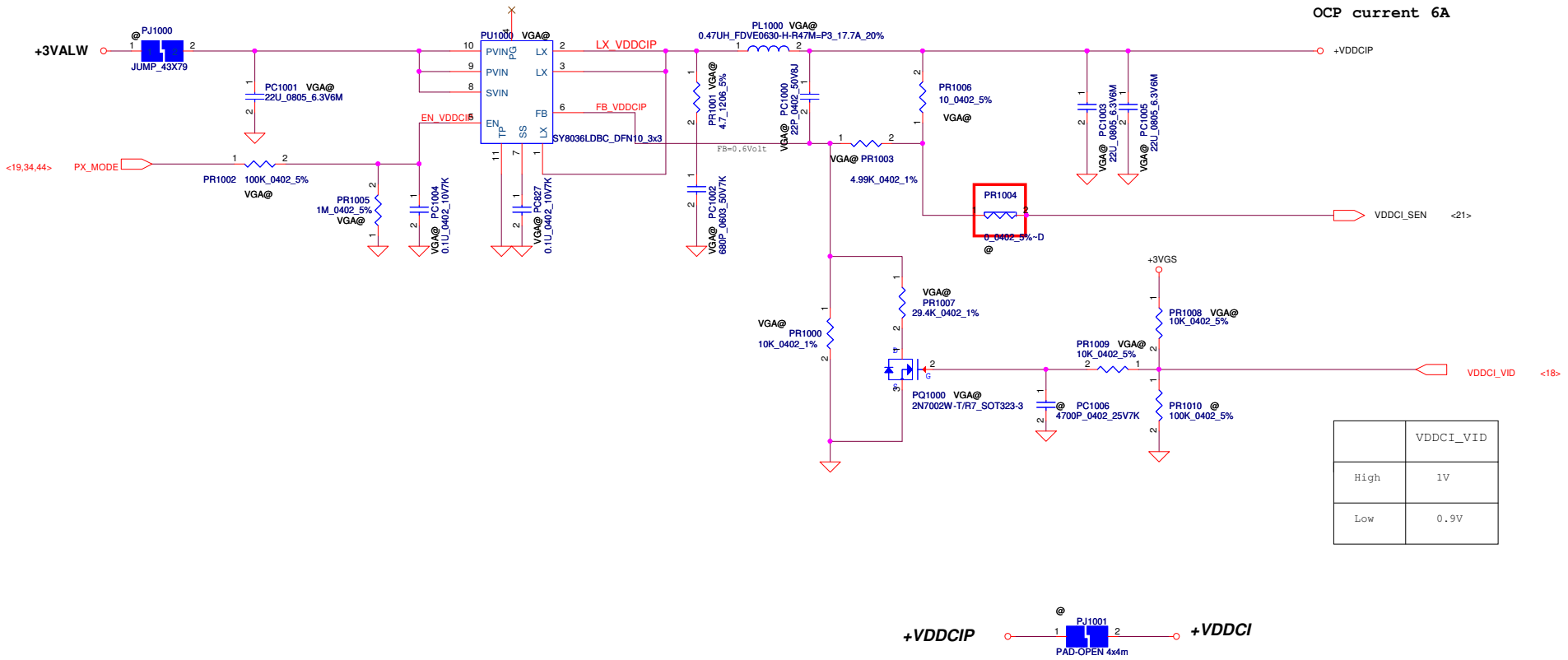
Date:	Monday, July 16, 2012
Sheet	44 of 50

+VDDCI
TDC 2.8A
Peak Current 4A
OCP current 6A



	VDDCI_VID
High	1V
Low	0.9V

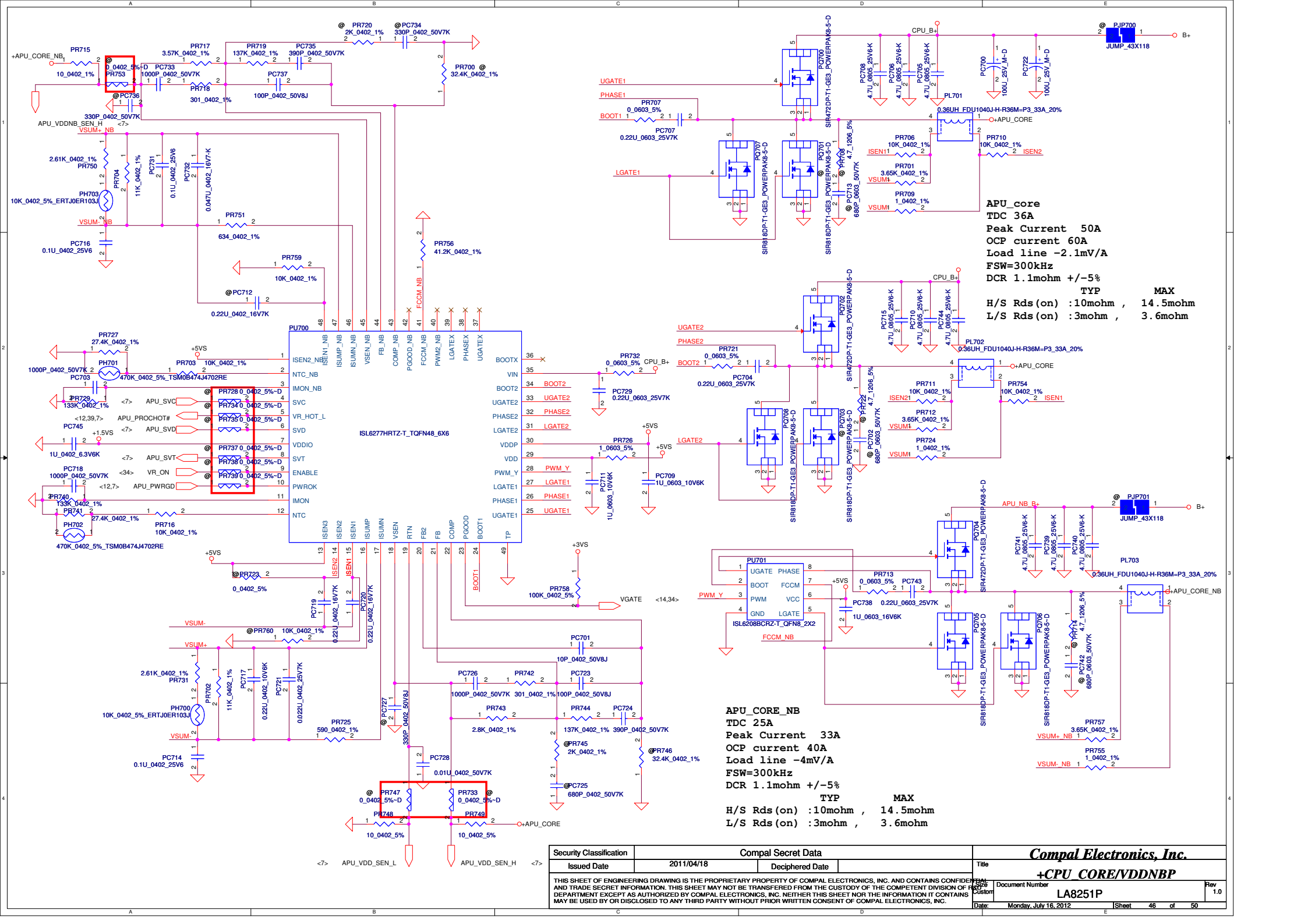
Security Classification	Compal Secret Data		
Issued Date	2011/08/16	Deciphered Date	2012/08/15

Compal Electronics, Inc.

Title: +VDDCIP

Size | Document Number: LA-8251P | Rev: 1.0

Date: Monday, July 16, 2012 | Sheet 45 of 50


PU700
ISL6277HRTZ-T_TQFN48_6X6
PU701
ISL6208BCRZ-T_QFN8_2X2
APU_core
TDC 36A
Peak Current 50A
OCP current 60A
Load line -2.1mV/A
FSW=300kHz
DCR 1.1mohm +/-5%
TYP MAX
H/S Rds(on) :10mohm , 14.5mohm
L/S Rds(on) :3mohm , 3.6mohm
APU_CORE_NB
TDC 25A
Peak Current 33A
OCP current 40A
Load line -4mV/A
FSW=300kHz
DCR 1.1mohm +/-5%
TYP MAX
H/S Rds(on) :10mohm , 14.5mohm
L/S Rds(on) :3mohm , 3.6mohm
Security Classification
Compal Secret Data
Issued Date
2011/04/18
Deciphered Date
Compal Electronics, Inc.
+CPU_CORE/VDDNBP
Document Number
LA8251P
Rev 1.0
Monday, July 16, 2012
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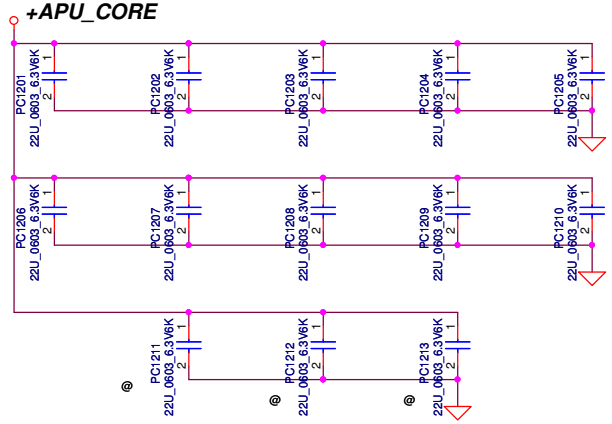
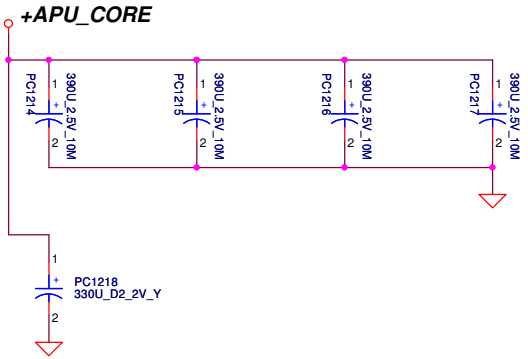
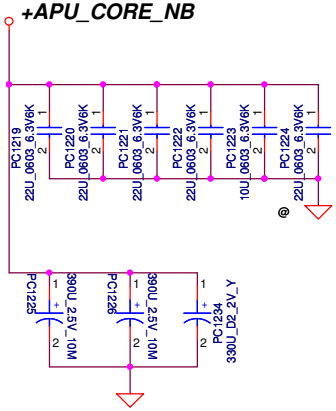
+APU_CORE

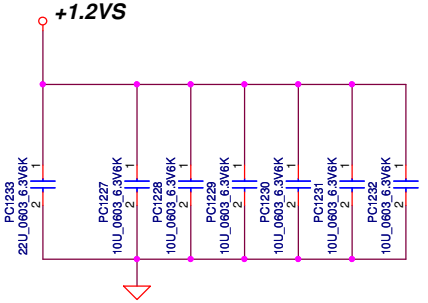




+APU_CORE_NB



+1.2VS



+1.2VS

Security Classification	Compal Secret Data		
Issued Date	2011/04/18	Deciphered Date	

Compal Electronics, Inc.

Title: PROCESSOR DECOUPLING

Size	Document Number	Rev
Custom	LA8251P	1.0

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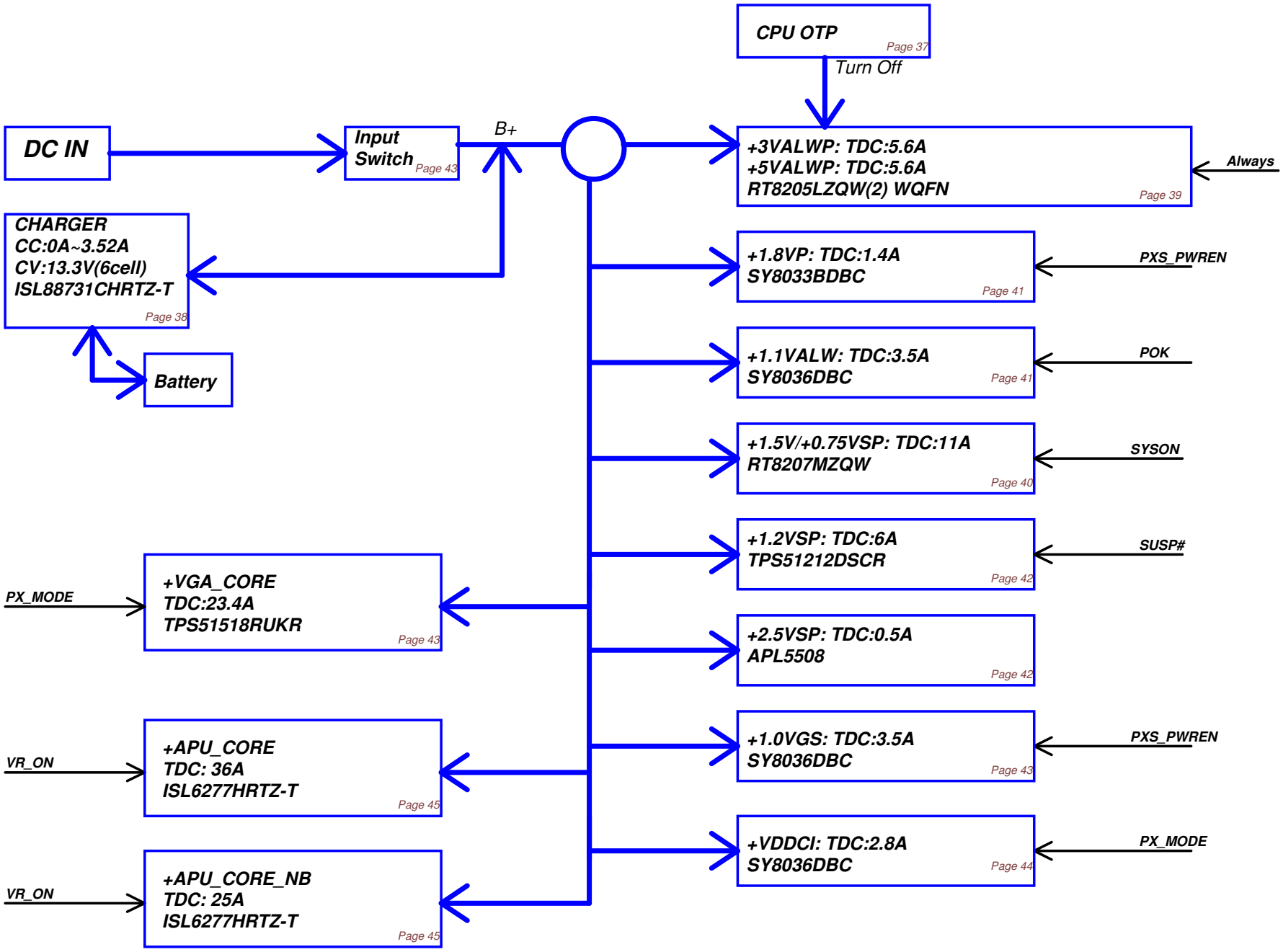
Power block



Security Classification	Compal Secret Data		Compal Electronics, Inc.
Issued Date	2011/04/18	Deciphered Date	Title: PWR-POWER BLOCK DIAGRAM
Size: Custom	Document Number: LA8251P		Rev: 1.0
Date: Monday, July 16, 2012	Sheet 48 of 50		

Version Change List (P. I. R. List)

Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
1							

Security Classification	Compal Secret Data		Compal Electronics, Inc.
Issued Date	2011/04/18	Deciphered Date	
Title	PWR-PIR		
Size: Custom	Document Number: LA8251P		Rev: 1.0
Date: Monday, July 16, 2012	Sheet 49 of 50		

Version Change List (P. I. R. List)

Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
1	9	XXX	XX*XX/XX	Compal_XX	XXXXX	Change PRXX from Xohm to XXKohm.	X01

Design Change

Date	Page	Part reference	change description	Reason
10/17/2011	33	JLED2	Add JLED2 for Inspiron use only.	ME change drawing.
10/17/2011	30	UD1	Swap nets FCH_SDATA0/FCH_SCLK0	correct connection
10/17/2011	25	UV27.1	ADD RV327 for HPD	Vendor review
10/17/2011	25	RV268	DEL RV268	No need 1.2V from system.
10/17/2011	14	D6.D7	Change D6. D7 to Schottky for VGA PWR control	Original Diode. Vf too high.
10/17/2011	12	C159.C158	Change C159.C158 to 10pF	Vendor review
10/17/2011	12	D5.D8	Change D5. D8 to Schottky	Original Diode. Vf too high. Vendor review.
10/17/2011	27	DV8	Reserve DV8. use RV40 short.	HDMI Voltage issue.
10/17/2011	26	JLVDS	JLVDS Reverse Pin	LVDS connector location change.
10/17/2011	21	RV215	RV215 connect to net:+VDDCI	FB_VDDCI Should connect to +VDDCI
10/17/2011	37	AMP	Add an Audio AMP Circuit in page37	customer requires.
10/19/2011	33	DB7	Reserve DB7 for ESD	ESD request
10/19/2011	36	RB21	Adding RB21. change USB charge circuit power rail to +VC	USB charge sequence fine tune
10/19/2011	34	U26	Dashboard button change to U26 pin34.36.75	to meet customer spec.
10/19/2011	13	U2	KB_DET# Change to FCH GPIO56. add Q76	EC pin saving.
10/20/2011	34	R503	R503 DEL	Leakage form 3VALW to VS
10/20/2011	30	QD4	Add QD4	Leakage form 3VALW to VS
10/21/2011	33	R793.R794.R795.R796.D24	add R793.R794.R795 100K*3.R796 0ohm.D24 BAT54C	For Dashboard support 3 second boot up.
10/21/2011	37	U6	Reserve U6. C244~C251. R797~R799	Reserve GreenCLK
10/21/2011	31	JBTB1	change pin67 to +3VS. pin36.38.40.42 to +3VALW	LAN D/B design changes.
10/21/2011	27.32	JUSB2.JHDMI	update JUSB2 Footprint. JHDMI Footprint	ME change drawing.
10/25/2011	29	CA19.CA20	From 2.2UF to 4.7UF	Vendor review
10/25/2011	28	CV6.CV7.CV8	From 22pF to 10pF	CRT high resolution issue.
10/26/2011	33	R60.R8	Change to 300ohm	LED current need >5mA
10/26/2011	33	R792	Add 100Kohm to GND	Power LED issue.
10/26/2011	33	UX1	SYSON connect to UX1.20	Express Card not support S5 weakup.
10/28/2011	29	RA12.RA13	Change from 5.1ohm to 39.2ohm	Vendor review
11/21/2011	33	UX1	Connect pin4 to +3VS. pin14 to +1.5VS for 2nd GMT	2nd source required.
11/28/2011	7	Q6	Add Q6, Del Q1	ProcHot# change to High active. Common code for EC
11/28/2011	12	R109	10M reserved	Without RTC battery, system should not boot up issue
11/28/2011	36	EMI	Add C254,C255,C256,C257,C258,C259 0.1uF +1.5V	For EMI request
11/28/2011	32	UB4	AMD USB debug Port0 change to JUSB1	JUSB1 USB SI too margin. Due to switch serial resistor approx 10ohm

Design Change for PT

Date	Page	Part reference	change description	Reason
04/03/12	18	YV1	27MHz package change to small size	Sourcer's recommend for cost down
04/03/12	26	JLVDS	pin assignment change for 31,32,33,34,35,37	Sourcer's recommend for cost down
04/03/12	35	C657	add 0.1u_0402 on USB_DETECT#	ESD required
04/03/12	35	C658	add 0.1u_0402 on USB_DET#_DELAY	ESD required
04/03/12	18	RV205,RV206	add 10K_0402 reserved only.	AMD Chelsea required
04/03/12	18	R804,R805	add 0_0402 reserved only.	AMD Chelsea required
04/03/12	20	RV244,CV366,RV208	add 2K_0402 ,10P_0402, 0_0402, reserved	AMD Chelsea required
04/03/12	21	RV247,RV248	add 0_0402 reserved, RV247 stuffed.	AMD Chelsea required
04/03/12	18	RV250	add 0_0402 to GND for Thames, stuffed.	AMD Chelsea required
04/03/12	28	JCRT	footprint changed	DFB required
04/03/12	30	JHDD	footprint changed	DFB required
04/03/12	12	C158,C159,Y1	18p,18p,small size, 10P→18P	Sourcer's recommend for cost down
04/03/12	12	C155,C157,X1	12p,12p,small size, 27P→12P	Sourcer's recommend for cost down
04/12/12	19	RV104,RV101,QV21,CV96,RV103,RV109,QV25,RV99,RV100,QV18,QV19,QV20	Remove from BOM	These parts are PX4.0 supports. We support PX5.0 only.
04/12/12	19	RV112,RV113	RV113 Change 150K→240K, RV112 change 20K→240K.	Power rail +1.5VGS Timing fine tune.
04/12/12	18	R807,R806	Reserve 0ohm, R807 stuffed.	Reserve adaptor choice for dGPU GPIO5(net:AC_BATT)
04/12/12	29	R14, Q78	R14 10K, Q78 NMOS dual.	AMD recommend.
04/12/12	32	LB6, RB17, RB19	LB6 add to BOM.	EMI required.
04/12/12	13	R136	100K ohm stuffed.	Add PU for FCH GPIO171. (net:ODD_EN#)
04/12/12	14	R104	Reserve 0ohm.	Reserve for ODD_DA#
04/12/12	33	C260, C261, C262, C263	0.1uF stuffed.	ESD required
04/10/12	8	C100	Change to SGA00002280	ME Height limit. 4mm.
04/11/12	27	CV365,CV367	add 0.1U_0402_10V7K~D, reserve only.	EMI required, add caps in HDMI DDC
04/12/12	33	L3	add DLW21SN900SQ2_0805~D, reserve only.	EMI required, add CC in Cardreader
05/02/12	7	C71	pop 0.1U_0402_16V4Z	EE required, Shutdown issue, Leason learn from CGs

Design Change for ST

Date	Page	Part reference	change description	Reason
05/31/12	26,33,31	RV328,R808,R774	add 300_0402_5%~D	AMD required, USB20 D- add RC for device lose
05/31/12	26,33,31	CV368,C155,C795	add 15P_0402_50V8J~D	AMD required, USB20 D- add RC for device lose
05/31/12	18,28	RV220,RV223,RV217,RV226,RV222,RV225,RV221,RV224,RV216,RV227,RV218,RV228,RV219,RV229	delete CRT debug	AMD required, for VGA layout concern.
05/31/12	7	Q6	reverse Q6	EE required
05/31/12	27	RV329,RV330	add 0_0603_5%~D	EMI required, DDC EMI issue.
05/31/12	27	D20	add PESD24VS2UT_SOT23-3~D, reserve only.	ESD required, HDMI plug issue, Leason learn from CGs
06/22/12	18	R806	pop R806 0ohm	Fast Power reduce function
06/23/12	27	RV39, RV41, RV42, RV44, RV53, RV54, RV57, RV58	Remove these part	change to common mode chock
06/24/12	27	LV4, LV5, LV6,LV7	add these KINGCORE WCM-2012HS-900T common mode chock	EMI required for HDMI noise
06/25/12	27	CV351, CV352, CV349, CV350, CV353, CV354, CV355, CV356	add these 3.3pF 50V 0402	EMI required for HDMI noise
06/26/12	27	CV364, CV363, CV360, CV361, CV358, CV357, CV362, CV359	add these 1pF 50V 0402	EMI required for HDMI noise
06/22/12	32	DB4	Remove	USB detect issue